

LPC2478

Single-chip 16-bit/32-bit micro; 512 kB flash, ethernet, CAN, LCD, USB 2.0 device/host/OTG, external memory interface

Rev. 01 — 6 July 2007

Preliminary data sheet

1. General description

NXP Semiconductors designed the LPC2478 microcontroller, powered by the ARM7TDMI-S core, to be a highly integrated microcontroller for a wide range of applications that require advanced communications and high quality graphic displays. The LPC2478 microcontroller has 512 kB of on-chip high-speed flash memory. This flash memory includes a special 128-bit wide memory interface and accelerator architecture that enables the CPU to execute sequential instructions from flash memory at the maximum 72 MHz system clock rate. This feature is available only on the LPC2000 ARM microcontroller family of products. The LPC2478, with real-time debug interfaces that include both JTAG and embedded trace, can execute both 32-bit ARM and 16-bit Thumb instructions.

The LPC2478 microcontroller incorporates an LCD controller, a 10/100 Ethernet Media Access Controller (MAC), a USB full-speed Device/Host/OTG Controller with 4 kB of endpoint RAM, four UARTs, two Controller Area Network (CAN) channels, an SPI interface, two Synchronous Serial Ports (SSP), three I²C interfaces, and an I²S interface. Supporting this collection of serial communications interfaces are the following feature components; an on-chip 4 MHz internal oscillator, 98 kB of total RAM consisting of 64 kB of local SRAM, 16 kB SRAM for Ethernet, 16 kB SRAM for general purpose DMA, 2 kB of battery powered SRAM, and an External Memory Controller (EMC). These features make this device optimally suited for portable electronics and Point-of-Sale (POS) applications. Complementing the many serial communication controllers, versatile clocking capabilities, and memory features are various 32-bit timers, a 10-bit ADC, 10-bit DAC, two PWM units, and up to 160 fast GPIO lines. The LPC2478 connects 64 of the GPIO pins to the hardware based Vector Interrupt Controller (VIC) that means these external inputs can generate edge-triggered interrupts. All of these features make the LPC2478 device particularly suitable for industrial control and medical systems.

2. Features

- ARM7TDMI-S processor, running at up to 72 MHz.
- 512 kB on-chip flash program memory with In-System Programming (ISP) and In-Application Programming (IAP) capabilities. Flash program memory is on the ARM local bus for high performance CPU access.
- 98 kB on-chip SRAM includes:
 - ♦ 64 kB of SRAM on the ARM local bus for high performance CPU access.
 - ◆ 16 kB SRAM for Ethernet interface. Can also be used as general purpose SRAM.
 - 16 kB SRAM for general purpose DMA use also accessible by the USB.
 - 2 kB SRAM data storage powered from the RTC power domain.



- LCD controller, supporting both Super-Twisted Nematic (STN) and Thin-Film Transistors (TFT) displays.
 - Dedicated DMA controller.
 - Selectable display resolution (up to 1024 × 768 pixels).
 - Supports up to 24-bit true-color mode.
- Dual Advanced High-performance Bus (AHB) system allows simultaneous Ethernet DMA, USB DMA, and program execution from on-chip flash with no contention.
- EMC provides support for asynchronous static memory devices such as RAM, ROM and flash, as well as dynamic memories such as Single Data Rate SDRAM.
- Advanced Vectored Interrupt Controller (VIC), supporting up to 32 vectored interrupts.
- General Purpose AHB DMA controller (GPDMA) that can be used with the SSP, I²S, and SD/MM interface as well as for memory-to-memory transfers.
- Serial Interfaces:
 - Ethernet MAC with MII/RMII interface and associated DMA controller. These functions reside on an independent AHB bus.
 - USB 2.0 full-speed dual-port device/host/OTG controller with on-chip PHY and associated DMA controller.
 - Four UARTs with fractional baud rate generation, one with modem control I/O, one with IrDA support, all with FIFO.
 - CAN controller with two channels.
 - SPI controller.
 - Two SSP controllers, with FIFO and multi-protocol capabilities. One is an alternate for the SPI port, sharing its interrupt. SSPs can be used with the GPDMA controller.
 - Three I²C-bus interfaces (one with open-drain and two with standard port pins).
 - I²S (Inter-IC Sound) interface for digital audio input or output. It can be used with the GPDMA.
- Other peripherals:
 - SD/MMC memory card interface.
 - ◆ 160 General purpose I/O pins with configurable pull-up/down resistors.
 - ◆ 10-bit ADC with input multiplexing among 8 pins.
 - 10-bit DAC.
 - Four general purpose timers/counters with 8 capture inputs and 10 compare outputs. Each timer block has an external count input.
 - Two PWM/timer blocks with support for three-phase motor control. Each PWM has an external count inputs.
 - Real-Time Clock (RTC) with separate power domain. Clock source can be the RTC oscillator or the APB clock.
 - 2 kB SRAM powered from the RTC power pin, allowing data to be stored when the rest of the chip is powered off.
 - WatchDog Timer (WDT). The WDT can be clocked from the internal RC oscillator, the RTC oscillator, or the APB clock.
- Single 3.3 V power supply (3.0 V to 3.6 V).
- 4 MHz internal RC oscillator trimmed to 1 % accuracy that can optionally be used as the system clock.
- Three reduced power modes: idle, sleep, and power-down.
- Four external interrupt inputs configurable as edge/level sensitive. All pins on PORT0 and PORT2 can be used as edge sensitive interrupt sources.

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- Processor wake-up from Power-down mode via any interrupt able to operate during Power-down mode (includes external interrupts, RTC interrupt, USB activity, Ethernet wake-up interrupt, CAN bus activity, PORT0/2 pin interrupt).
- Two independent power domains allow fine tuning of power consumption based on needed features.
- Each peripheral has its own clock divider for further power saving. These dividers help reduce active power by 20 % to 30 %.
- Brownout detect with separate thresholds for interrupt and forced reset.
- On-chip power-on reset.
- On-chip crystal oscillator with an operating range of 1 MHz to 24 MHz.
- On-chip PLL allows CPU operation up to the maximum CPU rate without the need for a high frequency crystal. May be run from the main oscillator, the internal RC oscillator, or the RTC oscillator.
- Boundary scan for simplified board testing.
- Versatile pin function selections allow more possibilities for using on-chip peripheral functions.
- Standard ARM test/debug interface for compatibility with existing tools.
- Emulation trace module supports real-time trace.

3. Applications

- Industrial control
- Medical systems
- Portable electronics
- Point-of-Sale (POS) equipment

4. Ordering information

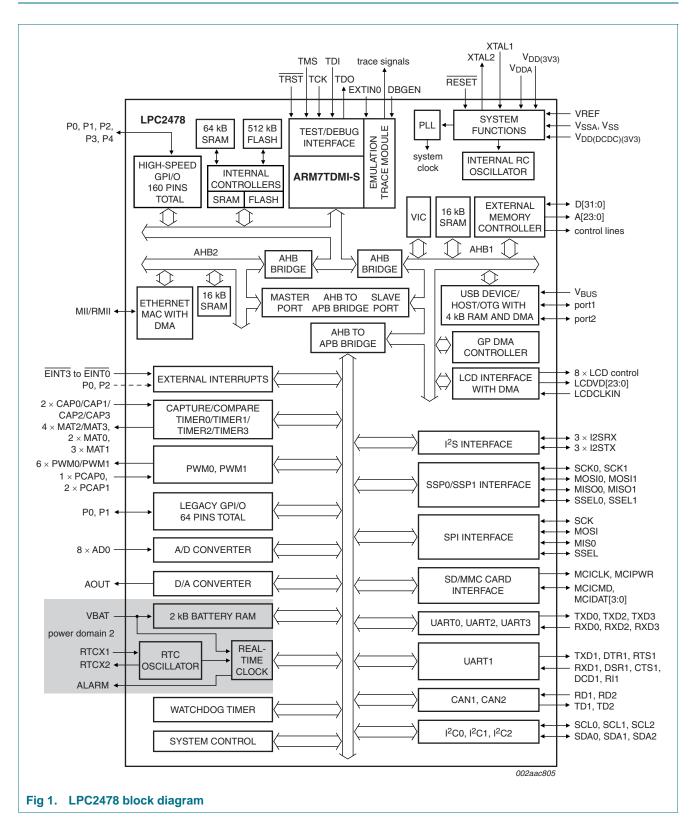
Table 1.Ordering information

Type number	Package								
	Name	Description	Version						
LPC2478FBD208	LQFP208	plastic low profile quad flat package; 208 leads; body $28 \times 28 \times 1.4$ mm	SOT459-1						
LPC2478FET208	TFBGA208	plastic thin fine-pitch ball grid array package; 208 balls; body 15 \times 15 \times 0.7 mm	SOT950-1						

4.1 Ordering options

Table 2.OrderinType number	Flash		SR	AM (k	B)		External	OHC/ Devic	USB	DTG/ DHC/ Device + 4 kB	SD/	GP			Temp
	(kB)	Local bus	Ethernet buffer	GP/USB	RTC	Total	bus		+ 4 kB FIFO		ММС	DMA	ADC channels	DAC channels	range
LPC2478FBD208	512	64	16	16	2	98	Full 32-bit	MII/RMII	yes	2	yes	yes	8	1	–40 °C to +85 °C
LPC2478FET208	512	64	16	16	2	98	Full 32-bit	MII/RMII	yes	2	yes	yes	8	1	–40 °C to +85 °C

5. Block diagram

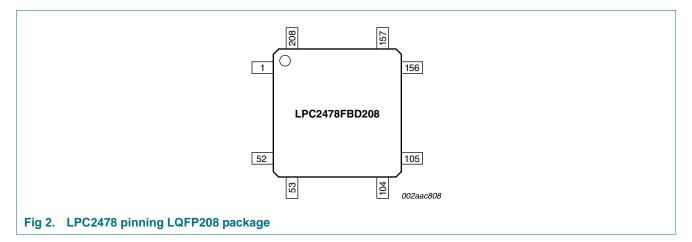


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6. Pinning information

6.1 Pinning



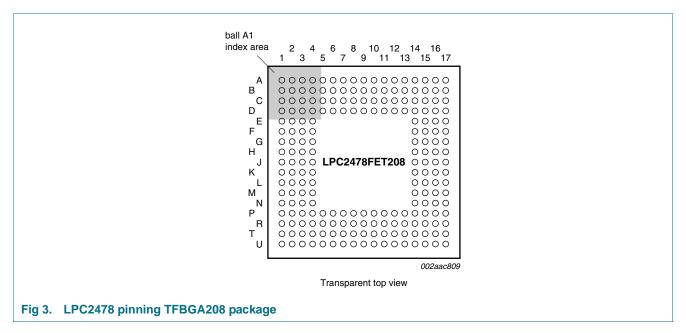


Table 3.Pin allocation table

Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol
Ro	w A						
1	P3[27]/D27/ CAP1[0]/PWM1[4]	2	V _{SSIO}	3	P1[0]/ENET_TXD0	4	P4[31]/CS1
5	P1[4]/ENET_TX_EN	6	P1[9]/ENET_RXD0	7	P1[14]/ENET_RX_ER	8	P1[15]/ ENET_REF_CLK/ ENET_RX_CLK
9	P1[17]/ENET_MDIO	10	P1[3]/ENET_TXD3/ MCICMD/PWM0[2]	11	P4[15]/A15	12	V _{SSIO}

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Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol
13	P3[20]/D20/ PWM0[5]/DSR1	14	P1[11]/ENET_RXD2/ MCIDAT2/PWM0[6]	15	P0[8]/I2STX_WS/ LCDVD[16]/MISO1/ MAT2[2]	16	P1[12]/ENET_RXD3/ MCIDAT3/PCAP0[0]
17	P1[5]/ENET_TX_ER/ MCIPWR/PWM0[3]		-		-		-
Row	/ В						
1	P3[2]/D2	2	P3[10]/D10	3	P3[1]/D1	4	P3[0]/D0
5	P1[1]/ENET_TXD1	6	V _{SSIO}	7	P4[30]/CS0	8	P4[24]/OE
9	P4[25]/WE	10	P4[29]/BLS3/MAT2[1]/ LCDVD[7]/LCDVD[11]/ LCDVD[3]/RXD3	11	P1[6]/ENET_TX_CLK/ MCIDAT0/PWM0[4]	12	P0[4]/I2SRX_CLK/ LCDVD[0]/RD2/CAP2[0
13	V _{DD(3V3)}	14	P3[19]/D19/ PWM0[4]/DCD1	15	P4[14]/A14	16	P4[13]/A13
17	P2[0]/PWM1[1]/TXD1/ TRACECLK/LCDPWR		-		-		-
Row	/ C						
1	P3[13]/D13	2	TDI	3	RTCK	4	P0[2]/TXD0
5	P3[9]/D9	6	P3[22]/D22/ PCAP0[0]/RI1	7	P1[8]/ENET_CRS_DV/ ENET_CRS	8	P1[10]/ENET_RXD1
9	V _{DD(3V3)}	10	P3[21]/D21/ PWM0[6]/DTR1	11	P4[28]/BLS2/MAT2[0]/ LCDVD[6]/LCDVD[10]/ LCDVD[2]/TXD3	12	P0[5]/I2SRX_WS/ LCDVD[1]/TD2/CAP2[1
13	P0[7]/l2STX_CLK/ LCDVD[9]/SCK1/ MAT2[1]	14	P0[9]/I2STX_SDA/ LCDVD[17]/MOSI1/ MAT2[3]	15	P3[18]/D18/ PWM0[3]/CTS1	16	P4[12]/A12
17	V _{DD(3V3)}		-		-		-
Row	<i>i</i> D	- 1					
1	TRST	2	P3[28]/D28/ CAP1[1]/PWM1[5]	3	TDO	4	P3[12]/D12
5	P3[11]/D11	6	P0[3]/RXD0	7	V _{DD(3V3)}	8	P3[8]/D8
9	P1[2]/ENET_TXD2/ MCICLK/PWM0[1]	10	P1[16]/ENET_MDC	11	V _{DD(DCDC)(3V3)}	12	V _{SSCORE}
13	P0[6]/I2SRX_SDA/ LCDVD[8]/SSEL1/ MAT2[0]	14	P1[7]/ENET_COL/ MCIDAT1/PWM0[5]	15	P2[2]/PWM1[3]/CTS1/ PIPESTAT1/LCDDCLK	16	P1[13]/ENET_RX_DV
17	P2[4]/PWM1[5]/ DSR1/TRACESYNC/ LCDENAB/LCDM		-		-		-
Row	/ E						
1	P0[26]/AD0[3]/ AOUT/RXD3	2	ТСК	3	TMS	4	P3[3]/D3
14	P2[1]/PWM1[2]/RXD1/ PIPESTAT0/LCDLE	15	V _{SSIO}	16	P2[3]/PWM1[4]/DCD1/ PIPESTAT2/LCDFP	17	P2[6]/PCAP1[0]/RI1/ TRACEPKT1/ LCDVD[0]/LCDVD[4]
Row	/ F						
1	P0[25]/AD0[2]/ I2SRX_SDA/TXD3	2	P3[4]/D4	3	P3[29]/D29/ MAT1[0]/PWM1[6]	4	DBGEN
_PC247	P 1						© NXP B.V. 2007. All rights reserv

Table 3. Pin allocation table ...continued

Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol
4	P4[11]/A11	15	P3[17]/D17/ PWM0[2]/RXD1	16	P2[5]/PWM1[6]/ DTR1/TRACEPKT0/ LCDLP	17	P3[16]/D16/ PWM0[1]/TXD1
Rov	v G						
1	P3[5]/D5	2	P0[24]/AD0[1]/ I2SRX_WS/CAP3[1]	3	V _{DD(3V3)}	4	V _{DDA}
14	NC	15	P4[27]/BLS1	16	P2[7]/RD2/ RTS1/TRACEPKT2/ LCDVD[1]/LCDVD[5]	17	P4[10]/A10
Rov	v H						
1	P0[23]/AD0[0]/ I2SRX_CLK/CAP3[0]	2	P3[14]/D14	3	P3[30]/D30/ MAT1[1]/RTS1	4	V _{DD(DCDC)(3V3)}
14	V _{SSIO}	15	P2[8]/TD2/TXD2/ TRACEPKT3/ LCDVD[2]/LCDVD[6]	16	P2[9]/ USB_CONNECT1/ RXD2/EXTIN0/ LCDVD[3]/LCDVD[7]	17	P4[9]/A9
Rov	v J						
1	P3[6]/D6	2	V _{SSA}	3	P3[31]/D31/MAT1[2]	4	NC
14	P0[16]/RXD1/ SSEL0/SSEL	15	P4[23]/A23/ RXD2/MOSI1	16	P0[15]/TXD1/ SCK0/SCK	17	P4[8]/A8
Rov	v K						
1	VREF	2	RTCX1	3	RSTOUT	4	V _{SSCORE}
14	P4[22]/A22/ TXD2/MISO1	15	P0[18]/DCD1/ MOSI0/MOSI	16	V _{DD(3V3)}	17	P0[17]/CTS1/ MISO0/MISO
Rov	v L						
1	P3[7]/D7	2	RTCX2	3	V _{SSIO}	4	P2[30]/DQMOUT2/ MAT3[2]/SDA2
14	NC	15	P4[26]/BLS0	16	P4[7]/A7	17	P0[19]/DSR1/ MCICLK/SDA1
Rov		0	DEOFT	0		4	
1	P3[15]/D15	2	RESET	3	VBAT	4	XTAL1
14	P4[6]/A6	15	P4[21]/A21/ SCL2/SSEL1	16	P0[21]/RI1/ MCIPWR/RD1	17	P0[20]/DTR1/ MCICMD/SCL1
Rov		•					
1	ALARM	2	P2[31]/DQMOUT3/ MAT3[3]/SCL2	3	P2[29]/DQMOUT1	4	XTAL2
14	P2[12]/EINT2/ LCDVD[4]/LCDVD[8]/ LCDVD[3]/LCDVD[18]/ MCIDAT2/I2STX_WS	15	P2[10]/EINT0	16	V _{SSIO}	17	P0[22]/RTS1/ MCIDAT0/TD1
Rov	v P						
1	P1[31]/USB_OVRCR2/ SCK1/AD0[5]	2	P1[30]/USB_PWRD2/ V _{BUS} /AD0[4]	3	P2[27]/CKEOUT3/ MAT3[1]/MOSI0	4	P2[28]/DQMOUT0
5	P2[24]/CKEOUT0	6	V _{DD(3V3)}	7	P1[18]/USB_UP_LED1/ PWM1[1]/CAP1[0]	8	V _{DD(3V3)}

Table 3. Pin allocation table ...continued

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MISO1/AD0[6] MOS11/AD0[7] MOS1/AD0[7] 5 P3[24]/D24/ CAP0[1]/PWM1[1] 6 P0[30]/USB_D-1 7 P2[19]/CLKOUT1 8 P1[21]/USB_T LCDVD[12]/LCDVD[20]/ PVM1[6]/CAP0[0] 9 V _{SSIO} 10 P1[26]/USB_SSPND1/ LCDVD[12]/LCDVD[20]/ PVM1[6]/CAP0[0] 11 P2[16]/CAS 12 P2[14]/CS2/C, SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - 17 P4[20]/A20/SDA2/SCK1 - - - - 18 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - - 19 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14]/ LCDVD[11]/LCDVD[15]/ USB_HSTENI/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_IT LCDVD[13]/LCDVD[13]/ LCDVD[13]/LCDVD[14]/ LCDVD[14]/LCDVD[22)/ PCA+1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCDVD	Table 3. Pin allocation tablecontinued									
LCDVD[9]/LCDVD[13]/ LCDVD 13 P2[15]/CS3/ CAP2[1]/SCL1 14 P4[17]/A17 15 P4[18]/A18 16 P4[19]/A19 17 Voncxv3) - - - - - Row R 1 P0[12]/USB_PPWR2/ MIS01/AD0[6] 2 P0[13]/USB_UP_LED2/ MOS11/AD0[7] 3 P0[28]/SCL0 4 P2[25]/CKE0/ LCDVD[7]/LC/ PWM1[3]/SSE 5 P3[24]/D24/ CAP0[1]/PWM1[1] 6 P0[30]/USB_D-11 7 P2[19]/CLKOUT1 8 P1[21]/USB_ LCDVD[7]/LC/ PWM1[3]/SSE 9 Vssio 10 P1[26]/USB_SSPND1/ LCDVD[12]/LCDVD[20/ PWM1[6]/CAP0[0] 11 P2[16]/CAS 12 P2[14]/CS2/C SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - 18 P0[27]/SDA0 2 P0[31]/USB_LSL3// LCDVD[11]/LCDVD[15]/ USB_LSTETMI/M11[1] 7 P0[14]/USB_HSTEN2/ USB_CONRECT2/ SSEL1 8 P2[20]/DVCS3/ LCDVD[13]/MLSD/JSCL1 15 P0[10]/LTD2/SDA2// MAT3[0] 16	Symbol	I	Pin	Symbol	Pin	Symbol	Pin	Symbol		
CAP2[1]/SCL1 - - - 17 Vob[qv3) - - - Row R - - - - 1 P0[12]/USB_PPWR2/ MISO1/AD0[6] 2 P0[13]/USB_UP_LED2/ MOSI1/AD0[7] 3 P0[28]/SCL0 4 P2[25]/CKEOU 5 P3[24/D24/ CAP0[1]/PWM1[1] 6 P0[30]/USB_D-1 7 P2[19]/CLKOUT1 8 P1[21/USB_T LCD/D1[7]/LCD/D[20/ PWM1[6]/CAS 12 P2[14]/CS2/C/ SDA1 9 Vssio 10 P1[26]/USB_SSPND1/ LCD/D[12]/LCD/D[20/ PWM1[6]/CAS 12 P2[14]/CS2/C/ SDA1 SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - - 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P3[26]/D26/ MAT3[1]/PWM1[3] 4 P2[26]/CKEOU MAT3[0]/PWM1[3] 4 P2[26]/CKEOU MAT3[0]/PWM1[3] 5 P2[20]/DYCS2 5 2 P0[31]/USB_DE_ST CAP0[0]/PCAP1[0] 7 P0[1	LCDVD[[9]/LCDVD[13]/	10	V _{SSCORE}		V _{DD(DCDC)(3V3)}	12	V _{SSIO}		
Row R P0[12]/USB_PPWR2/ MIS01/AD0[6] 2 P0[13]/USB_UP_LED2/ MOS11/AD0[7] 3 P0[28]/SCL0 4 P2[25]/CKEOL 5 P3[24/D24/ CAP0[1]/PWM1[1] 6 P0[30]/USB_D-1 7 P2[19]/CLKOUT1 8 P1[21]/USB_T LCDVD[7]/LCI PWM1[3]/SSE 9 V _{SSIO} 10 P1[26]/USB_SSPND1/ LCDVD[12]/LCDVD[20]/ PWM1[6]/CAP0[0] 11 P2[16]/CAS 12 P2[14]/CS2/C SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ PWM1[6]/CAP0[0] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - - 1 P0[27]/SDA0 2 P0[31]/USB_D+2 3 P3[26]/D26/ MAT0[1/PWM1[3] 4 P2[26]/CKEOU MAT3[0]/PWM1[3] 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCS5 9 P1[24]/USB_RX_DM1/ LCDVD[14]/ PVM1[5]/MOS10 10 P1[25]/USB_LS1/ LCDVD[14]/ EOVD[14]/LCDVD[14]/ PO(1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[14]/ PCAP1[0]/MAT0[0] 14 P0[1]			14	P4[17]/A17		P4[18]/A18	16	P4[19]/A19		
1 P0[12]/USB_PPWR2/ MIS01/AD0[6] 2 P0[13]/USB_UP_LED2/ MOS11/AD0[7] 3 P0[28]/SCL0 4 P2[25]/CKE0U 5 P3[24]/D24/ CAP0[1]/PWM1[1] 6 P0[30]/USB_D-1 7 P2[19]/CLKOUT1 8 P1[21]/USB_T LCDVD[7]/LC1 PWM1[3]/SSE 9 VSSI0 10 P1[26]/USB_SSPND1/ LCDVD[12]/LCDVD[20]/ PWM1[6]/CAP0[0] 11 P2[16]/GAS 12 P2[14]/CS2/CJ SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - - 17 P4[20]/A20/SDA2/SCK1 - - - - - 18 P0[27]/SDA0 2 P0[31]/USB_D+2 3 P3[26]/D26/ MAT0[1]/PWM1[3] 4 P2[26]/CKE0U MAT3[0]/PCM1[3] 8 P2[20]/DYCS0 5 VSI0 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCS0 13 P1[24]/USB_RX_DM1/ LCDVD[14]/LCDVD[14]/ LCDVD[14]/LCDVD[22/ PCAP1[0]/MAT0[0] 10 P4[12]/U	V _{DD(3V3)})		-		-		-		
MISO1/AD0[6] MOS11/AD0[7] MOS1/AD0[7] 5 P3[24]/D24/ CAP0[1]/PWM1[6] 6 P0[30]/USB_D-1 7 P2[19]/CLKOUT1 8 P1[21]/USB_T LCDVD[12]/LCDVD[20]/ PWM1[6]/CAP0[0] 9 V _{SSIO} 10 P1[26]/USB_SSPND1/ LCDVD[12]/LCDVD[20]/ PVMM1[6]/CAP0[0] 11 P2[16]/CAS 12 P2[14]/CS2/C, SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - 17 P4[20]/A20/SDA2/SCK1 - - - - 18 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - - 19 P0[27]/SDA0 2 P0[31/USB_D+2 3 P3[26]/D26/ MAT3[0]/DES_DESEL1 8 P2[20]/DYCS0 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[14]/ DSB_HSTENI/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_IT LCDVD[13]/LCDVD[21]/ PUM1[5]/MCSIO 16	v R									
CAPO[1]/PWM1[1] D P1[26]/USB_SSPND1/ LCD/D[12]/LCD/D[20]/ PWM1[6]/CAPO[0] 11 P2[16]/CAS 12 P2[14]/CS2/C SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - 1 P0[27]/SDA0 2 P0[31]/USB_D+2 3 P3[26]/D26// MAT0[1]/PWM1[3] 4 P2[26]/CKEOL MAT3[0]/MISC 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCS0 9 P1[24]/USB_SXL1/ LCDVD[10]/LCDVD[14/J PWM1[5]/MOSI0 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[14/J PWM1[5]/MOSI0 11 P4[2]/A2 12 P1[27]/USB_IT LCDVD[13]/LCDVD[14/J PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCL UCDVD[5]/LCL UCDVD[5]/LCL UCDVD[5]/LCL UCDVD[5]/LCL UCDVD[5]/LCL UCDVD[5]/LCL UCDVD[6]/LCDVD[14]/ PCAP1[0]/MAT0[0] - - - - 17 P2[11]/EINT1/ LCDVCLNIN/ MCIDAT1/12STX_CLK 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0]/PWM1[2]/SCKO <td></td> <td></td> <td>2</td> <td></td> <td>3</td> <td>P0[28]/SCL0</td> <td>4</td> <td>P2[25]/CKEOUT1</td>			2		3	P0[28]/SCL0	4	P2[25]/CKEOUT1		
LCDVD[12]/LCDVD[20]/ PWM1[6]/CAP0[0] SDA1 13 P2[17]/RAS 14 P0[11]/RXD2/SCL2/ MAT3[1] 15 P4[4]/A4 16 P4[5]/A5 17 P4[20]/A20/SDA2/SCK1 - - - - 10 P0[27]/SDA0 2 P0[31]/USB_D+2 3 P3[26]/D26// MAT3[1]/PWM1[3] 4 P2[26]/CKE0/ MAT3[0]/MISC 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCSC 9 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14// PWM1[5]/MOSI0 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[15]/ USB_HSTEN1/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_IT LCDVD[13]/LCDVD[14]/ USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22// PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LC1 LCDVD[19]/MI I2STX_SDA 17 P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/12STX_CLK - - - - 10 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_D 5 <td></td> <td></td> <td>6</td> <td>P0[30]/USB_D-1</td> <td>7</td> <td>P2[19]/CLKOUT1</td> <td>8</td> <td>P1[21]/USB_TX_DM1/ LCDVD[7]/LCDVD[11]/ PWM1[3]/SSEL0</td>			6	P0[30]/USB_D-1	7	P2[19]/CLKOUT1	8	P1[21]/USB_TX_DM1/ LCDVD[7]/LCDVD[11]/ PWM1[3]/SSEL0		
MAT3[1] MAT3[1] 17 P4[20]/A20/SDA2/SCK1 - - Row T - - - 1 P0[27]/SDA0 2 P0[31]/USB_D+2 3 P3[26]/D26/ MAT0[1]/PWM1[3] 4 P2[26]/CKEOL MAT3[0]/MISC 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCSC 9 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14]/ PWM1[5]/MOSI0 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[15]/ USB_HSTEN1/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_II LCDVD[13]/LC USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22]/ PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCI LCDVD[5]/LCI LCDVD[5]/LCI LCDVD[19]/MI I2STX_SDA 17 P2[11]/EINT1/ LCDLCKIN/ MCIDAT1/I2STX_CLK - - - - 1 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_E 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/ <u>USB_TX_E1/</u> USB_FX_DP1/ USB_PPWRD1 7 P1[20]/USB_TX_DP	V _{SSIO}		10	LCDVD[12]/LCDVD[20]/	11	P2[16]/CAS	12	P2[14]/CS2/CAP2[0]/ SDA1		
Row T Po[27]/SDA0 2 Po[31]/USB_D+2 3 P3[26]/D26/ MAT0[1]/PWM1[3] 4 P2[26]/CKEOU MAT3[0]/MISC 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCSC 9 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14]/ USB_DVD[10]/LCDVD[14]/ USB_DTETN1/MAT1[1] 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[15]/ USB_DSLST 11 P4[2]/A2 12 P1[27]/JUSB_II LCDVD[13]/LCDVD[13]/ USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22]/ PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCI LCDVD[19]/MI 12STX_SDA 17 P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/12STX_CLK - - - - 10 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_E LCDVD[6]/LCDVD[0]/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[0]/ USB_PWR1[2]/SCK0 8 P1[22]/USB_C CAP3[0]/SCK0 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(GV3)}	P2[17]/R	RAS	14		15	P4[4]/A4	16	P4[5]/A5		
1 P0[27]/SDA0 2 P0[31]/USB_D+2 3 P3[26]/D26/ MAT0[1]/PWM1[3] 4 P2[26]/CKEOL MAT3[0]/MISC 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCS0 9 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14]/ PWM1[5]/MOSIO 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[15]/ USB_HSTEN1/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_IT LCDVD[13]/LC USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22)/ PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCI LCDVD[5]/LCI LCDVD[5]/LCI LCDVD[14]/MAT0[0]/PWM1[2] 17 P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/I2STX_CLK - - - - 1 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_D 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_E LCDVD[8]/CCI 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12	P4[20]/A	A20/SDA2/SCK1		-		-		-		
MATO[1]/PWM1[3] MAT3[0]/MISC 5 V _{SSIO} 6 P3[23]/D23/ CAP0[0]/PCAP1[0] 7 P0[14]/USB_HSTEN2/ USB_CONNECT2/ SSEL1 8 P2[20]/DYCSC 9 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14]/ PWM1[5]/MOSIO 10 P1[25]/USB_LS1/ UCDVD[11]/LCDVD[15]/ USB_HSTEN1/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_II LCDVD[13]/LCDVD[13]/ USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22]/ PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCI LCDVD[19]/MCI 2STX_SDA 17 P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/I2STX_CLK - - - - 1 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_C 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_C CAP3[0]/SCK0 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15	v T									
CAPO[0]/PCAP1[0] USB_CONNECT2/ SSEL1 USB_CONNECT2/ SSEL1 9 P1[24]/USB_RX_DM1/ LCDVD[10]/LCDVD[14]/ PWM1[5]/MOSI0 10 P1[25]/USB_LS1/ LCDVD[11]/LCDVD[15]/ USB_HSTEN1/MAT1[1] 11 P4[2]/A2 12 P1[27]/USB_IT LCDVD[13]/LC USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22]/ PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCI USB_PPWR1/CAP1[1] 3 P2[18]/CLKOUT0 4 P0[29]/USB_CI LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_F LCDVD[8]/LCI USB_PWRD1, 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD[3V3}) 14 P1[29]/USB_SDA1/ 15 <td>P0[27]/S</td> <td>SDA0</td> <td>2</td> <td>P0[31]/USB_D+2</td> <td>3</td> <td></td> <td>4</td> <td>P2[26]/CKEOUT2/ MAT3[0]/MISO0</td>	P0[27]/S	SDA0	2	P0[31]/USB_D+2	3		4	P2[26]/CKEOUT2/ MAT3[0]/MISO0		
LCDVD[10]/LCDVD[14]/ PWM1[5]/MOSI0 LCDVD[11]/LCDVD[15]/ USB_HSTEN1/MAT1[1] LCDVD[13]/LCI USB_OVRCR 13 P1[28]/USB_SCL1/ LCDVD[14]/LCDVD[22]/ PCAP1[0]/MAT0[0] 14 P0[1]/TD1/RXD3/SCL1 15 P0[10]/TXD2/SDA2/ MAT3[0] 16 P2[13]/EINT3/ LCDVD[5]/LCI LCDVD[5]/LCI LCDVD[19]/MAT3[0] 17 P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/I2STX_CLK - - - - 1 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_D 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_R LCDVD[8]/LCI USB_PWR01/ 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3	V _{SSIO}		6		7	USB_CONNECT2/	8	P2[20]/DYCS0		
LCDVD[14]/LCDVD[22]/ PCAP1[0]/MAT0[0] MAT3[0] LCDVD[5]/LCI LCDVD[19]/M I2STX_SDA 17 P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/I2STX_CLK - - - 10 VU - - - - 11 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_D 11 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_D 15 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_R LCDVD[8]/LCI USB_PWRD1, 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3	LCDVD[[10]/LCDVD[14]/	10	LCDVD[11]/LCDVD[15]/	11	P4[2]/A2	12	P1[27]/USB_INT1/ LCDVD[13]/LCDVD[21]/ USB_OVRCR1/CAP0[1]		
LCDCLKIN/ MCIDAT1/I2STX_CLK POIDE Row U Point 3 P2[18]/CLKOUTO 4 P0[29]/USB_D 1 USB_D-2 2 P3[25]/D25/ MAT0[0]/PWM1[2] 3 P2[18]/CLKOUTO 4 P0[29]/USB_D 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_R LCDVD[8]/LCI USB_PWRD1, 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3	LCDVD[[14]/LCDVD[22]/	14	P0[1]/TD1/RXD3/SCL1	15		16	P2[13]/EINT3/ LCDVD[5]/LCDVD[9]/ LCDVD[19]/MCIDAT3/ I2STX_SDA		
1 USB_D-2 2 P3[25]/D25/ MATO[0]/PWM1[2] 3 P2[18]/CLKOUT0 4 P0[29]/USB_D 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_R LCDVD[8]/LCDVD[8]/LCDVD USB_PWRD1/ 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3	LCDCLK	KIN/		-		-		-		
MATO[0]/PWM1[2] MATO[0]/PWM1[2] 5 P2[23]/DYCS3/ CAP3[1]/SSEL0 6 P1[19]/USB_TX_E1/ USB_PPWR1/CAP1[1] 7 P1[20]/USB_TX_DP1/ LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 8 P1[22]/USB_R LCDVD[8]/LCI USB_PWRD1/ 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3	v U									
CAP3[1]/SSEL0 USB_PPWR1/CAP1[1] LCDVD[6]/LCDVD[10]/ PWM1[2]/SCK0 LCDVD[8]/LCI USB_PWRD1/ 9 P4[0]/A0 10 P4[1]/A1 11 P2[21]/DYCS1 12 P2[22]/DYCS2 CAP3[0]/SCK0 13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3	USB_D-	-2	2		3	P2[18]/CLKOUT0	4	P0[29]/USB_D+1		
CAP3[0]/SCK(13 V _{DD(3V3)} 14 P1[29]/USB_SDA1/ 15 P0[0]/RD1/TXD/SDA1 16 P4[3]/A3			6		7	LCDVD[6]/LCDVD[10]/	8	P1[22]/USB_RCV1/ LCDVD[8]/LCDVD[12]/ USB_PWRD1/MAT1[0]		
	P4[0]/A0	0	10	P4[1]/A1	11	P2[21]/DYCS1	12	P2[22]/DYCS2/ CAP3[0]/SCK0		
PCAP1[1]/MAT0[1]	V _{DD(3V3)})	14	LCDVD[15]/LCDVD[23]/	15	P0[0]/RD1/TXD/SDA1	16	P4[3]/A3		
17 P4[16]/A16	P4[16]/A	A16		-		-		-		

Table 3. Pin allocation table ...continued

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6.2 Pin description

Symbol	Pin	Ball	Туре	Description
P0[0] to P0[31]			I/O	Port 0: Port 0 is a 32-bit I/O port with individual direction controls for each bit. The operation of port 0 pins depends upon the pin function selected via the Pin Connect block.
P0[0]/RD1/TXD3/	94 <mark>1]</mark>	U15 <mark>11</mark>	I/O	P0[0] — General purpose digital input/output pin.
SDA1			I	RD1 — CAN1 receiver input.
			0	TXD3 — Transmitter output for UART3.
			I/O	SDA1 — I ² C1 data input/output (this is not an open-drain pin).
P0[1]/TD1/RXD3/	96 <mark>1]</mark>	T14 <mark>11</mark>	I/O	P0[1] — General purpose digital input/output pin.
SCL1			0	TD1 — CAN1 transmitter output.
			I	RXD3 — Receiver input for UART3.
			I/O	SCL1 — I ² C1 clock input/output (this is not an open-drain pin).
P0[2]/TXD0	202[1]	C4[1]	I/O	P0[2] — General purpose digital input/output pin.
			0	TXD0 — Transmitter output for UART0.
P0[3]/RXD0		D6[1]	I/O	P0[3] — General purpose digital input/output pin.
			I	RXD0 — Receiver input for UART0.
P0[4]/I2SRX_CLK/ LCDVD[0]/RD2/ CAP2[0]	168 <mark>11</mark>	B12[1]	I/O	P0[4] — General purpose digital input/output pin.
				I/O
			0	LCDVD[0] — LCD data.[15]
			I	RD2 — CAN2 receiver input.
			I	CAP2[0] — Capture input for Timer 2, channel 0.
P0[5]/I2SRX_WS/	166 <mark>[1]</mark>	C12[1]	I/O	P0[5] — General purpose digital input/output pin.
LCDVD[1]/TD2/ CAP2[1]			I/O	I2SRX_WS — I ² S Receive word select. It is driven by the master and received by the slave. Corresponds to the signal WS in the I^2S -bus specification. ^[15]
			0	LCDVD[1] — LCD data.[15]
			0	TD2 — CAN2 transmitter output.
			I	CAP2[1] — Capture input for Timer 2, channel 1.
P0[6]/I2SRX_SDA/	164 <mark>11</mark>	D13[1]	I/O	P0[6] — General purpose digital input/output pin.
LCDVD[8]/ SSEL1/MAT2[0]			I/O	I2SRX_SDA — I ² S Receive data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the l^2S -bus specification. ^[15]
			0	LCDVD[8] — LCD data.[15]
			I/O	SSEL1 — Slave Select for SSP1.
			0	MAT2[0] — Match output for Timer 2, channel 0.

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Symbol	Pin	Ball	Туре	Description
P0[7]/I2STX_CL		C13 ^[1]	I/O	P0[7] — General purpose digital input/output pin.
LCDVD[9]/SCK1 MAT2[1]	/		I/O	I2STX_CLK — I ² S transmit clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>I</i> ² S-bus specification. ^[15]
			0	LCDVD[9] — LCD data.[15]
			I/O	SCK1 — Serial Clock for SSP1.
			0	MAT2[1] — Match output for Timer 2, channel 1.
P0[8]/I2STX_WS	S/ 160[1]	A15 <mark>[1]</mark>	I/O	P0[8] — General purpose digital input/output pin.
LCDVD[16]/ MISO1/MAT2[2]			I/O	I2STX_WS — I^2S Transmit word select. It is driven by the master and received by the slave. Corresponds to the signal WS in the I^2S -bus specification. ^[15]
			0	LCDVD[16] — LCD data. ^[15]
			I/O	MISO1 — Master In Slave Out for SSP1.
			0	MAT2[2] — Match output for Timer 2, channel 2.
P0[9]/I2STX_SD	A/ 158[1]	C14[1]	I/O	P0[9] — General purpose digital input/output pin.
LCDVD[17]/ MOSI1/MAT2[3]			I/O	I2STX_SDA — I ² S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the l^2S -bus specification. ^[15]
			0	LCDVD[17] — LCD data.[15]
			I/O	MOSI1 — Master Out Slave In for SSP1.
			0	MAT2[3] — Match output for Timer 2, channel 3.
P0[10]/TXD2/	98 <mark>[1]</mark>	T15 <mark>11</mark>	I/O	P0[10] — General purpose digital input/output pin.
SDA2/MAT3[0]			0	TXD2 — Transmitter output for UART2.
			I/O	SDA2 — I ² C2 data input/output (this is not an open-drain pin).
			0	MAT3[0] — Match output for Timer 3, channel 0.
P0[11]/RXD2/	100[1]	R14[1]	I/O	P0[11] — General purpose digital input/output pin.
SCL2/MAT3[1]			Ι	RXD2 — Receiver input for UART2.
			I/O	SCL2 — I^2C2 clock input/output (this is not an open-drain pin).
			0	MAT3[1] — Match output for Timer 3, channel 1.
P0[12]/ USB_PPWR2/	41 <mark>2</mark>	R1 ^[2]	I/O	P0[12] — General purpose digital input/output pin.
MISO1/AD0[6]			0	USB_PPWR2 — Port Power enable signal for USB port 2.
			I/O	MISO1 — Master In Slave Out for SSP1.
			I	AD0[6] — A/D converter 0, input 6.
P0[13]/	45 <mark>2</mark>	R2 ^[2]	I/O	P0[13] — General purpose digital input/output pin.
USB_UP_LED2/ MOSI1/AD0[7]			0	USB_UP_LED2 — USB port 2 GoodLink LED indicator. It is LOW when device is configured (non-control endpoints enabled). It is HIGH when the device is not configured or during global suspend.
			I/O	MOSI1 — Master Out Slave In for SSP1.
			Ι	AD0[7] — A/D converter 0, input 7.

Table 4. Pin description ...continued

Symbol	Pin	Ball	Туре	Description	
P0[14]/	69 <mark>11</mark>	[<u>1]</u> T7[<u>1]</u>	I/O	P0[14] — General purpose digital input/output pin.	
USB_HSTEN2/ USB_CONNECT2/			0	USB_HSTEN2 — Host Enabled status for USB port 2.	
SSEL1			0	USB_CONNECT2 — SoftConnect control for USB port 2. Signal used to switch an external 1.5 k Ω resistor under software control. Used with the SoftConnect USB feature.	
			I/O	SSEL1 — Slave Select for SSP1.	
P0[15]/TXD1/	128 <mark>1]</mark>	J16 <mark>11</mark>	I/O	P0[15] — General purpose digital input/output pin.	
SCK0/SCK			0	TXD1 — Transmitter output for UART1.	
			I/O	SCK0 — Serial clock for SSP0.	
			I/O	SCK — Serial clock for SPI.	
P0[16]/RXD1/	130 <mark>1]</mark>	J14 <mark>[1]</mark>	I/O	P0 [16] — General purpose digital input/output pin.	
SSEL0/SSEL			I	RXD1 — Receiver input for UART1.	
			I/O	SSEL0 — Slave Select for SSP0.	
			I/O	SSEL — Slave Select for SPI.	
P0[17]/CTS1/	126 <mark>1]</mark>	K17[1]	I/O	P0[17] — General purpose digital input/output pin.	
MISO0/MISO			Ι	CTS1 — Clear to Send input for UART1.	
			I/O	MISO0 — Master In Slave Out for SSP0.	
			I/O	MISO — Master In Slave Out for SPI.	
P0[18]/DCD1/	124 <mark>11</mark>	K15[1]	I/O	P0[18] — General purpose digital input/output pin.	
MOSI0/MOSI			Ι	DCD1 — Data Carrier Detect input for UART1.	
				I/O	MOSI0 — Master Out Slave In for SSP0.
			I/O	MOSI — Master Out Slave In for SPI.	
P0[19]/DSR1/	122 <mark>1</mark>]	L17 <mark>[1]</mark>	I/O	P0[19] — General purpose digital input/output pin.	
MCICLK/SDA1			Ι	DSR1 — Data Set Ready input for UART1.	
			0	MCICLK — Clock output line for SD/MMC interface.	
			I/O	SDA1 — I ² C1 data input/output (this is not an open-drain pin).	
P0[20]/DTR1/	120 <mark>1</mark>]	M17[1]	I/O	P0[20] — General purpose digital input/output pin.	
MCICMD/SCL1			0	DTR1 — Data Terminal Ready output for UART1.	
			I/O	MCICMD — Command line for SD/MMC interface.	
			I/O	SCL1 — I^2C1 clock input/output (this is not an open-drain pin).	
P0[21]/RI1/	118 <mark>11</mark>	M16 ^[1]	I/O	P0[21] — General purpose digital input/output pin.	
MCIPWR/RD1			Ι	RI1 — Ring Indicator input for UART1.	
			0	MCIPWR — Power Supply Enable for external SD/MMC power supply.	
			I	RD1 — CAN1 receiver input.	
P0[22]/RTS1/	116 <mark>11</mark>	N17 <mark>11</mark>	I/O	P0[22] — General purpose digital input/output pin.	
MCIDAT0/TD1			0	RTS1 — Request to Send output for UART1.	
			I/O	MCIDAT0 — Data line 0 for SD/MMC interface.	
			0	TD1 — CAN1 transmitter output.	

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Symbol	Pin	Ball	Туре	Description
P0[23]/AD0[0]/	18 <mark>2</mark>	H1[2]	I/O	P0[23] — General purpose digital input/output pin.
I2SRX_CLK/ CAP3[0]			Ι	AD0[0] — A/D converter 0, input 0.
CAF3[0]			I/O	I2SRX_CLK — Receive Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the l^2S -bus specification.
			I	CAP3[0] — Capture input for Timer 3, channel 0.
P0[24]/AD0[1]/	16 <mark>2]</mark>	G2 ^[2]	I/O	P0[24] — General purpose digital input/output pin.
I2SRX_WS/ CAP3[1]			Ι	AD0[1] — A/D converter 0, input 1.
0,4 0[1]			I/O	I2SRX_WS — Receive Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>l</i> ² <i>S</i> -bus specification.
			I	CAP3[1] — Capture input for Timer 3, channel 1.
P0[25]/AD0[2]/	14 <mark>2</mark>	F1 ^[2]	I/O	P0[25] — General purpose digital input/output pin.
I2SRX_SDA/ TXD3			Ι	AD0[2] — A/D converter 0, input 2.
17,00			I/O	I2SRX_SDA — Receive data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the PS -bus specification.
			0	TXD3 — Transmitter output for UART3.
P0[26]/AD0[3]/	12 <mark>[2][3]</mark>	E1[2][3]	I/O	P0[26] — General purpose digital input/output pin.
AOUT/RXD3			Ι	AD0[3] — A/D converter 0, input 3.
			0	AOUT — D/A converter output.
			I	RXD3 — Receiver input for UART3.
P0[27]/SDA0	50 <mark>[4]</mark>	T1 <u>^[4]</u>	I/O	P0[27] — General purpose digital input/output pin.
			I/O	SDA0 — I ² C0 data input/output. Open-drain output (for I ² C-bus compliance).
P0[28]/SCL0	48 <mark>[4]</mark>	R3 <mark>[4]</mark>	I/O	P0[28] — General purpose digital input/output pin.
			I/O	SCL0 — I ² C0 clock input/output. Open-drain output (for I ² C-bus compliance).
P0[29]/USB_D+1	61 <u>5</u>	U4 <mark>5</mark>	I/O	P0[29] — General purpose digital input/output pin.
			I/O	USB_D+1 — USB port 1 bidirectional D+ line.
P0[30]/USB_D-1	62 <mark>5</mark>	R6[5]	I/O	P0[30] — General purpose digital input/output pin.
			I/O	USB_D-1 — USB port 1 bidirectional D- line.
P0[31]/USB_D+2	51 <u>5</u>	T2 ^[5]	I/O	P0[31] — General purpose digital input/output pin.
			I/O	USB_D+2 — USB port 2 bidirectional D+ line.
P1[0] to P1[31]			I/O	Port 1: Port 1 is a 32 bit I/O port with individual direction controls for each bit. The operation of port 1 pins depends upon the pin function selected via the Pin Connect block.
P1[0]/	196 <mark>1]</mark>	A3[1]	I/O	P1[0] — General purpose digital input/output pin.
ENET_TXD0			0	ENET_TXD0 — Ethernet transmit data 0 (RMII/MII interface).
P1[1]/	194 <mark>11</mark>	B5 <mark>[1]</mark>	I/O	P1[1] — General purpose digital input/output pin.
ENET_TXD1			0	ENET_TXD1 — Ethernet transmit data 1 (RMII/MII interface).
P1[2]/	185 <mark>11</mark>	D9 <mark>[1]</mark>	I/O	P1[2] — General purpose digital input/output pin.
ENET_TXD2/ MCICLK/			0	ENET_TXD2 — Ethernet transmit data 2 (MII interface).
PWM0[1]			0	MCICLK — Clock output line for SD/MMC interface.
- 1 3			0	PWM0[1] — Pulse Width Modulator 0, output 1.

LPC2478_1 Preliminary data sheet Pin description ... continued

Table 4.

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Symbol Pin Ball Description Type P1[3]/ 177<mark>1</mark> A10[1] I/O P1[3] — General purpose digital input/output pin. ENET_TXD3/ Ο ENET_TXD3 — Ethernet transmit data 3 (MII interface). MCICMD/ I/O MCICMD — Command line for SD/MMC interface. PWM0[2] Ο **PWM0[2]** — Pulse Width Modulator 0. output 2. P1[4]/ 192[1] A5[1] I/O P1[4] — General purpose digital input/output pin. ENET_TX_EN Ο ENET_TX_EN — Ethernet transmit data enable (RMII/MII interface). P1[5]/ 156[1] A17[1] I/O P1[5] — General purpose digital input/output pin. ENET_TX_ER/ Ο ENET_TX_ER — Ethernet Transmit Error (MII interface). MCIPWR/ 0 MCIPWR — Power Supply Enable for external SD/MMC power supply. PWM0[3] 0 PWM0[3] — Pulse Width Modulator 0, output 3. P1[6]/ 171 B11[1] I/O P1[6] — General purpose digital input/output pin. ENET TX CLK/ I ENET_TX_CLK — Ethernet Transmit Clock (MII interface). MCIDAT0/ I/O MCIDAT0 — Data line 0 for SD/MMC interface. PWM0[4] Ο **PWM0[4]** — Pulse Width Modulator 0. output 4. P1[7]/ 153[1] D14[1] I/O P1[7] — General purpose digital input/output pin. ENET COL/ L ENET_COL — Ethernet Collision detect (MII interface). MCIDAT1/ I/O MCIDAT1 — Data line 1 for SD/MMC interface. PWM0[5] Ο **PWM0[5]** — Pulse Width Modulator 0. output 5. C7[1] P1[8]/ 190[1] I/O P1[8] — General purpose digital input/output pin. ENET_CRS_DV/ L ENET_CRS_DV/ENET_CRS — Ethernet Carrier Sense/Data Valid (RMII ENET CRS interface)/ Ethernet Carrier Sense (MII interface). A6[1] P1[9]/ 188[1] I/O P1[9] — General purpose digital input/output pin. ENET_RXD0 I ENET RXD0 — Ethernet receive data 0 (RMII/MII interface). 186<mark>[1]</mark> C8[1] I/O P1[10]/ P1[10] — General purpose digital input/output pin. ENET_RXD1 L ENET RXD1 — Ethernet receive data 1 (RMII/MII interface). P1[11]/ 163<mark>[1]</mark> A14[1] I/O P1[11] — General purpose digital input/output pin. ENET RXD2/ L ENET RXD2 — Ethernet Receive Data 2 (MII interface). MCIDAT2/ I/O MCIDAT2 — Data line 2 for SD/MMC interface. PWM0[6] Ο PWM0[6] — Pulse Width Modulator 0, output 6. P1[12]/ 157[1] A16[1] I/O P1[12] — General purpose digital input/output pin. ENET RXD3/ L ENET_RXD3 — Ethernet Receive Data (MII interface). MCIDAT3/ I/O MCIDAT3 — Data line 3 for SD/MMC interface. PCAP0[0] L PCAP0[0] — Capture input for PWM0, channel 0. 147[1] P1[13]/ D16^[1] I/O P1[13] — General purpose digital input/output pin. ENET_RX_DV I ENET_RX_DV — Ethernet Receive Data Valid (MII interface). P1[14]/ 184<mark>[1]</mark> A7[1] I/O P1[14] — General purpose digital input/output pin. ENET_RX_ER L ENET RX ER — Ethernet receive error (RMII/MII interface). P1[15]/ 182<mark>[1]</mark> A8[1] I/O P1[15] — General purpose digital input/output pin. ENET_REF_CLK/ ENET_REF_CLK/ENET_RX_CLK — Ethernet Reference Clock (RMII T ENET RX CLK

interface)/ Ethernet Receive Clock (MII interface).

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Symbol	Pin	Ball	Туре	Description
P1[16]/	180 <mark>11</mark>	D10 ¹¹	I/O	P1[16] — General purpose digital input/output pin.
ENET_MDC			I	ENET_MDC — Ethernet MIIM clock.
P1[17]/	178 <mark>11</mark>	A9 <mark>[1]</mark>	I/O	P1[17] — General purpose digital input/output pin.
ENET_MDIO			I/O	ENET_MDIO — Ethernet MI data input and output.
P1[18]/	66 <mark>[1]</mark>	P7 <mark>11</mark>	I/O	P1[18] — General purpose digital input/output pin.
USB_UP_LED1/ PWM1[1]/CAP1[0]			0	USB_UP_LED1 — USB port 1 GoodLink LED indicator. It is LOW when device is configured (non-control endpoints enabled). It is HIGH when the device is not configured or during global suspend.
			0	PWM1[1] — Pulse Width Modulator 1, channel 1 output.
			I	CAP1[0] — Capture input for Timer 1, channel 0.
P1[19]/	68 <mark>[1]</mark>	U6 <mark>[1]</mark>	I/O	P1[19] — General purpose digital input/output pin.
USB_TX_E1/ USB_PPWR1/ CAP1[1]			0	USB_TX_E1 — Transmit Enable signal for USB port 1 (OTG transceiver).
			0	USB_PPWR1 — Port Power enable signal for USB port 1.
			Ι	CAP1[1] — Capture input for Timer 1, channel 1.
P1[20]/	70 <mark>1]</mark>	U7 <mark>[1]</mark>	I/O	P1[20] — General purpose digital input/output pin.
USB_TX_DP1/ LCDVD[6]/			0	USB_TX_DP1 — D+ transmit data for USB port 1 (OTG transceiver).[16]
LCDVD[10]/			0	LCDVD[6]/LCDVD[10] — LCD data.[16]
PWM1[2]/SCK0			0	PWM1[2] — Pulse Width Modulator 1, channel 2 output.
			I/O	SCK0 — Serial clock for SSP0.
P1[21]/	72 <mark>1]</mark>	R8 <mark>[1]</mark>	I/O	P1[21] — General purpose digital input/output pin.
USB_TX_DM1/ LCDVD[7]/			0	USB_TX_DM1 — D- transmit data for USB port 1 (OTG transceiver).[16]
LCDVD[11]/			0	LCDVD[7]/LCDVD[11] — LCD data.[16]
PWM1[3]/SSEL0			0	PWM1[3] — Pulse Width Modulator 1, channel 3 output.
			I/O	SSEL0 — Slave Select for SSP0.
P1[22]/USB_RCV1/	74[1]	U8 <mark>[1]</mark>	I/O	P1[22] — General purpose digital input/output pin.
LCDVD[8]/ LCDVD[12]/ USB_PWRD1/			I	USB_RCV1 — Differential receive data for USB port 1 (OTG transceiver). ^[16]
MAT1[0]			0	LCDVD[8]/LCDVD[12] — LCD data.[16]
			I	USB_PWRD1 — Power Status for USB port 1 (host power switch).
			0	MAT1[0] — Match output for Timer 1, channel 0.
P1[23]/	76 <mark>1]</mark>	P9 <mark>[1]</mark>	I/O	P1[23] — General purpose digital input/output pin.
USB_RX_DP1/ LCDVD[9]/			I	USB_RX_DP1 — D+ receive data for USB port 1 (OTG transceiver).[16]
LCDVD[13]/			0	LCDVD[9]/LCDVD[13] — LCD data.[16]
PWM1[4]/MISO0			0	PWM1[4] — Pulse Width Modulator 1, channel 4 output.
			I/O	MISO0 — Master In Slave Out for SSP0.
P1[24]/	78 <mark>[1]</mark>	T9 <mark>[1]</mark>	I/O	P1[24] — General purpose digital input/output pin.
USB_RX_DM1/ LCDVD[10]/			I	USB_RX_DM1 — D- receive data for USB port 1 (OTG transceiver).[16]
LCDVD[14]/			0	LCDVD[10]/LCDVD[14] — LCD data.[16]
PWM1[5]/MOSI0			0	PWM1[5] — Pulse Width Modulator 1, channel 5 output.
			I/O	MOSI0 — Master Out Slave in for SSP0.

Preliminary data sheet

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Symbol	Pin	Ball	Туре	Description
P1[25]/USB_LS1/	80 <mark>11</mark>	T10 ^[1]	I/O	P1[25] — Genera
LCDVD[11]/ LCDVD[15]/			0	USB_LS1 — Lov
			\circ	

Table 4 Pin description ... continued

Symbol	PIN	Dali	туре	Description
P1[25]/USB_LS1/	80 <mark>[1]</mark>	T10 <mark>11</mark>	I/O	P1[25] — General purpose digital input/output pin.
LCDVD[11]/			0	USB_LS1 — Low Speed status for USB port 1 (OTG transceiver).[16]
LCDVD[15]/ USB_HSTEN1/			0	LCDVD[11]/LCDVD[15] — LCD data.[16]
MAT1[1]			0	USB_HSTEN1 — Host Enabled status for USB port 1.
			0	MAT1[1] — Match output for Timer 1, channel 1.
P1[26]/	82 <mark>1</mark>	R10 ^[1]	I/O	P1[26] — General purpose digital input/output pin.
USB_SSPND1/ LCDVD[12]/			0	USB_SSPND1 — USB port 1 Bus Suspend status (OTG transceiver).[16]
LCDVD[20]/			0	LCDVD[12]/LCDVD[20] — LCD data.[16]
PWM1[6]/CAP0[0]			0	PWM1[6] — Pulse Width Modulator 1, channel 6 output.
			Ι	CAP0[0] — Capture input for Timer 0, channel 0.
P1[27]/USB_INT1/	88 <mark>[1]</mark>	T12[1]	I/O	P1[27] — General purpose digital input/output pin.
LCDVD[13]/ LCDVD[21]/			Ι	USB_INT1 — USB port 1 ATX interrupt (OTG transceiver).[16]
USB_OVRCR1/			0	LCDVD[13]/LCDVD[21] — LCD data.[16]
CAP0[1]			Ι	USB_OVRCR1 — USB port 1 Over-Current status.
			Ι	CAP0[1] — Capture input for Timer 0, channel 1.
P1[28]/USB_SCL1/	90 <mark>11</mark>	T13[1]	I/O	P1[28] — General purpose digital input/output pin.
LCDVD[14]/ LCDVD[22]/			I/O	USB_SCL1 — USB port 1 I ² C serial clock (OTG transceiver). ^[16]
PCAP1[0]/MAT0[0]			0	LCDVD[14]/LCDVD[22] — LCD data.[16]
			I	PCAP1[0] — Capture input for PWM1, channel 0.
			0	MAT0[0] — Match output for Timer 0, channel 0.
P1[29]/USB_SDA1/	92 <mark>1</mark>	U14 <mark>11</mark>	I/O	P1[29] — General purpose digital input/output pin.
LCDVD[15]/ LCDVD[23]/			I/O	USB_SDA1 — USB port 1 I ² C serial data (OTG transceiver).[16]
PCAP1[1]/MAT0[1]			0	LCDVD[15]/LCDVD[23] — LCD data.[16]
			I	PCAP1[1] — Capture input for PWM1, channel 1.
			0	MAT0[1] — Match output for Timer 0, channel 0.
P1[30]/	42 <mark>2</mark>	P2 ^[2]	I/O	P1[30] — General purpose digital input/output pin.
USB_PWRD2/ V _{BUS} /AD0[4]			I	USB_PWRD2 — Power Status for USB port 2.
03/100[1]			Ι	V _{BUS} — Indicates the presence of USB bus power.
				Note: This signal must be HIGH for USB reset to occur.
			I	AD0[4] — A/D converter 0, input 4.
P1[31]/	40 <mark>[2]</mark>	P1 ²	I/O	P1[31] — General purpose digital input/output pin.
USB_OVRCR2/ SCK1/AD0[5]			Ι	USB_OVRCR2 — Over-Current status for USB port 2.
			I/O	SCK1 — Serial Clock for SSP1.
			Ι	AD0[5] — A/D converter 0, input 5.
P2[0] to P2[31]			I/O	Port 2: Port 2 is a 32-bit I/O port with individual direction controls for each bit. The operation of port 2 pins depends upon the pin function selected via the Pin Connect block.

Table 4. Pin description ...continued

	-in desc	cription			
Symbol		Pin	Ball	Туре	Description
P2[0]/PWM1		154 <mark>11</mark>	B17 <mark>11</mark>	I/O	P2[0] — General purpose digital input/output pin.
TXD1/TRAC	ECLK/			0	PWM1[1] — Pulse Width Modulator 1, channel 1 output.
				0	TXD1 — Transmitter output for UART1.
				0	TRACECLK — Trace clock. ^[17]
				0	LCDPWR — LCD panel power enable.[17]
P2[1]/PWM1		152 <mark>11</mark>	E14 <mark>11</mark>	I/O	P2[1] — General purpose digital input/output pin.
RXD1/PIPES	STAT0/			0	PWM1[2] — Pulse Width Modulator 1, channel 2 output.
LODLL				I	RXD1 — Receiver input for UART1.
				0	PIPESTAT0 — Pipeline status, bit 0.[17]
				0	LCDLE — Line end signal. ^[17]
P2[2]/PWM1		150 <mark>11</mark>	D15[1]	I/O	P2[2] — General purpose digital input/output pin.
CTS1/PIPES	STAT1/			0	PWM1[3] — Pulse Width Modulator 1, channel 3 output.
LCDDCLK				I	CTS1 — Clear to Send input for UART1.
				0	PIPESTAT1 — Pipeline status, bit 1.[17]
				0	LCDDCLK — LCD panel clock. ^[17]
P2[3]/PWM1	[4]/	144 <mark>1]</mark>	E16[1]	I/O	P2[3] — General purpose digital input/output pin.
DCD1/PIPE	STAT2/			0	PWM1[4] — Pulse Width Modulator 1, channel 4 output.
LCDFP				Ι	DCD1 — Data Carrier Detect input for UART1.
			0	PIPESTAT2 — Pipeline status, bit 2.[17]	
				0	LCDFP — Frame pulse (STN). Vertical synchronization pulse (TFT).[17]
P2[4]/PWM1	[5]/	142 ^[1]	D17[1]	I/O	P2[4] — General purpose digital input/output pin.
DSR1/	0/			0	PWM1[5] — Pulse Width Modulator 1, channel 5 output.
TRACESYN LCDENAB/L				I	DSR1 — Data Set Ready input for UART1.
				0	TRACESYNC — Trace Synchronization. ^[17]
				0	LCDENAB/LCDM — STN AC bias drive or TFT data enable output.[17]
P2[5]/PWM1	[6]/	140 <mark>11</mark>	F16 ^[1]	I/O	P2[5] — General purpose digital input/output pin.
DTR1/	. (0	PWM1[6] — Pulse Width Modulator 1, channel 6 output.
TRACEPKT	0/			0	DTR1 — Data Terminal Ready output for UART1.
2002.				0	TRACEPKT0 — Trace Packet, bit 0.[17]
				0	LCDLP — Line synchronization pulse (STN). Horizontal synchronization pulse (TFT). ^[17]
P2[6]/PCAP	1[0]/	138 <mark>1]</mark>	E17[1]	I/O	P2[6] — General purpose digital input/output pin.
RI1/				I	PCAP1[0] — Capture input for PWM1, channel 0.
TRACEPKT LCDVD[0]/	1/			Ι	RI1 — Ring Indicator input for UART1.
LCDVD[4]				0	TRACEPKT1 — Trace Packet, bit 1.[17]
				0	LCDVD[0]/LCDVD[4] — LCD data.[17]
P2[7]/RD2/		136 <mark>[1]</mark>	G16[1]	I/O	P2[7] — General purpose digital input/output pin.
RTS1/	. (Ι	RD2 — CAN2 receiver input.
TRACEPKT: LCDVD[1]/	2/			0	RTS1 — Request to Send output for UART1.
LCDVD[1]/ LCDVD[5]				0	TRACEPKT2 — Trace Packet, bit 2.[17]
				0	LCDVD[1]/LCDVD[5] — LCD data.[17]
				-	

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P2[8]/TD2/TXD2/ TRACEPKT3/ LCDVD[2]/ LCDVD[6]134[1]H15[1]I/OP2[8] — General purpose digital input/output pin.0TD2 — CAN2 transmitter output.0TXD2 — Transmitter output for UART2.0TRACEPKT3 — Trace packet, bit 3.[17]0LCDVD[2]/LCDVD[6] — LCD data.[17]0LCDVD[2]/LCDVD[6] — LCD data.[17]P2[9]/ USB_CONNECT1/ RXD2/EXTINO/ LCDVD[3]/ LCDVD[3]/ LCDVD[7]132[1]132[1]H16[1]10[2]H16[1]10[2]H16[1]110[2]N15[2]110[2]N15[2]110[2]N15[2]110[2]T17[2]110[3]T17[4]108[4]T17[5]108[4]T17[6]110[5]T17[6]110[6]T17[6]110[7]T17[6]110[8]T17[6]110[9]CP2[11] — General purpose digital input/output pin. Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset. I110[9]T17[6]110[9]T17[6]110[9]CP2[11] — General purpose digital input/output pin. Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset. I110[9]T17[9]120[11] — General purpose digital input/output pin. I EINT1 — External interrupt 0 input. I EINT1 — External interrupt 1 input.[19] O1110[9]CDCLKIN — LCD clock.[19] I/O120[11] — General purpose digital input/output pin. I EINT1 — External interrupt 1 input.[19] O <t< th=""><th>Table 4.</th><th>Pin dese</th><th>cription</th><th>.continued</th><th></th><th></th></t<>	Table 4.	Pin dese	cription	.continued		
TRÀCEPKT3/ LCDVD[9] 0 TD2 – CAN2 transmitter output. O TX02 – Transmitter output. 0 LCDVD[9] 0 TX02 – Transmitter output. 0 VERDENT3/ LCDVD[9] 132!! H16!! VO P2[9] – General purpose digital input/output pin. VSB_CONNECT1/ VSD2EXTIN0/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ H16!! VO P2[9] – General purpose digital input/output pin. VSD2EXTIN0/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[4]/ LCDVD[3]/ LCDVD[4]/	Symbol		Pin	Ball	Туре	Description
LCDVD[2] 0 102 - CAR2 diamination duput for UART2. LCDVD[6] 0 TX02 - Transmitter output for UART2. 0 LCOVD[2]/LCDVD[6] - LCD data[12] 0 LCOVD[2]/LCDVD[6] - LCD data[12] 0 USB_CONNECT1 / ISBI SoliConnect control. Signal used to switch an external 1.5 kG resistor under the software control. Used with the SoftConnect USB feature. 1 RXD2 - Receiver input for UART2. 1 EXTNO - External Trigger Input[12] 1 LCOVD[3]/LCDVD[7] - LCD data[12] P2[10]/EINT0 1108 N158 P2[11]/EINT1/ 1088 T178 1 EINT0 - External interrupt 0 input. P2[11]/EINT1/ 1088 T178 1 EINT1 - External interrupt 1 input[19] 1 EINT1 - External interrupt 1 input[19] 1 EINT2 - External interrupt 1 input[19] 1 EINT2 - External interrupt 2 input[19] 1 EINT2 - External interrupt 2 input[19] 1 EINT2 - External interupt 2 input[19] 1 <td< td=""><td></td><td></td><td>134<mark>11</mark></td><td>H15<mark>11</mark></td><td>I/O</td><td>P2[8] — General purpose digital input/output pin.</td></td<>			134 <mark>11</mark>	H15 <mark>11</mark>	I/O	P2[8] — General purpose digital input/output pin.
LCDVD[6] O TX02 — Transmitter output for UART2. 0 TRACEPKT3 — Trace packet, bit 3.1/2 O 0 D2[9]/ 132(1) H16(1) VO DBS CONNECT1 — USB1 SoftConnect control. Signal used to switch an external 15 K2 resistor under the software control. Used with the SoftConnect USB teature. I LCDVD[7] I EXTINO / LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/LCDVD[7] — LCD data.1/2 I EXTINO - External Trigger Input.1/2 I P2[10]/EINT0 110(9) N15(9) VO P2[10] — General purpose digital input/output pin. Note: LCDV on this pin while RESET is LCDW forces on-chip bootloader to take over control of the part after a reset. P2[11]/EINT1/ LCDCLKIN/ WCIDAT1/ I2STX_CLK 108(9) T17(9) VO P2[11] — General purpose digital input/output pin. VCIDAT1 — Data line 1 for SD/MMC interface. I/O LCDVD[4]/LCDVD[3/LCDVD[3/LCDVD[18] — LCD data.1(9) VCIDAT1 / I2STX_CLK VO EINT2 — External interrupt 2 input.1(9) VIO VESTY WS VIO WCIDAT1 — Data line 2 for SD/MMC interface. I/O UCDVD[4/ LCDVD[3/LCDVD[3/LCDVD[3/LCDVD[18] — LCD data.1(9) VO WCIDAT2 — Data line 2 for SD/MMC interface. I/O UCDVD[4/ LCDVD[4/ LCDVD[4/LCDVD[3/LCDVD[4/LCDVD[4/LCDVD[18] — LCD data.1(9) VO <td< td=""><td></td><td></td><td></td><td></td><td>0</td><td>TD2 — CAN2 transmitter output.</td></td<>					0	TD2 — CAN2 transmitter output.
0 LCDVD[2]/LCDVD[6] — LCD data.[12] P2[9]/ 132[1] H16[1] I/O P2[9] — General purpose digital input/output pin. USB_CONNECT1 / RXD2/EXTINU LCDVD[3]/ N15[2] H16[1] I/O P2[9] — General purpose digital input/output pin. LCDVD[3]/ LCDVD[7] N15[2] I EXTINO — External T:5 kQ resistor under the software control. Used with the SoftConnect USB feature. 1 EXTINO — External T:5 kQ resistor under the software control. Used with the SoftConnect USB feature. I P2[10/EINT0 110[2] N15[2] I/O P2[10] — General purpose digital input/output pin. P2[11/EINT1/ LCDCLKIN/ WCIDAT1/ I2STX_CLK 108[2] T17[2] I/O P2[11] — General purpose digital input/output pin. P2[12/EINT2/ LCDVD[4]/ LC	LCDVD[6]				0	TXD2 — Transmitter output for UART2.
P2[9]/ 132!1 H16!1 I/O P2[9] — General purpose digital input/output pin. USB_CONNECT1 USB_CONNECT1 USB_CONNECT0 USB_CONNECT0 USB_CONNECT0 LCDVD[3]/ LCDVD[3]/ I RXD2 RXD2 Image: Control of the software control. Used with the SoftConnect USB feature. LCDVD[3]/ LCDVD[3]/ LCDVD[3]/LCDVD[7] — LCD data.121 LCDVD[3]/LCDVD[7] — LCD data.121 P2[10]/EINT0 110(9) N15(9) I/O P2[10] — General purpose digital input/output pin. Note: LCDVD[3]/LCDVD[7] — LCD data.121 LCDVD[3]/LCDVD[7] — LCD data.121 Image: Control of the part after a reset. P2[10]/EINT1/ 10(8) N15(9) I/O P2[11] — General purpose digital input/output pin. LCDCLKIN/ MCIDAT1 D = External interrupt 1 input.19 Imput.19 MCIDAT1/ 0 LCCLKIN LCDVD[4]/LCDVD[3]/LCDVD[3]/LCDVD[4] LCDVD[4]/ U/O P2[12] — General purpose digital input/output pin. LCDVD[4]/ LCDVD[4]/LCDVD[3]/LCDVD[3]/LCDVD[4					0	TRACEPKT3 — Trace packet, bit 3.[17]
USB_CONNECT1 USB1 SoftConnect control. Signal used to switch an external 1.5 kQ resistor under the software control. Used with the SoftConnect USB feature. I RXD2 Receiver input for UART2. I EXTINO External Trigger Input.III P2[10]/EINTO 110(9) N15(9) // O P2[10] General purpose digital input/output pin. Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset. I EINTO External interrupt 0 input. P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/ I2[STX_CLK // INTO P2[12]/EINT2/ LCDV0[3]/ LCDV0[3]/ LCDV0[4]/ P2[12]/EINT2/ LCDV0[4]/ P2[12]/EINT2/ LCDV0[4]/ P2[12]/EINT2/ LCDV0[4]/ P2[12]/EINT2/ LCDV0[4]/ LCDV0[4]/ LCDV0[4]/ LCDV0[4]/ LCDV0[4]/ P2[12]/EINT2/ LCDV0[4]/					0	LCDVD[2]/LCDVD[6] — LCD data.[17]
RXD2/EXTINO/ LCDVD[3] Composition of the control of the solution meet on the solution meet on the solution meet on the solution meet on the solution of the solution meet on the solution of the solution meet on the solution of the solution meet on the solutin the solution meet on the solutin the sol	P2[9]/		132 <mark>1</mark>	H16 ¹¹	I/O	P2[9] — General purpose digital input/output pin.
Image: Section of the sectio	RXD2/EXT LCDVD[3]	ΓΙΝΟ/ /			0	an external 1.5 $k\Omega$ resistor under the software control. Used with the
I LCDVD[3]/LCDVD[7] — LCD data.[12] P2[10]/EINT0 110[5] N15[5] I/O P2[10] — General purpose digital input/output pin. Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset. P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/ I2STX_CLK 108[5] T17[5] I/O P2[11] — General purpose digital input/output pin. LCDVLKIN/ MCIDAT1/ I2STX_CLK 108[5] T17[5] I/O P2[11] — General purpose digital input/output pin. LCDVD[4]/ LCDVD[4]/ LCDVD[3]/ LCDVD[3]/ 108[5] T17[5] I/O P2[12]/EINT2/ (O LCDCLKIN - LCD clock. Its driven by the master and received by the slave. Corresponds to the signal SCK in the <i>PS-bus specification</i> . P2[12]/EINT2/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[3]/ LCDVD[4]/ MCIDAT2/ I2STX_WS N14[9] I/O P2[13] — General purpose digital input/output pin. LCDVD[4]/ LCDVD[3]/ LCD					I	RXD2 — Receiver input for UART2.
P2[10]/EINT0 110[2] N15[2] I/O P2[10] — General purpose digital input/output pin. Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset. I EINT0 P2[11]/EINT1/ 108[2] T17[2] I/O P2[11] General purpose digital input/output pin. LCDCLKINV MCIDAT1/ 108[2] T17[2] I/O P2[11] General purpose digital input/output pin. I_EINT0 LCDCLKIN LCDCLKIN LCDCLKIN LCDCLKIN LCDCLKIN Vice MCIDAT1 Data line 1 for SD/MMC Interface. V/O MCIDAT1 Data line 1 for SD/MMC Interface. Vice Vice MCIDAT2 Defeit MCIDAT2 Defeit Separation. Vice P2[12]/EINT2/ 106[2] N14[9] V/O P2[12] General purpose digital input/output pin. LCDVD[6]/ LCDVD[6]/ V/O P2[12] General purpose digital input/output pin. LCDVD[6]/ LCDVD[6]/ MCIDAT2 Data line 2 for SD/MMC interface. LCDVD[6]/ V/O MCIDAT3 Data line 2 for SD/MMC interface. LCDVD[6]/ LCDVD[6]/ MCIDAT3 D					I	EXTIN0 — External Trigger Input.[17]
Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset. I EINT0 — External interrupt 0 input. P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/ I2STX_CLK 108 ^[9] T17 ^[9] I/O P2[11] — General purpose digital input/output pin. I EINT1 — External interrupt 1 input.[19] O LCDCLKIN — LCD clock.l19] I/O MCIDAT1 — Data line 1 for SD/MMC interface. I/O I/O ESTX_CLK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>PS-bus specification</i> . P2[12]/EINT2/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[4/ I/O P2[12] — General purpose digital input/output pin. I_CDVD[4/ LCDVD[3					I	LCDVD[3]/LCDVD[7] — LCD data.[17]
take over control of the part after a reset. I ENTO — External interrupt 0 input. P2[11]/EINT1/ 108 ⁽²⁾ T17 ⁽²⁾ I/O P2[11] — General purpose digital input/output pin. LCDCLKIN LCDCLKIN — LCD clock.lt ⁽²⁾ O LCD clock I/O VO MCIDAT1 — Data line 1 for SD/MMC interface. I/O I/O I/O VO MCIDAT1 — Data line 1 for SD/MMC interface. I/O I/O P2[12]/EINT2/ 106 ⁽²⁾ N14 ⁽²⁾ I/O P2[12] — General purpose digital input/output pin. LCDVD[4/ LCDVD[4/ Data line 2 for SD/MMC interface. I/O I/O P2[12] — General purpose digital input/output pin. LCDVD[3/ LCDVD[4//LCDVD[3/LCDVD[3/LCDVD[18] — LCD data.l ⁽¹⁾ O LCDVD[4//LCDVD[3/LCDVD[18] — LCD data.l ⁽¹⁾ LCDVD[4//LCDVD[3/LCDVD[3/LCDVD[18] — LCD data.l ⁽¹⁾ VO P2[13]/EINT3/ I/O I/O I/O I/O I/O LCDVD[5//LCDVD[9//LCDVD[18] I/O P2[13]/EINT3/ I/O P2[13] — General purpose digital input/output pin. I <eint3 3="" external="" input.l<sup="" interrupt="" —="">(2) I I<eint3 3="" external="" input.l<sup="" interrupt="" —="">(2) I I<eint3 3="" external="" input.l<sup="" interrupt="" —="">(2) I I/O<td>P2[10]/EIN</td><td>NT0</td><td>110<mark>6</mark></td><td>N15<mark>6</mark></td><td>I/O</td><td>P2[10] — General purpose digital input/output pin.</td></eint3></eint3></eint3>	P2[10]/EIN	NT0	110 <mark>6</mark>	N15 <mark>6</mark>	I/O	P2[10] — General purpose digital input/output pin.
P2[11]/EINT1/ LCDCLKIN/ MCIDAT1/ I2STX_CLK 108(2) T17(5) I/O P2[11] — General purpose digital input/output pin. I EINT1 — External interrupt 1 input.[16] 0 LCDCLKIN — LCD clock.[15] I/O MCIDAT1 — Data line 1 for SD/MMC interface. I/O I/O I2STX_CLK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>FS-bus specification</i> . P2[12]/EINT2/ LCDVD[4/ LCDVD[3/ LCDVD[3/ LCDVD[8]/ LCDVD[8]/ 106(5) N14(5) I/O P2[12] — General purpose digital input/output pin. I EINT2 — External interrupt 2 input.[16] 0 LCDVD[4//LCDVD[3/LCDVD[8]/LCDVD[8]/LCDVD[18] — LCD data.[15] ICDVD[4// LCDVD[8]/ LCDVD[9]/ LCDVD[9]/ N14(5) I/O P2[13] — General purpose digital input/output pin. I SETX_WS T16(5) I/O P2[13] — General purpose digital input/output pin. I EINT3 — External interrupt 3 input.[16] I/O P2[13] — General purpose digital input/output pin. I EINT3 — External interrupt 3 input.[16] I/O P2[13] — General purpose digital input/output pin. I EINT3 — External interrupt 3 input.[16] I/O P2[13] — General purpose digital input/output pin. I EINT3 — External interrupt 3 input.[16] I/O P2[14] — CBVD[5]/LCDVD[9] — LCD data.[16]						Note: LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after a reset.
LCDCLKIN/ MCIDAT1/ I2STX_CLK I EINT1 — External interrupt 1 input.19 (UCDCLKIN — LCD clock.19 (UCDCLKIN — LCD clock.19 (UCDCLCIN = Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>PS-bus specification</i> . P2[12]/EINT2/ LCDVD[4/ LCDVD[3/ LCDVD[3/ LCDVD[8/ UCDVD[3/ LCDVD[8/ (UCDCLCIN] 1069 (UCDVD[4/LCDVD[3/LCDVD[3/LCDVD[3/LCDVD[3]] — LCD data.19 (UCDVD[3/LCDVD[3/LCDVD[3/LCDVD[3]] — LCD data.19 (UCDVD[3/LCDVD[3/LCDVD[3]] — LCD data.19 (UCDV13/ (UCDVD[3/LCDVD[3/LCDVD[3]] — LCD data.19 (UCDV13/ (UCDV13 — Data line 3 for SD/MMC interface. (UCDV15/LCDVD[3/LCDVD[3]] — LCD data.19 (UCDV15/LCDVD[3/LCDVD[3]] = LCD data.19 (UCDV15/LCDV15					I	EINT0 — External interrupt 0 input.
MCIDAT1/ I2STX_CLK Image: Construction of the standard structure of the structure of the standard structure of the standard structure of the structure o			108 <mark>6</mark>	T17 <mark>6</mark>	I/O	P2[11] — General purpose digital input/output pin.
I2STX_CLK 0 LCDCLKIN — LCD clock [19] I/O MCIDAT1 — Data line 1 for SD/MMC interface. I/O I/O I2STX_CLK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>PS-bus specification</i> . P2[12]/EINT2/ 106 ^[5] N14 ^[5] I/O P2[12] — General purpose digital input/output pin. LCDVD[3/ LCDVD[3/ 0 LCDVD[3//LCDVD	LCDCLKIN/ MCIDAT1/ I2STX_CLK			I	EINT1 — External interrupt 1 input.[18]	
I/OI2STX_CLK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the PS -bus specification.P2[12]/EINT2/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[3/ LCDVD[18/ MCIDAT2/ MCIDAT3/ M				0	LCDCLKIN — LCD clock.[18]	
P2[12]/EINT2/ LCDVD[4/) 106[2] N14[9] I/O P2[12] — General purpose digital input/output pin. LCDVD[4/) I EINT2 — External interrupt 2 input.[19] LCDVD[8/) O LCDVD[3]/LCDVD[3]/LCDVD[3]/LCDVD[3]/LCDVD[18] — LCD data.[19] UCDVD[18// MCIDAT2/ I2STX_WS VO MCIDAT2 — Data line 2 for SD/MMC interface. V/O I2STX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>FS-bus</i> specification. P2[13]/EINT3/ LCDVD[5]/ LCDVD[9]/ LCDVD[9]/ LCDVD[9]/ LCDVD[9]/ LCDVD[19]/ 102[9] T16[9] V/O P2[13] — General purpose digital input/output pin. I EINT3 — External interrupt 3 input.[19] V/O P2[13] — General purpose digital input/output pin. LCDVD[9]/ LCDVD[9]/ LCDVD[9]/ LCDVD[19]/ Nt16[9] V/O P2[13] — General purpose digital input/output pin. I2STX_SDA V/O MCIDAT3 — Data line 3 for SD/MMC interface. V/O V/O MCIDAT3 — Data line 3 for SD/MC interface. V/O V2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>FS-bus</i> specification. P2[14]/CS2/ CAP2[0]/SDA1 91[9] R12[6] V/O P2[14] — General purpose digital input/output pin. O CS2 <t< td=""><td></td><td>I/O</td><td>MCIDAT1 — Data line 1 for SD/MMC interface.</td></t<>				I/O	MCIDAT1 — Data line 1 for SD/MMC interface.	
LCDVD[4]/ I EINT2 — External interrupt 2 input.[19] LCDVD[3]/ O LCDVD[4]/LCDVD[3]/LCDVD[8]/LCDVD[8]/LCDVD[18] — LCD data.[19] LCDVD[4]/ V MCIDAT2 — Data line 2 for SD/MMC interface. I/O MCIDAT2 — Data line 2 for SD/MMC interface. I/O I/O P2[13]/EINT3/ I2STX_WS I/O P2[13] — General purpose digital input/output pin. ILCDVD[5]/ I/O P2[13] — General purpose digital input/output pin. ILCDVD[5]/ I/O P2[13] — General purpose digital input/output pin. ILCDVD[5]/ I/O P2[13] — General purpose digital input/output pin. ILCDVD[5]/ I/O P2[13] — General purpose digital input/output pin. ILCDVD[5]/ I/O P2[13] — General purpose digital input/output pin. ILCDVD[5]/ I/O MCIDAT3 — Data line 3 for SD/MMC interface. I/O MCIDAT3 — Data line 3 for SD/MMC interface. I/O I/O P2[14]/CS2/ 91[9] R12[9] I/O P2[14] — General purpose digital input/output pin. CAP2[0]/SDA1 91[9] R12[9] I/O P2[14] — General purpose digital input/output pin. O CS2 LOW active Chip Select 2 signal.					I/O	I2STX_CLK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the l^2S -bus specification.
LCDVD[3] 0 LCDVD[3]/LCDVD[3]/LCDVD[3]/LCDVD[18] — LCD data.[19] 0 LCDVD[4]/LCDVD[3]/LCDVD[3]/LCDVD[18] — LCD data.[19] 12STX_WS 0 LCDVD[4]/LCDVD[3]/LCDVD[18]/LCDVD[18] — LCD data.[19] 12STX_WS 102[9] 102[9] 102[9] 12STX_WS 102[9] T16[9] 1/0 P2[13] — General purpose digital input/output pin. 12CDVD[5]/ LCDVD[5]/ LCDVD[9]/ 102[9] T16[9] 1/0 P2[13] — General purpose digital input/output pin. 1 EINT3 — External interrupt 3 input.[19] 0 LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data.[19] 0 LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data.[19] 0 LCDVD[5]/LCDVD[19]/LCDVD[19] — LCD data.[19] 12STX_SDA 10 12STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>PS-bus specification</i> . P2[14]/CS2/ 91[9] R12[9] I/O P2[14] — General purpose digital input/output pin. 0 CS2 LOW active Chip Select 2 signal. I CAP2[0]/SDA1 I P2[15]/CS3/ 99[9] P13[6] I/O P2[15] — General purpose digital input/output pin. O 0 CS3 LOW active Chip Select 3 signal. I <td></td> <td></td> <td>106<mark>6</mark></td> <td>N14<mark>6</mark></td> <td>I/O</td> <td>P2[12] — General purpose digital input/output pin.</td>			106 <mark>6</mark>	N14 <mark>6</mark>	I/O	P2[12] — General purpose digital input/output pin.
LCDVD[8]/ O LCDVD[4]/LCDVD[8]/LCDVD[8]/LCDVD[8]/LCDVD[18] — LCD data.113 LCDVD[18]/ MCIDAT2/ I/O MCIDAT2 — Data line 2 for SD/MMC interface. I/O I2STX_WS IVO I2STX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>PS-bus specification</i> . P2[13]/EINT3/ 102 ^[6] T16 ^[6] I/O P2[13] — General purpose digital input/output pin. LCDVD[5]/ LCDVD[9]/ DVD[9]/LCDVD[9]/LCDVD[9]/LCDVD[19] — LCD data. ^[18] IVO LCDVD[19]/ MCIDAT3/ 0 LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data. ^[18] MCIDAT3/ I2STX_SDA MCIDAT3 — External interrupt 3 input. ^[13] MCIDAT3/ 0 LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data. ^[16] MCIDAT3/ I2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>PS-bus specification</i> . P2[14]/CS2/ 91 ^[6] R12 ^[6] I/O P2[14] — General purpose digital input/output pin. O CAP2[0]/SDA1 91 ^[6] R12 ^[6] I/O P2[14] — General purpose digital input/output pin. O CAP2[0]/SDA1 91 ^[6] R12 ^[6] I/O P2[14] — General purpose digital input/output pin. O<					I	EINT2 — External interrupt 2 input.[18]
LCDVD[13]/ MCIDAT2/ I2STX_WS I/O MCIDAT2 — Data line 2 for SD/MMC interface. I/O I2STX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>PS-bus</i> specification. P2[13]/EINT3/ LCDVD[5]/ LCDVD[5]/ LCDVD[9]/ LCDVD[9]/ LCDVD[19]/ MCIDAT3/ I2STX_SDA 102 ^[6] T16 ^[6] I/O P2[13] — General purpose digital input/output pin. I EINT3 — External interrupt 3 input. ^[18] O LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data. ^[18] MCIDAT3/ I2STX_SDA 0 LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data. ^[18] P2[14]/CS2/ I2STX_SDA 91 ^[6] R12 ^[6] I/O P2[14] — General purpose digital input/output pin. P2[14]/CS2/ I2STX_SDA 91 ^[6] R12 ^[6] I/O P2[14] — General purpose digital input/output pin. O CS2 LOW active Chip Select 2 signal. I CAP2[0] — Capture input for Timer 2, channel 0. P2[15]/CS3/ CAP2[1]/SCL1 99 ^[6] P13 ^[6] I/O P2[15] — General purpose digital input/output pin. O CS3 LOW active Chip Select 3 signal. I CAP2[1] — Capture input for Timer 2, channel 1. P2[15]/CS3/ CAP2[1]/SCL1 99 ^[6] P13 ^[6] I/O P2[15] — General purpose digital input/output pin. <					0	LCDVD[4]/LCDVD[3]/LCDVD[8]/LCDVD[18] — LCD data.[18]
I2STX_WSI/OI2STX_WSI2STX_WSInasmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the l^2S -bus specification.P2[13]/EINT3/102[9]T16[9]I/OP2[13] — General purpose digital input/output pin.LCDVD[5]/LCDVD[9]/EINT3 — External interrupt 3 input.[19]LCDVD[19]/OLCDVD[9]/LCDVD[19] — LCD data.[16]MCIDAT3/I/OMCIDAT3 — Data line 3 for SD/MMC interface.I/OISTX_SDAI2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the l^2S -bus specification.P2[14]/CS2/91[6]R12[6]I/OP2[14] — General purpose digital input/output pin.OCS2 — LOW active Chip Select 2 signal.ICAP2[0] — Capture input for Timer 2, channel 0.I/OSDA1 — I²C1 data input/output (this is not an open-drain pin).P2[15]/CS3/99[6]P13[6]I/OP2[15] — General purpose digital input/output pin.OCS3 — LOW active Chip Select 3 signal.ICAP2[1] — Capture input for Timer 2, channel 1.I/OSCL1 — I²C1 clock input/output (this is not an open-drain pin).	LCDVD[18	3]/			I/O	MCIDAT2 — Data line 2 for SD/MMC interface.
LCDVD[5]/ LCDVD[9]/ LCDVD[19]/ MCIDAT3/ I EINT3 — External interrupt 3 input.[19] 0 LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data.[18] 1/0 MCIDAT3 — Data line 3 for SD/MMC interface. 1/2STX_SDA I/0 I2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>l</i> ² S-bus specification. P2[14]/CS2/ CAP2[0]/SDA1 916 R12[6] I/O P2[14] — General purpose digital input/output pin. 0 CS2 — LOW active Chip Select 2 signal. I CAP2[0] — Capture input for Timer 2, channel 0. I/O SDA1 — l ² C1 data input/output (this is not an open-drain pin). I/O P2[15] — General purpose digital input/output pin. P2[15]/CS3/ CAP2[1]/SCL1 99[6] P13[6] I/O P2[15] — General purpose digital input/output pin. 0 CS3 — LOW active Chip Select 3 signal. I CAP2[1] — Capture input for Timer 2, channel 1. I/O SCL1 — l ² C1 clock input/output (this is not an open-drain pin). I/O					I/O	received by the slave. Corresponds to the signal WS in the l^2S -bus
LCDVD[9]/ LCDVD[19]/ LCDVD[19]/ O LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data.[18] MCIDAT3/ I/O MCIDAT3 — Data line 3 for SD/MMC interface. I/O I2STX_SDA I/O I2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I</i> ² S-bus specification. P2[14]/CS2/ 91[6] R12[6] I/O P2[14] — General purpose digital input/output pin. O CS2 — LOW active Chip Select 2 signal. I CAP2[0] — Capture input for Timer 2, channel 0. I/O SDA1 — I ² C1 data input/output (this is not an open-drain pin). I/O P2[15] — General purpose digital input/output pin. O CS3 — LOW active Chip Select 3 signal. I CAP2[1] — Capture input for Timer 2, channel 1. I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin). I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin).			102 <mark>6</mark>]	T16 ^[6]	I/O	P2[13] — General purpose digital input/output pin.
LCDVD[19]/ O LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data.[18] MCIDAT3/ I2STX_SDA I/O MCIDAT3 — Data line 3 for SD/MMC interface. I/O I2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the I ² S-bus specification. P2[14]/CS2/ 91[6] R12[6] I/O P2[14] — General purpose digital input/output pin. CAP2[0]/SDA1 91[6] R12[6] I/O P2[14] — General purpose digital input/output pin. O CS2 — LOW active Chip Select 2 signal. I CAP2[0] — Capture input for Timer 2, channel 0. I/O SDA1 — I ² C1 data input/output (this is not an open-drain pin). I/O P2[15] — General purpose digital input/output pin. P2[15]/CS3/ 99[6] P13[6] I/O P2[15] — General purpose digital input/output pin. O CS3 — LOW active Chip Select 3 signal. I CAP2[1] — Capture input for Timer 2, channel 1. I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin). I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin).					I	EINT3 — External interrupt 3 input.[18]
MCIDAT3/ I2STX_SDA I/O MCIDAT3 — Data line 3 for SD/MMC interface. I/O I2STX_SDA — Transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>PS-bus specification</i> . P2[14]/CS2/ CAP2[0]/SDA1 91 ^[6] R12 ^[6] I/O P2[14] — General purpose digital input/output pin. O CS2 — LOW active Chip Select 2 signal. I CAP2[0] — Capture input for Timer 2, channel 0. I/O SDA1 — I ² C1 data input/output (this is not an open-drain pin). P2[15]/CS3/ CAP2[1]/SCL1 P13 ^[6] P13 ^[6] P13 ^[6] I/O SDA1 — I ² C1 data input/output (this is not an open-drain pin). P2[15]/CS3/ CAP2[1]/SCL1 P13 ^[6] I/O SC1 — I ² C1 clock input for Timer 2, channel 1. I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin).					0	LCDVD[5]/LCDVD[9]/LCDVD[19] — LCD data.[18]
$\frac{100}{1231X_30A} = 17a1still data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the l2S-bus specification.$ $P2[14]/CS2/ OAP2[0]/SDA1 = 120 P2[14] - General purpose digital input/output pin. O CS2 - LOW active Chip Select 2 signal. I CAP2[0] - Capture input for Timer 2, channel 0. I/O SDA1 - I2C1 data input/output (this is not an open-drain pin). P2[15]/CS3/ SOA1 = 136 P136 P136 P136 P136 P136 P136 P136 $	MCIDAT3/	, - ,			I/O	MCIDAT3 — Data line 3 for SD/MMC interface.
$\begin{array}{c} CAP2[0]/SDA1 \\ CAP2[0]/SDA1 \\ CAP2[0]/SDA1 \\ CS2 - LOW \text{ active Chip Select 2 signal.} \\ I \\ CAP2[0] - Capture input for Timer 2, channel 0. \\ I/O \\ SDA1 - I^2C1 \text{ data input/output (this is not an open-drain pin).} \\ P2[15]/CS3/ \\ P3[1]/SCL1 \\ \begin{array}{c} P3[6] \\ P13[6] \\ P13[6] \\ P2[15] - General purpose digital input/output pin. \\ O \\ CS3 - LOW \text{ active Chip Select 3 signal.} \\ I \\ CAP2[1] - Capture input for Timer 2, channel 1. \\ I \\ SCL1 - I^2C1 \operatorname{clock input/output (this is not an open-drain pin).} \end{array}$	I2STX_SD	A			I/O	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	P2[14]/CS	2/	91 <mark>6</mark>]	R12 <mark>6</mark>	I/O	P2[14] — General purpose digital input/output pin.
I/OSDA1 — l^2C1 data input/output (this is not an open-drain pin).P2[15]/CS3/99[6]P13[6]CAP2[1]/SCL1P13[6]I/OP2[15] — General purpose digital input/output pin.OCS3 — LOW active Chip Select 3 signal.ICAP2[1] — Capture input for Timer 2, channel 1.I/OSCL1 — l^2C1 clock input/output (this is not an open-drain pin).	CAP2[0]/S	SDA1			0	CS2 — LOW active Chip Select 2 signal.
P2[15]/CS3/ 99[6] P13[6] I/O P2[15] — General purpose digital input/output pin. CAP2[1]/SCL1 O CS3 — LOW active Chip Select 3 signal. I CAP2[1] — Capture input for Timer 2, channel 1. I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin).					I	CAP2[0] — Capture input for Timer 2, channel 0.
CAP2[1]/SCL1 O CS3 — LOW active Chip Select 3 signal. I CAP2[1] — Capture input for Timer 2, channel 1. I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin).					I/O	SDA1 — I ² C1 data input/output (this is not an open-drain pin).
I CAP2[1] — Capture input for Timer 2, channel 1. I/O SCL1 — I ² C1 clock input/output (this is not an open-drain pin).			99 <mark>6]</mark>	P13 ^[6]	I/O	P2[15] — General purpose digital input/output pin.
I/O SCL1 — I^2C1 clock input/output (this is not an open-drain pin).	CAP2[1]/S	SCL1			0	CS3 — LOW active Chip Select 3 signal.
					I	CAP2[1] — Capture input for Timer 2, channel 1.
© NXP R V 2007 All rights reserve					I/O	SCL1 — I ² C1 clock input/output (this is not an open-drain pin).
	LPC2478 1					© NXP R V 2007 All rights researce

LPC2478_1 Preliminary data sheet

Symbol	Pin	Ball	Туре	Description
P2[16]/CAS	87 <mark>11</mark>	R11[1]	I/O	P2[16] — General purpose digital input/output pin.
			0	CAS — LOW active SDRAM Column Address Strobe.
P2[17]/RAS	95 <mark>1]</mark>	R13[1]	I/O	P2[17] — General purpose digital input/output pin.
			0	RAS — LOW active SDRAM Row Address Strobe.
P2[18]/	59 <mark>[1]</mark>	U3 <mark>[1]</mark>	I/O	P2[18] — General purpose digital input/output pin.
CLKOUT0			0	CLKOUT0 — SDRAM clock 0.
P2[19]/	67 <mark>11</mark>	R7 <mark>11</mark>	I/O	P2[19] — General purpose digital input/output pin.
CLKOUT1			0	CLKOUT1 — SDRAM clock 1.
P2[20]/DYCS0	73 <mark>11</mark>	T8 <mark>[1]</mark>	I/O	P2[20] — General purpose digital input/output pin.
			0	DYCS0 — SDRAM chip select 0.
P2[21]/DYCS1	81 <mark>11</mark>	U11[1]	I/O	P2[21] — General purpose digital input/output pin.
			0	DYCS1 — SDRAM chip select 1.
P2[22]/DYCS2/	85 <mark>11</mark>	U12 <mark>11</mark>	I/O	P2[22] — General purpose digital input/output pin.
CAP3[0]/SCK0			0	DYCS2 — SDRAM chip select 2.
			Ι	CAP3[0] — Capture input for Timer 3, channel 0.
			I/O	SCK0 — Serial clock for SSP0.
P2[23]/DYCS3/	64 <mark>1</mark>	U5 <mark>[1]</mark>	I/O	P2[23] — General purpose digital input/output pin.
CAP3[1]/SSEL0			0	DYCS3 — SDRAM chip select 3.
			Ι	CAP3[1] — Capture input for Timer 3, channel 1.
			I/O	SSEL0 — Slave Select for SSP0.
P2[24]/	53 <mark>11</mark>	P5 <mark>11</mark>	I/O	P2[24] — General purpose digital input/output pin.
CKEOUT0			0	CKEOUT0 — SDRAM clock enable 0.
P2[25]/	54 <mark>11</mark>	R4 <mark>11</mark>	I/O	P2[25] — General purpose digital input/output pin.
CKEOUT1			0	CKEOUT1 — SDRAM clock enable 1.
P2[26]/ CKEOUT2/	57 <mark>11</mark>	T4 <mark>[1]</mark>	I/O	P2[26] — General purpose digital input/output pin.
MAT3[0]/MISO0			0	CKEOUT2 — SDRAM clock enable 2.
			0	MAT3[0] — Match output for Timer 3, channel 0.
			I/O	MISO0 — Master In Slave Out for SSP0.
P2[27]/ CKEOUT3/	47 <mark>11</mark>	P3 <mark>[1]</mark>	I/O	P2[27] — General purpose digital input/output pin.
MAT3[1]/MOSI0			0	CKEOUT3 — SDRAM clock enable 3.
			0	MAT3[1] — Match output for Timer 3, channel 1.
			I/O	MOSI0 — Master Out Slave In for SSP0.
P2[28]/ DQMOUT0	49 <mark>[1]</mark>	P4 <mark>1]</mark>	I/O	P2[28] — General purpose digital input/output pin.
			0	DQMOUT0 — Data mask 0 used with SDRAM and static devices.
P2[29]/	43 <mark>11</mark>	N3 <mark>[1]</mark>	I/O	P2[29] — General purpose digital input/output pin.
DQMOUT1			0	DQMOUT1 — Data mask 1 used with SDRAM and static devices.
P2[30]/ DQMOUT2/	31 <mark>11</mark>	L4 <mark>[1]</mark>	I/O	P2[30] — General purpose digital input/output pin.
MAT3[2]/SDA2			0	DQMOUT2 — Data mask 2 used with SDRAM and static devices.
			0	MAT3[2] — Match output for Timer 3, channel 2.
			I/O	SDA2 — I ² C2 data input/output (this is not an open-drain pin).

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Table 4. P	in description	continued		
Symbol	Pin	Ball	Туре	Description
P2[31]/	39 <mark>[1]</mark>	N2[1]	I/O	P2[31] — General purpose digital input/output pin.
DQMOUT3/ MAT3[3]/SCL	2		0	DQMOUT3 — Data mask 3 used with SDRAM and static devices.
			0	MAT3[3] — Match output for Timer 3, channel 3.
			I/O	SCL2 — I^2C2 clock input/output (this is not an open-drain pin).
P3[0] to P3[3	31]		I/O	Port 3: Port 3 is a 32-bit I/O port with individual direction controls for each bit. The operation of port 3 pins depends upon the pin function selected via the Pin Connect block.
P3[0]/D0	197 <mark>11</mark>	B4[1]	I/O	P3[0] — General purpose digital input/output pin.
			I/O	D0 — External memory data line 0.
P3[1]/D1	201[1]	B3[1]	I/O	P3[1] — General purpose digital input/output pin.
			I/O	D1 — External memory data line 1.
P3[2]/D2	207[1]	B1 <mark>11</mark>	I/O	P3[2] — General purpose digital input/output pin.
			I/O	D2 — External memory data line 2.
P3[3]/D3	3 <mark>[1]</mark>	E4 <mark>[1]</mark>	I/O	P3[3] — General purpose digital input/output pin.
			I/O	D3 — External memory data line 3.
P3[4]/D4	13 <mark>[1]</mark>	F2 ^[1]	I/O	P3[4] — General purpose digital input/output pin.
			I/O	D4 — External memory data line 4.
P3[5]/D5	17 <mark>[1]</mark>	G1[1]	I/O	P3[5] — General purpose digital input/output pin.
			I/O	D5 — External memory data line 5.
P3[6]/D6	23 <mark>[1]</mark>	<u>1]</u> J1[1]	I/O	P3[6] — General purpose digital input/output pin.
			I/O	D6 — External memory data line 6.
P3[7]/D7	27 <mark>1</mark>]	L1[1]	I/O	P3[7] — General purpose digital input/output pin.
			I/O	D7 — External memory data line 7.
P3[8]/D8	191 <mark>11</mark>	D8[1]	I/O	P3[8] — General purpose digital input/output pin.
			I/O	D8 — External memory data line 8.
P3[9]/D9	199 <mark>11</mark>	C5[1]	I/O	P3[9] — General purpose digital input/output pin.
			I/O	D9 — External memory data line 9.
P3[10]/D10	205 <mark>11</mark>	B2[1]	I/O	P3[10] — General purpose digital input/output pin.
			I/O	D10 — External memory data line 10.
P3[11]/D11	208 <mark>[1]</mark>	D5[1]	I/O	P3[11] — General purpose digital input/output pin.
			I/O	D11 — External memory data line 11.
P3[12]/D12	1[1]	D4 <mark>[1]</mark>	I/O	P3[12] — General purpose digital input/output pin.
			I/O	D12 — External memory data line 12.
P3[13]/D13	7[1]	C1[1]	I/O	P3[13] — General purpose digital input/output pin.
			I/O	D13 — External memory data line 13.
P3[14]/D14	21 <mark>1</mark>]	H2[1]	I/O	P3[14] — General purpose digital input/output pin.
			I/O	D14 — External memory data line 14.

P3[15]/D15

P3[15] — General purpose digital input/output pin.

D15 — External memory data line 15.

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28<mark>1</mark>

M1[1]

I/O

I/O

Table 4. Pin description ...continued

Table 4.	Fill des			T	Description
Symbol	0/	Pin	Ball	Туре	Description
P3[16]/D1 PWM0[1]/		137 <mark>11</mark>	F17[1]	I/O	P3[16] — General purpose digital input/output pin.
				I/O	D16 — External memory data line 16.
				0	PWM0[1] — Pulse Width Modulator 0, output 1.
		[4]	[4]	0	TXD1 — Transmitter output for UART1.
P3[17]/D1 PWM0[2]/		143 <mark>11</mark>	F15[1]	I/O	P3[17] — General purpose digital input/output pin.
				I/O	D17 — External memory data line 17.
				0	PWM0[2] — Pulse Width Modulator 0, output 2.
				Ι	RXD1 — Receiver input for UART1.
P3[18]/D1 PWM0[3]/		151 <mark>11</mark>	C15[1]	I/O	P3[18] — General purpose digital input/output pin.
	0131			I/O	D18 — External memory data line 18.
				0	PWM0[3] — Pulse Width Modulator 0, output 3.
				I	CTS1 — Clear to Send input for UART1.
P3[19]/D1		161 <mark>1</mark> 1	B14 <mark>11</mark>	I/O	P3[19] — General purpose digital input/output pin.
PWM0[4]/	DCD1			I/O	D19 — External memory data line 19.
				0	PWM0[4] — Pulse Width Modulator 0, output 4.
				Ι	DCD1 — Data Carrier Detect input for UART1.
P3[20]/D2		167 <mark>[1]</mark>	A13[1]	I/O	P3[20] — General purpose digital input/output pin.
PWM0[5]/	DSRI			I/O	D20 — External memory data line 20.
				0	PWM0[5] — Pulse Width Modulator 0, output 5.
				Ι	DSR1 — Data Set Ready input for UART1.
P3[21]/D2		175 <mark>11</mark>	C10 ^[1]	I/O	P3[21] — General purpose digital input/output pin.
PWM0[6]/	DIR1			I/O	D21 — External memory data line 21.
				0	PWM0[6] — Pulse Width Modulator 0, output 6.
				0	DTR1 — Data Terminal Ready output for UART1.
P3[22]/D2		195 <mark>11</mark>	C6[1]	I/O	P3[22] — General purpose digital input/output pin.
PCAP0[0]	/RI1			I/O	D22 — External memory data line 22.
				I	PCAP0[0] — Capture input for PWM0, channel 0.
				I	RI1 — Ring Indicator input for UART1.
P3[23]/D2	3/	65 <mark>11</mark>	T6 <mark>1]</mark>	I/O	P3[23] — General purpose digital input/output pin.
CAP0[0]/ PCAP1[0]				I/O	D23 — External memory data line 23.
FCAFI[0]				I	CAP0[0] — Capture input for Timer 0, channel 0.
				Ι	PCAP1[0] — Capture input for PWM1, channel 0.
P3[24]/D2	4/	58 <mark>[1]</mark>	R5 <mark>[1]</mark>	I/O	P3[24] — General purpose digital input/output pin.
CAP0[1]/				I/O	D24 — External memory data line 24.
PWM1[1]				I	CAP0[1] — Capture input for Timer 0, channel 1.
				0	PWM1[1] — Pulse Width Modulator 1, output 1.
P3[25]/D2	5/	56 <mark>1</mark>	U2[1]	I/O	P3[25] — General purpose digital input/output pin.
MAT0[0]/				I/O	D25 — External memory data line 25.
PWM1[2]				0	MAT0[0] — Match output for Timer 0, channel 0.
				0	PWM1[2] — Pulse Width Modulator 1, output 2.
			-	• • • • • • • • • • • • • • • • • • • •	

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Table 4.	Pin descr	iption	continued		
Symbol	I	Pin	Ball	Туре	Description
P3[26]/D26/	/ !	55 <mark>[1]</mark>	T3 <mark>11</mark>	I/O	P3[26] — General purpose digital input/output pin.
MAT0[1]/ PWM1[3]				I/O	D26 — External memory data line 26.
				0	MAT0[1] — Match output for Timer 0, channel 1.
				0	PWM1[3] — Pulse Width Modulator 1, output 3.
P3[27]/D27/	/ :	203 <mark>[1]</mark>	A1[1]	I/O	P3[27] — General purpose digital input/output pin.
CAP1[0]/ PWM1[4]				I/O	D27 — External memory data line 27.
F VVIVI 1 [4]				I	CAP1[0] — Capture input for Timer 1, channel 0.
				0	PWM1[4] — Pulse Width Modulator 1, output 4.
P3[28]/D28/	/ !	5 <mark>[1]</mark>	D2[1]	I/O	P3[28] — General purpose digital input/output pin.
CAP1[1]/				I/O	D28 — External memory data line 28.
PWM1[5]				I	CAP1[1] — Capture input for Timer 1, channel 1.
				0	PWM1[5] — Pulse Width Modulator 1, output 5.
P3[29]/D29/	/	11 <mark>1</mark>	F3[1]	I/O	P3[29] — General purpose digital input/output pin.
MAT1[0]/				I/O	D29 — External memory data line 29.
PWM1[6]				0	MAT1[0] — Match output for Timer 1, channel 0.
				0	PWM1[6] — Pulse Width Modulator 1, output 6.
P3[30]/D30/ 19 MAT1[1]/ RTS1	19[1]	H3[1]	I/O	P3[30] — General purpose digital input/output pin.	
			I/O	D30 — External memory data line 30.	
				0	MAT1[1] — Match output for Timer 1, channel 1.
				0	RTS1 — Request to Send output for UART1.
P3[31]/D31/	/ :	25 <mark>[1]</mark>	J3 <u>[1]</u>	I/O	P3[31] — General purpose digital input/output pin.
MAT1[2]				I/O	D31 — External memory data line 31.
				0	MAT1[2] — Match output for Timer 1, channel 2.
P4[0] to P4[[31]			I/O	Port 4: Port 4 is a 32-bit I/O port with individual direction controls for each bit. The operation of port 4 pins depends upon the pin function selected via the Pin Connect block.
P4[0]/A0	-	75 <mark>11</mark>	U9 <u>[1]</u>	I/O	P4[0] —]General purpose digital input/output pin.
				I/O	A0 — External memory address line 0.
P4[1]/A1	-	79 <mark>[1]</mark>	U10 ^[1]	I/O	P4[1] — General purpose digital input/output pin.
				I/O	A1 — External memory address line 1.
P4[2]/A2	ł	83 <mark>11</mark>	T11[1]	I/O	P4[2] — General purpose digital input/output pin.
				I/O	A2 — External memory address line 2.
P4[3]/A3	9	97 <mark>[1]</mark>	U16 <mark>11</mark>	I/O	P4[3] — General purpose digital input/output pin.
				I/O	A3 — External memory address line 3.
P4[4]/A4		103 <mark>[1]</mark>	R15 <mark>11</mark>	I/O	P4[4] — General purpose digital input/output pin.
				I/O	A4 — External memory address line 4.
P4[5]/A5		107 <mark>1]</mark>	R16[1]	I/O	P4[5] — General purpose digital input/output pin.
				I/O	A5 — External memory address line 5.
P4[6]/A6		113 <mark>11</mark>	M14[1]	I/O	P4[6] — General purpose digital input/output pin.
				I/O	A6 — External memory address line 6.

Table 4. Pin description ...continued

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	Pin description			
Symbol	Pin	Ball	Туре	Description
P4[7]/A7	121 <mark>1</mark> 1	L16 ^[1]	I/O	P4[7] — General purpose digital input/output pin.
			I/O	A7 — External memory address line 7.
P4[8]/A8	127 <mark>1</mark>]	J17 <mark>[1]</mark>	I/O	P4[8] — General purpose digital input/output pin.
			I/O	A8 — External memory address line 8.
P4[9]/A9	131 <mark>1</mark> 1	H17 <mark>11</mark>	I/O	P4[9] — General purpose digital input/output pin.
			I/O	A9 — External memory address line 9.
P4[10]/A10	135 <mark>11</mark>	G17 <mark>11</mark>	I/O	P4[10] — General purpose digital input/output pin.
			I/O	A10 — External memory address line 10.
P4[11]/A11	145 <mark>11</mark>	F14[1]	I/O	P4[11] — General purpose digital input/output pin.
			I/O	A11 — External memory address line 11.
P4[12]/A12	149 <mark>11</mark>	C16[1]	I/O	P4[12] — General purpose digital input/output pin.
			I/O	A12 — External memory address line 12.
P4[13]/A13	155 <mark>11</mark>	B16[1]	I/O	P4[13] — General purpose digital input/output pin.
			I/O	A13 — External memory address line 13.
P4[14]/A14	159 <mark>[1]</mark>	B15 <mark>11</mark>	I/O	P4[14] — General purpose digital input/output pin.
			I/O	A14 — External memory address line 14.
P4[15]/A15	173 <mark>11</mark>	A11[1]	I/O	P4[15] — General purpose digital input/output pin.
			I/O	A15 — External memory address line 15.
P4[16]/A16	101 <mark>11</mark>	U17 <mark>11</mark>	I/O	P4[16] — General purpose digital input/output pin.
			I/O	A16 — External memory address line 16.
P4[17]/A17	104 <mark>1]</mark>	P14 <mark>11</mark>	I/O	P4[17] — General purpose digital input/output pin.
			I/O	A17 — External memory address line 17.
P4[18]/A18	105 <mark>1]</mark>	P15 <mark>11</mark>	I/O	P4[18] — General purpose digital input/output pin.
			I/O	A18 — External memory address line 18.
P4[19]/A19	111 <mark>11</mark>	P16 ^[1]	I/O	P4[19] — General purpose digital input/output pin.
			I/O	A19 — External memory address line 19.
P4[20]/A20		R17[1]	I/O	P4[20] — General purpose digital input/output pin.
SDA2/SCK	1		I/O	A20 — External memory address line 20.
			I/O	SDA2 — I ² C2 data input/output (this is not an open-drain pin).
			I/O	SCK1 — Serial Clock for SSP1.
P4[21]/A21		M15 <mark>11</mark>	I/O	P4[21] — General purpose digital input/output pin.
SCL2/SSEI	_1		I/O	A21 — External memory address line 21.
			I/O	SCL2 — I ² C2 clock input/output (this is not an open-drain pin).
			I/O	SSEL1 — Slave Select for SSP1.
P4[22]/A22	/ 123[1]	K14[1]	I/O	P4[22] — General purpose digital input/output pin.
TXD2/MISC	01		I/O	A22 — External memory address line 22.
			0	TXD2 — Transmitter output for UART2.
			I/O	MISO1 — Master In Slave Out for SSP1.

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Symbol		Pin	Ball	Туре	Description
P4[23]/A23/		129 <mark>11</mark>	J15[1]	I/O	P4[23] — General purpose digital input/output pin.
RXD2/MOSI1		120	0.0	I/O	A23 — External memory address line 23.
				1	RXD2 — Receiver input for UART2.
				I/O	MOSI1 — Master Out Slave In for SSP1.
P4[24]/OE		183 <mark>11</mark>	B8[1]	I/O	P4[24] — General purpose digital input/output pin.
				0	OE — LOW active Output Enable signal.
P4[25]/WE		179 <mark>11</mark>	B9 <mark>11</mark>	I/O	P4[25] — General purpose digital input/output pin.
				0	WE — LOW active Write Enable signal.
P4[26]/BLS0		119 <mark>11</mark>	L15[1]	I/O	P4[26] — General purpose digital input/output pin.
				0	BLS0 — LOW active Byte Lane select signal 0.
P4[27]/BLS1		139 <mark>11</mark>	G15 <mark>11</mark>	I/O	P4[27] — General purpose digital input/output pin.
				0	BLS1 — LOW active Byte Lane select signal 1.
P4[28]/BLS2/		170 <mark>1]</mark>	C11[1]	I/O	P4 [28] — General purpose digital input/output pin.
MAT2[0]/LCD				0	BLS2 — LOW active Byte Lane select signal 2.
LCDVD[10]/ LCDVD[2]/				0	MAT2[0] — Match output for Timer 2, channel 0. ^[19]
TXD3				0	LCDVD[6]/LCDVD[10]/LCDVD[2] — LCD data.[19]
				0	TXD3 — Transmitter output for UART3.
P4[29]/BLS3/		176 <mark>1]</mark>	B10 ^[1]	I/O	P4[29] — General purpose digital input/output pin.
MAT2[1]				0	BLS3 — LOW active Byte Lane select signal 3.
LCDVD[7]/ LCDVD[11]/				0	MAT2[1] — Match output for Timer 2, channel 1. ^[19]
LCDVD[3]/RX	(D3			0	LCDVD[7]/LCDVD[11]/LCDVD[3] — LCD data [19]
				Ι	RXD3 — Receiver input for UART3.
P4[30]/CS0		187 <mark>11</mark>	B7[1]	I/O	P4[30] — General purpose digital input/output pin.
				0	CS0 — LOW active Chip Select 0 signal.
P4[31]/CS1		193 <mark>1</mark>	A4[1]	I/O	P4[31] — General purpose digital input/output pin.
				0	CS1 — LOW active Chip Select 1 signal.
ALARM		37 <mark>8</mark>	N1 ^[8]	0	ALARM — RTC controlled output. This is a 1.8 V pin. It goes HIGH when a RTC alarm is generated.
USB_D-2		52	U1	I/O	USB_D-2 — USB port 2 bidirectional D- line.
DBGEN		9 <u>[1]</u>	F4 <u>[1]</u>	I	DBGEN — JTAG interface control signal. Also used for boundary scanning.
TDO		2[1]	D3[1]	0	TDO — Test Data out for JTAG interface.
TDI		4 <u>[1]</u>	C2[1]	I	TDI — Test Data in for JTAG interface.
TMS		6 <mark>[1]</mark>	E3 <mark>[1]</mark>	Ι	TMS — Test Mode Select for JTAG interface.
TRST		8[1]	D1[1]	I	TRST — Test Reset for JTAG interface.
ТСК		10 <mark>[1]</mark>	E2[1]	I	TCK — Test Clock for JTAG interface.
RTCK		206 <mark>1]</mark>	C3[1]	I/O	RTCK — JTAG interface control signal.
					Note: LOW on this pin while $\overline{\text{RESET}}$ is LOW enables ETM pins (P2[9:0]) to operate as Trace port after reset.
RSTOUT		29 <u>[1]</u>	K3 <mark>[1]</mark>	0	RSTOUT — LOW on this pin indicates LPC2478 being in Reset state.

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Fast communication chip

Symbol	Pin	Ball	Туре	Description	
RESET	35[7]	M2[7]	I	external reset input: A LOW on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. TTL with hysteresis, 5 V tolerant.	
				The VBAT pin must be powered with 3.3 V for the RESET pin to detect external signal existence and/or activity.	
XTAL1	44 <u>^[8]</u>	M4 <mark>[8]</mark>	I	Input to the oscillator circuit and internal clock generator circuits.	
XTAL2	46 <mark>[8]</mark>	N4 <mark>[8]</mark>	0	Output from the oscillator amplifier.	
RTCX1	34 <mark>[8]</mark>	K2 <mark>^[8]</mark>	I	Input to the RTC oscillator circuit.	
RTCX2	36 <mark>[8]</mark>	L2 <mark>[8]</mark>	0	Output from the RTC oscillator circuit.	
V _{SSIO}	33, 63, 77, 93, 114,133, 148,169, 189, 200 ^[9]		I	ground: 0 V reference for the digital IO pins.	
V _{SSCORE}	32, 84, 172 <mark>9</mark>	K4, P10, D12 ^[9]	I	ground: 0 V reference for the core.	
V _{SSA}	22 <mark>[10]</mark>	J2[10]	I	analog ground: 0 V reference. This should nominally be the same voltage as V_{SS} , but should be isolated to minimize noise and error.	
V _{DD(3V3)}	15, 60, 71, 89, 112,125, 146, 165,181, 198 ^[11]	K16,	I	3.3 V supply voltage: This is the power supply voltage for the I/O ports	
NC	30, 117, 141 <u>^[12]</u>	J4, L14, G14 <mark>[12]</mark>	I	Not Connected pins: These pins must be left unconnected (floating).	
VDD(DCDC)(3V3)	26, 86, 174 <u>^[13]</u>	H4, P11, D11 <mark>[13]</mark>	I	3.3 V DC-to-DC converter supply voltage: This is the power supply fo the on-chip DC-to-DC converter.	
V _{DDA}	20 <u>[14]</u>	G4 <u>[14]</u>	I	analog 3.3 V pad supply voltage: This should be nominally the same voltage as $V_{DD(3V3)}$ but should be isolated to minimize noise and error. This voltage is used to power the ADC and DAC.	
VREF	24 <u>[14]</u>	K1 <u>^[14]</u>	I	ADC reference: This should be nominally the same voltage as $V_{DD(3V3)}$ but should be isolated to minimize noise and error. The level on this pin is used as a reference for ADC and DAC.	
VBAT	38 <u>[14]</u>	M3 <u>[14]</u>	I	RTC and RESET pin power supply: 3.3 V on this pin supplies the power to the RTC peripheral and the RESET pin logic.	

[1] 5 V tolerant pad providing digital I/O functions with TTL levels and hysteresis.

[2] 5 V tolerant pad providing digital I/O functions (with TTL levels and hysteresis) and analog input. When configured as a ADC input, digital section of the pad is disabled.

[3] 5 V tolerant pad providing digital I/O with TTL levels and hysteresis and analog output function. When configured as the DAC output, digital section of the pad is disabled.

- [4] Open-drain 5 V tolerant digital I/O I²C-bus 400 kHz specification compatible pad. It requires an external pull-up to provide output functionality. When power is switched off, this pin connected to the I²C-bus is floating and does not disturb the I²C lines.
- [5] Pad provides digital I/O and USB functions. It is designed in accordance with the USB specification, revision 2.0 (Full-speed and Low-speed mode only).

[6] 5 V tolerant pad with 5 ns glitch filter providing digital I/O functions with TTL levels and hysteresis.

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- [7] 5 V tolerant pad with 20 ns glitch filter providing digital I/O function with TTL levels and hysteresis.
- [8] Pad provides special analog functionality.
- [9] Pad provides special analog functionality.
- [10] Pad provides special analog functionality.
- [11] Pad provides special analog functionality.
- [12] Pad provides special analog functionality.
- [13] Pad provides special analog functionality.
- [14] Pad provides special analog functionality.
- [15] Either the I²S function or the LCD function is selectable, see <u>Table 13</u>, <u>Table 14</u>, and <u>Table 15</u>.
- [16] Either the USB OTG function or the LCD function is selectable, see <u>Table 13</u>, <u>Table 14</u>, and <u>Table 15</u>.
- [17] Either the trace function or the LCD function is selectable, see <u>Table 13</u>, <u>Table 14</u>, and <u>Table 15</u>.
- [18] Either one of the external interrupts EINT1 to EINT3 or the LCD function is selectable, see Table 13, Table 14, and Table 15.
- [19] Either one of the timer outputs MAT2[1] and MAT2[0] or the LCD function is selectable, see Table 13, Table 14, and Table 15.

7. Functional description

7.1 Architectural overview

The LPC2478 microcontroller consists of an ARM7TDMI-S CPU with emulation support, the ARM7 local bus for closely coupled, high-speed access to the majority of on-chip memory, the AMBA AHB interfacing to high-speed on-chip peripherals and external memory, and the AMBA APB for connection to other on-chip peripheral functions. The microcontroller permanently configures the ARM7TDMI-S processor for little-endian byte order.

The LPC2478 implements two AHB buses in order to allow the Ethernet block to operate without interference caused by other system activity. The primary AHB, referred to as AHB1, includes the VIC, GPDMA controller, and EMC.

The second AHB, referred to as AHB2, includes only the Ethernet block and an associated 16 kB SRAM. In addition, a bus bridge is provided that allows the secondary AHB to be a bus master on AHB1, allowing expansion of Ethernet buffer space into off-chip memory or unused space in memory residing on AHB1.

In summary, bus masters with access to AHB1 are the ARM7 itself, the GPDMA function, and the Ethernet block (via the bus bridge from AHB2). Bus masters with access to AHB2 are the ARM7 and the Ethernet block.

AHB peripherals are allocated a 2 MB range of addresses at the very top of the 4 GB ARM memory space. Each AHB peripheral is allocated a 16 kB address space within the AHB address space. Lower speed peripheral functions are connected to the APB bus. The AHB to APB bridge interfaces the APB bus to the AHB bus. APB peripherals are also allocated a 2 MB range of addresses, beginning at the 3.5 GB address point. Each APB peripheral is allocated a 16 kB address space.

The ARM7TDMI-S processor is a general purpose 32-bit microprocessor, which offers high performance and very low power consumption. The ARM architecture is based on Reduced Instruction Set Computer (RISC) principles, and the instruction set and related decode mechanism are much simpler than those of microprogrammed complex instruction set computers. This simplicity results in a high instruction throughput and impressive real-time interrupt response from a small and cost-effective processor core.

Pipeline techniques are employed so that all parts of the processing and memory systems can operate continuously. Typically, while one instruction is being executed, its successor is being decoded, and a third instruction is being fetched from memory.

The ARM7TDMI-S processor also employs a unique architectural strategy known as Thumb, which makes it ideally suited to high-volume applications with memory restrictions, or applications where code density is an issue.

The key idea behind Thumb is that of a super-reduced instruction set. Essentially, the ARM7TDMI-S processor has two instruction sets:

- the standard 32-bit ARM set
- a 16-bit Thumb set

The Thumb set's 16-bit instruction length allows it to approach higher density compared to standard ARM code while retaining most of the ARM's performance.

7.2 On-chip flash programming memory

The LPC2478 incorporates 512 kB flash memory system. This memory may be used for both code and data storage. Programming of the flash memory may be accomplished in several ways. It may be programmed In System via the serial port (UART0). The application program may also erase and/or program the flash while the application is running, allowing a great degree of flexibility for data storage field and firmware upgrades.

The flash memory is 128 bits wide and includes pre-fetching and buffering techniques to allow it to operate at speeds of 72 MHz.

The LPC2478 provides a minimum of 100000 write/erase cycles and 20 years of data retention.

7.3 On-chip SRAM

The LPC2478 includes a SRAM memory of 64 kB reserved for the ARM processor exclusive use. This RAM may be used for code and/or data storage and may be accessed as 8 bits, 16 bits, and 32 bits.

A 16 kB SRAM block serving as a buffer for the Ethernet controller and a 16 kB SRAM associated with the second AHB bus can be used both for data and code storage, too. Remaining SRAM such as a 4 kB USB FIFO and a 2 kB RTC SRAM can be used for data storage only. The RTC SRAM is battery powered and retains the content in the absence of the main power supply.

7.4 Memory map

The LPC2478 memory map incorporates several distinct regions as shown in <u>Table 5</u> and <u>Figure 4</u>.

In addition, the CPU interrupt vectors may be remapped to allow them to reside in either flash memory (default), boot ROM, or SRAM (see <u>Section 7.27.6</u>).

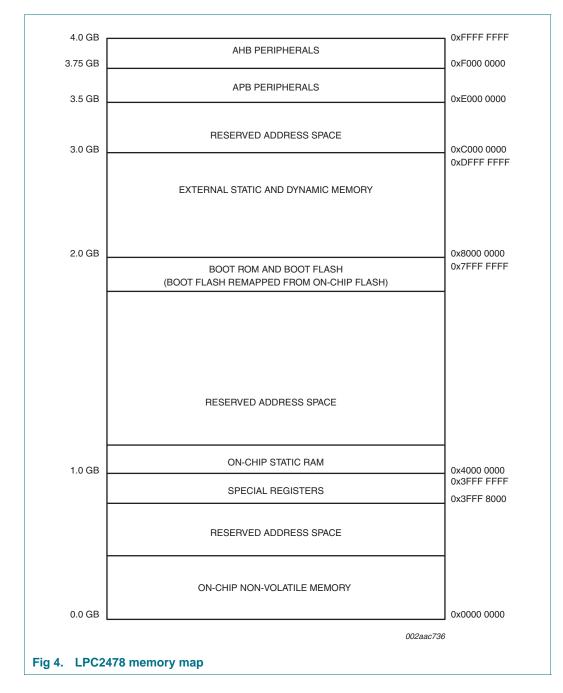
Downloaded from Elcodis.com electronic components distributor

Address range	General use	Address range details and des	cription	
0x0000 0000 to	On-chip	0x0000 0000 - 0x0007 FFFF	Flash Memory (512 kB)	
0x3FFF FFFF	non-volatile memory and Fast I/O	0x3FFF C000 - 0x3FFF FFFF	Fast GPIO registers	
0x4000 0000 to 0x7FFF FFFF	On-chip RAM	0x4000 0000 - 0x4000 FFFF	RAM (64 kB)	
		0x7FE0 0000 - 0x7FE0 3FFF	Ethernet RAM (16 kB)	
		0x7FD0 0000 - 0x7FD0 3FFF	USB RAM (16 kB)	
0x8000 0000 to 0xDFFF FFFF	Off-Chip Memory	Four static memory banks, 16 MB each		
		0x8000 0000 - 0x80FF FFFF	Static memory bank 0	
		0x8100 0000 - 0x81FF FFFF	Static memory bank 1	
		0x8200 0000 - 0x82FF FFFF	Static memory bank 2	
		0x8300 0000 - 0x83FF FFFF	Static memory bank 3	
		Four dynamic memory banks, 256 MB each		
		0xA000 0000 - 0xAFFF FFFF	Dynamic memory bank 0	
		0xB000 0000 - 0xBFFF FFFF	Dynamic memory bank 1	
		0xC000 0000 - 0xCFFF FFFF	Dynamic memory bank 2	
		0xD000 0000 - 0xDFFF FFFF	Dynamic memory bank 3	
0xE000 0000 to 0xEFFF FFFF	APB Peripherals	36 peripheral blocks, 16 kB each		
0xF000 0000 to 0xFFFF FFFF	AHB peripherals			

Table 5. LPC2478 memory usage and details



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7.5 Interrupt controller

The ARM processor core has two interrupt inputs called Interrupt Request (IRQ) and Fast Interrupt Request (FIQ). The VIC takes 32 interrupt request inputs which can be programmed as FIQ or vectored IRQ types. The programmable assignment scheme means that priorities of interrupts from the various peripherals can be dynamically assigned and adjusted.

FIQs have the highest priority. If more than one request is assigned to FIQ, the VIC ORs the requests to produce the FIQ signal to the ARM processor. The fastest possible FIQ latency is achieved when only one request is classified as FIQ, because then the FIQ

service routine can simply start dealing with that device. But if more than one request is assigned to the FIQ class, the FIQ service routine can read a word from the VIC that identifies which FIQ source(s) is (are) requesting an interrupt.

Vectored IRQs, which include all interrupt requests that are not classified as FIQs, have a programmable interrupt priority. When more than one interrupt is assigned the same priority and occur simultaneously, the one connected to the lowest numbered VIC channel will be serviced first.

The VIC ORs the requests from all of the vectored IRQs to produce the IRQ signal to the ARM processor. The IRQ service routine can start by reading a register from the VIC and jumping to the address supplied by that register.

7.5.1 Interrupt sources

Each peripheral device has one interrupt line connected to the VIC but may have several interrupt flags. Individual interrupt flags may also represent more than one interrupt source.

Any pin on PORT0 and PORT2 (total of 64 pins) regardless of the selected function, can be programmed to generate an interrupt on a rising edge, a falling edge, or both. Such interrupt request coming from PORT0 and/or PORT2 will be combined with the EINT3 interrupt requests.

7.6 Pin connect block

The pin connect block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on chip peripherals.

Peripherals should be connected to the appropriate pins prior to being activated and prior to any related interrupt(s) being enabled. Activity of any enabled peripheral function that is not mapped to a related pin should be considered undefined.

7.7 External memory controller

The LPC2478 EMC is an ARM PrimeCell MultiPort Memory Controller peripheral offering support for asynchronous static memory devices such as RAM, ROM, and flash. In addition, it can be used as an interface with off-chip memory-mapped devices and peripherals. The EMC is an Advanced Microcontroller Bus Architecture (AMBA) compliant peripheral.

7.7.1 Features

- Dynamic memory interface support including Single Data Rate SDRAM
- Asynchronous static memory device support including RAM, ROM, and flash, with or without asynchronous page mode
- Low transaction latency
- · Read and write buffers to reduce latency and to improve performance
- 8/16/32 data and 24 address lines wide static memory support
- 16 bit and 32 bit wide chip select SDRAM memory support
- Static memory features include:

- Asynchronous page mode read
- Programmable Wait States
- Bus turnaround delay
- Output enable and write enable delays
- Extended wait
- Four chip selects for synchronous memory and four chip selects for static memory devices
- Power-saving modes dynamically control CKE and CLKOUT to SDRAMs
- Dynamic memory self-refresh mode controlled by software
- Controller supports 2 k, 4 k, and 8 k row address synchronous memory parts. That is typical 512 MB, 256 MB, and 128 MB parts, with 4, 8, 16, or 32 data bits per device
- Separate reset domains allow the for auto-refresh through a chip reset if desired

Note: Synchronous static memory devices (synchronous burst mode) are not supported.

7.8 General purpose DMA controller

The GPDMA is an AMBA AHB compliant peripheral allowing selected LPC2478 peripherals to have DMA support.

The GPDMA enables peripheral-to-memory, memory-to-peripheral, peripheral-to-peripheral, and memory-to-memory transactions. Each DMA stream provides unidirectional serial DMA transfers for a single source and destination. For example, a bidirectional port requires one stream for transmit and one for receive. The source and destination areas can each be either a memory region or a peripheral, and can be accessed through the AHB master.

7.8.1 Features

- Two DMA channels. Each channel can support a unidirectional transfer.
- The GPDMA can transfer data between the 16 kB SRAM, external memory, and peripherals such as the SD/MMC, two SSPs, and the I²S interface.
- Single DMA and burst DMA request signals. Each peripheral connected to the GPDMA can assert either a burst DMA request or a single DMA request. The DMA burst size is set by programming the GPDMA.
- Memory-to-memory, memory-to-peripheral, peripheral-to-memory, and peripheral-to-peripheral transfers.
- Scatter or gather DMA is supported through the use of linked lists. This means that the source and destination areas do not have to occupy contiguous areas of memory.
- Hardware DMA channel priority. Each DMA channel has a specific hardware priority. DMA channel 0 has the highest priority and channel 1 has the lowest priority. If requests from two channels become active at the same time, the channel with the highest priority is serviced first.
- AHB slave DMA programming interface. The GPDMA is programmed by writing to the DMA control registers over the AHB slave interface.
- One AHB bus master for transferring data. This interface transfers data when a DMA request goes active.

- 32-bit AHB master bus width.
- Incrementing or non-incrementing addressing for source and destination.
- Programmable DMA burst size. The DMA burst size can be programmed to more efficiently transfer data. Usually the burst size is set to half the size of the FIFO in the peripheral.
- Internal four-word FIFO per channel.
- Supports 8-bit, 16-bit, and 32-bit wide transactions.
- An interrupt to the processor can be generated on a DMA completion or when a DMA error has occurred.
- Interrupt masking. The DMA error and DMA terminal count interrupt requests can be masked.
- Raw interrupt status. The DMA error and DMA count raw interrupt status can be read prior to masking.

7.9 Fast general purpose parallel I/O

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The value of the output register may be read back as well as the current state of the port pins.

LPC2478 use accelerated GPIO functions:

- GPIO registers are relocated to the ARM local bus so that the fastest possible I/O timing can be achieved.
- Mask registers allow treating sets of port bits as a group, leaving other bits unchanged.
- All GPIO registers are byte and half-word addressable.
- Entire port value can be written in one instruction.

Additionally, any pin on PORT0 and PORT2 (total of 64 pins) that is not configured as an analog input/output can be programmed to generate an interrupt on a rising edge, a falling edge, or both. The edge detection is asynchronous, so it may operate when clocks are not present such as during Power-down mode. Each enabled interrupt can be used to wake the chip up from Power-down mode.

7.9.1 Features

- Bit level set and clear registers allow a single instruction to set or clear any number of bits in one port.
- Direction control of individual bits.
- All I/O default to inputs after reset.
- Backward compatibility with other earlier devices is maintained with legacy PORT0 and PORT1 registers appearing at the original addresses on the APB bus.

7.10 LCD controller

The LCD controller provides all of the necessary control signals to interface directly to a variety of color and monochrome LCD panels. Both STN (single and dual panel) and TFT panels can be operated. The display resolution is selectable and can be up to 1024×768 pixels. Several color modes are provided, up to a 24-bit true-color non-palettized mode. An on-chip 512-byte color palette allows reducing bus utilization (i.e. memory size of the displayed data) while still supporting a large number of colors.

The LCD interface includes its own DMA controller to allow it to operate independently of the CPU and other system functions. A built-in FIFO acts as a buffer for display data, providing flexibility for system timing. Hardware cursor support can further reduce the amount of CPU time needed to operate the display.

7.10.1 Features

- AHB bus master interface to access frame buffer.
- Setup and control via a separate AHB slave interface.
- Dual 16-deep programmable 64-bit wide FIFOs for buffering incoming display data.
- Supports single and dual-panel monochrome Super Twisted Nematic (STN) displays with 4-bit or 8-bit interfaces.
- Supports single and dual-panel color STN displays.
- Supports Thin Film Transistor (TFT) color displays.
- Programmable display resolution including, but not limited to: 320×200 , 320×240 , 640×200 , 640×240 , 640×480 , 800×600 , and 1024×768 .
- Hardware cursor support for single-panel displays.
- 15 gray-level monochrome, 3375 color STN, and 32 K color palettized TFT support.
- 1, 2, or 4 bits-per-pixel (bpp) palettized displays for monochrome STN.
- 1, 2, 4, or 8 bpp palettized color displays for color STN and TFT.
- 16 bpp true-color non-palettized, for color STN and TFT.
- 24 bpp true-color non-palettized, for color TFT.
- Programmable timing for different display panels.
- 256 entry, 16-bit palette RAM, arranged as a 128 \times 32-bit RAM.
- Frame, line, and pixel clock signals.
- AC bias signal for STN, data enable signal for TFT panels.
- Supports little and big-endian, and Windows CE data formats.
- LCD panel clock may be generated from the peripheral clock, or from a clock input pin.

7.11 Ethernet

The Ethernet block contains a full featured 10 Mbit/s or 100 Mbit/s Ethernet MAC designed to provide optimized performance through the use of DMA hardware acceleration. Features include a generous suite of control registers, half or full duplex operation, flow control, control frames, hardware acceleration for transmit retry, receive packet filtering and wake-up on LAN activity. Automatic frame transmission and reception with scatter-gather DMA off-loads many operations from the CPU.

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The Ethernet block and the CPU share a dedicated AHB subsystem that is used to access the Ethernet SRAM for Ethernet data, control, and status information. All other AHB traffic in the LPC2478 takes place on a different AHB subsystem, effectively separating Ethernet activity from the rest of the system. The Ethernet DMA can also access off-chip memory via the EMC, as well as the SRAM located on another AHB. However, using memory other than the Ethernet SRAM, especially off-chip memory, will slow Ethernet access to memory and increase the loading of its AHB.

The Ethernet block interfaces between an off-chip Ethernet PHY using the Media Independent Interface (MII) or Reduced MII (RMII) protocol and the on-chip Media Independent Interface Management (MIIM) serial bus.

7.11.1 Features

- Ethernet standards support:
 - Supports 10 Mbit/s or 100 Mbit/s PHY devices including 10 Base-T, 100 Base-TX, 100 Base-FX, and 100 Base-T4.
 - Fully compliant with IEEE standard 802.3.
 - Fully compliant with 802.3x Full Duplex Flow Control and Half Duplex back pressure.
 - Flexible transmit and receive frame options.
 - Virtual Local Area Network (VLAN) frame support.
- Memory management:
 - Independent transmit and receive buffers memory mapped to shared SRAM.
 - DMA managers with scatter/gather DMA and arrays of frame descriptors.
 - Memory traffic optimized by buffering and pre-fetching.
- Enhanced Ethernet features:
 - Receive filtering.
 - Multicast and broadcast frame support for both transmit and receive.
 - Optional automatic Frame Check Sequence (FCS) insertion with Circular Redundancy Check (CRC) for transmit.
 - Selectable automatic transmit frame padding.
 - Over-length frame support for both transmit and receive allows any length frames.
 - Promiscuous receive mode.
 - Automatic collision back-off and frame retransmission.
 - Includes power management by clock switching.
 - Wake-on-LAN power management support allows system wake-up: using the receive filters or a magic frame detection filter.
- Physical interface:
 - Attachment of external PHY chip through standard MII or RMII interface.
 - PHY register access is available via the MIIM interface.

7.12 USB interface

The Universal Serial Bus (USB) is a 4-wire bus that supports communication between a host and one or more (up to 127) peripherals. The host controller allocates the USB bandwidth to attached devices through a token-based protocol. The bus supports hot plugging and dynamic configuration of the devices. All transactions are initiated by the host controller.

The LPC2478 USB interface includes a Device, Host, and OTG Controller. Details on typical USB interfacing solutions can be found in <u>Section 11.2 "Suggested USB interface</u> solutions" on page 65

7.12.1 USB Device Controller

The Device Controller enables 12 Mbit/s data exchange with a USB host controller. It consists of a register interface, serial interface engine, endpoint buffer memory, and a DMA controller. The serial interface engine decodes the USB data stream and writes data to the appropriate endpoint buffer. The status of a completed USB transfer or error condition is indicated via status registers. An interrupt is also generated if enabled. When enabled, the DMA controller transfers data between the endpoint buffer and the USB RAM.

7.12.1.1 Features

- Fully compliant with USB 2.0 specification (full speed).
- Supports 32 physical (16 logical) endpoints with a 4 kB endpoint buffer RAM.
- Supports Control, Bulk, Interrupt and Isochronous endpoints.
- Scalable realization of endpoints at run time.
- Endpoint Maximum packet size selection (up to USB maximum specification) by software at run time.
- Supports SoftConnect and GoodLink features.
- While USB is in the Suspend mode, LPC2478 can enter one of the reduced power modes and wake up on USB activity.
- Supports DMA transfers with the DMA RAM of 16 kB on all non-control endpoints.
- Allows dynamic switching between CPU-controlled and DMA modes.
- Double buffer implementation for Bulk and Isochronous endpoints.

7.12.2 USB Host Controller

The Host Controller enables full- and low-speed data exchange with USB devices attached to the bus. It consists of register interface, serial interface engine and DMA controller. The register interface complies with the OHCI specification.

7.12.2.1 Features

- OHCI compliant
- Two downstream ports
- Support for per-port power switching

LPC2478_1

7.12.3 USB OTG Controller

USB OTG (On-The-Go) is a supplement to the USB 2.0 specification that augments the capability of existing mobile devices and USB peripherals by adding host functionality for connection to USB peripherals.

The OTG Controller integrates the Host Controller, Device Controller, and a master-only I²C interface to implement OTG dual-role device functionality. The dedicated I²C interface controls an external OTG transceiver.

7.12.3.1 Features

- Fully compliant with On-The-Go supplement to the USB 2.0 Specification, Revision 1.0a.
- Hardware support for Host Negotiation Protocol (HNP).
- Includes a programmable timer required for HNP and Session Request Protocol (SRP).
- Supports any OTG transceiver compliant with the OTG Transceiver Specification (CEA-2011), Rev. 1.0.

7.13 CAN controller and acceptance filters

The Controller Area Network (CAN) is a serial communications protocol which efficiently supports distributed real-time control with a very high level of security. Its domain of application ranges from high-speed networks to low cost multiplex wiring.

The CAN block is intended to support multiple CAN buses simultaneously, allowing the device to be used as a gateway, switch, or router between two of CAN buses in industrial or automotive applications.

Each CAN controller has a register structure similar to the NXP SJA1000 and the PeliCAN Library block, but the 8-bit registers of those devices have been combined in 32-bit words to allow simultaneous access in the ARM environment. The main operational difference is that the recognition of received Identifiers, known in CAN terminology as Acceptance Filtering, has been removed from the CAN controllers and centralized in a global Acceptance Filter.

7.13.1 Features

- Two CAN controllers and buses.
- Data rates to 1 Mbit/s on each bus.
- 32-bit register and RAM access.
- Compatible with CAN specification 2.0B, ISO 11898-1.
- Global Acceptance Filter recognizes 11-bit and 29-bit receive identifiers for all CAN buses.
- Acceptance Filter can provide FullCAN-style automatic reception for selected Standard Identifiers.
- Full CAN messages can generate interrupts.

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7.14 10-bit ADC

The LPC2478 contains one ADC. It is a single 10-bit successive approximation ADC with eight channels.

7.14.1 Features

- 10-bit successive approximation ADC
- Input multiplexing among 8 pins
- Power-down mode
- Measurement range 0 V to V_{i(VREF)}
- 10-bit conversion time \ge 2.44 μ s
- Burst conversion mode for single or multiple inputs
- Optional conversion on transition of input pin or Timer Match signal
- Individual result registers for each ADC channel to reduce interrupt overhead

7.15 10-bit DAC

The DAC allows the LPC2478 to generate a variable analog output. The maximum output value of the DAC is $V_{i(\text{VREF})}.$

7.15.1 Features

- 10-bit DAC
- Resistor string architecture
- Buffered output
- Power-down mode
- Selectable output drive

7.16 UARTs

The LPC2478 contains four UARTs. In addition to standard transmit and receive data lines, UART1 also provides a full modem control handshake interface.

The UARTs include a fractional baud rate generator. Standard baud rates such as 115200 can be achieved with any crystal frequency above 2 MHz.

7.16.1 Features

- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Fractional divider for baud rate control, auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- UART1 equipped with standard modem interface signals. This module also provides full support for hardware flow control (auto-CTS/RTS).

• UART3 includes an IrDA mode to support infrared communication.

7.17 SPI serial I/O controller

The LPC2478 contains one SPI controller. SPI is a full duplex serial interface designed to handle multiple masters and slaves connected to a given bus. Only a single master and a single slave can communicate on the interface during a given data transfer. During a data transfer the master always sends 8 bits to 16 bits of data to the slave, and the slave always sends 8 bits to 16 bits of data to the master.

7.17.1 Features

- Compliant with SPI specification
- Synchronous, Serial, Full Duplex Communication
- Combined SPI master and slave
- Maximum data bit rate of one eighth of the input clock rate
- 8 bits to 16 bits per transfer

7.18 SSP serial I/O controller

The LPC2478 contains two SSP controllers. The SSP controller is capable of operation on a SPI, 4-wire SSI, or Microwire bus. It can interact with multiple masters and slaves on the bus. Only a single master and a single slave can communicate on the bus during a given data transfer. The SSP supports full duplex transfers, with frames of 4 bits to 16 bits of data flowing from the master to the slave and from the slave to the master. In practice, often only one of these data flows carries meaningful data.

7.18.1 Features

- Compatible with Motorola SPI, 4-wire TI SSI, and National Semiconductor Microwire buses
- Synchronous serial communication
- Master or slave operation
- 8-frame FIFOs for both transmit and receive
- 4-bit to 16-bit frame
- Maximum SPI bus data bit rate of one half (Master mode) and one twelfth (Slave mode) of the input clock rate
- DMA transfers supported by GPDMA

7.19 SD/MMC card interface

The Secure Digital and Multimedia Card Interface (MCI) allows access to external SD memory cards. The SD card interface conforms to the SD Multimedia Card Specification Version 2.11.

7.19.1 Features

• The MCI interface provides all functions specific to the SD/MMC memory card. These include the clock generation unit, power management control, and command and data transfer.

- Conforms to Multimedia Card Specification v2.11.
- Conforms to Secure Digital Memory Card Physical Layer Specification, v0.96.
- Can be used as a multimedia card bus or a secure digital memory card bus host. The SD/MMC can be connected to several multimedia cards or a single secure digital memory card.
- DMA supported through the GPDMA controller.

7.20 I²C-bus serial I/O controller

The LPC2478 contains three I^2C -bus controllers.

The I²C-bus is bidirectional, for inter-IC control using only two wires: a serial clock line (SCL), and a serial data line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (e.g., an LCD driver) or a transmitter with the capability to both receive and send information (such as memory). Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I²C-bus is a multi-master bus and can be controlled by more than one bus master connected to it.

The I²C-bus implemented in LPC2478 supports bit rates up to 400 kbit/s (Fast I²C-bus).

7.20.1 Features

- I²C0 is a standard I²C compliant bus interface with open-drain pins.
- I²C1 and I²C2 use standard I/O pins and do not support powering off of individual devices connected to the same bus lines.
- Easy to configure as master, slave, or master/slave.
- Programmable clocks allow versatile rate control.
- Bidirectional data transfer between masters and slaves.
- Multi-master bus (no central master).
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus.
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
- The I²C-bus can be used for test and diagnostic purposes.

7.21 I²S-bus serial I/O controllers

The I²S-bus provides a standard communication interface for digital audio applications.

The I²S-bus specification defines a 3-wire serial bus using one data line, one clock line, and one word select signal. The basic I²S connection has one master, which is always the master, and one slave. The I²S interface on the LPC2478 provides a separate transmit and receive channel, each of which can operate as either a master or a slave.

7.21.1 Features

- The interface has separate input/output channels each of which can operate in master or slave mode.
- Capable of handling 8-bit, 16-bit, and 32-bit word sizes.
- Mono and stereo audio data supported.
- The sampling frequency can range from 16 kHz to 48 kHz (16, 22.05, 32, 44.1, 48) kHz.
- Configurable word select period in master mode (separately for I²S input and output).
- Two 8 word FIFO data buffers are provided, one for transmit and one for receive.
- Generates interrupt requests when buffer levels cross a programmable boundary.
- Two DMA requests, controlled by programmable buffer levels. These are connected to the GPDMA block.
- Controls include reset, stop, and mute options separately for I²S input and I²S output.

7.22 General purpose 32-bit timers/external event counters

The LPC2478 includes four 32-bit Timer/Counters. The Timer/Counter is designed to count cycles of the system derived clock or an externally-supplied clock. It can optionally generate interrupts or perform other actions at specified timer values, based on four match registers. The Timer/Counter also includes four capture inputs to trap the timer value when an input signal transitions, optionally generating an interrupt.

7.22.1 Features

- A 32-bit Timer/Counter with a programmable 32-bit prescaler.
- Counter or Timer operation.
- Up to four 32-bit capture channels per timer, that can take a snapshot of the timer value when an input signal transitions. A capture event may also optionally generate an interrupt.
- Four 32-bit match registers that allow:
 - Continuous operation with optional interrupt generation on match.
 - Stop timer on match with optional interrupt generation.
 - Reset timer on match with optional interrupt generation.
- Up to four external outputs corresponding to match registers, with the following capabilities:
 - Set LOW on match.
 - Set HIGH on match.
 - Toggle on match.
 - Do nothing on match.

Preliminary data sheet

7.23 Pulse width modulator

The PWM is based on the standard Timer block and inherits all of its features, although only the PWM function is pinned out on the LPC2478. The Timer is designed to count cycles of the system derived clock and optionally switch pins, generate interrupts or perform other actions when specified timer values occur, based on seven match registers. The PWM function is in addition to these features and is based on match register events.

The ability to separately control rising and falling edge locations allows the PWM to be used for more applications. For instance, multi-phase motor control typically requires three non-overlapping PWM outputs with individual control of all three pulse widths and positions.

Two match registers can be used to provide a single edge controlled PWM output. A dedicated match register controls the PWM cycle rate, by resetting the count upon match. The other match register controls the PWM edge position. Additional single edge controlled PWM outputs require only one match register each, since the repetition rate is the same for all PWM outputs. Multiple single edge controlled PWM outputs will all have a rising edge at the beginning of each PWM cycle, when an PWMMR0 match occurs.

Three match registers can be used to provide a PWM output with both edges controlled. Again, a dedicated match register controls the PWM cycle rate. The other match registers control the two PWM edge positions. Additional double edge controlled PWM outputs require only two match registers each, since the repetition rate is the same for all PWM outputs.

With double edge controlled PWM outputs, specific match registers control the rising and falling edge of the output. This allows both positive going PWM pulses (when the rising edge occurs prior to the falling edge), and negative going PWM pulses (when the falling edge occurs prior to the rising edge).

7.23.1 Features

- LPC2478 has two PWMs with the same operational features. These may be operated in a synchronized fashion by setting them both up to run at the same rate, then enabling both simultaneously. PWM0 acts as the master and PWM1 as the slave for this use.
- Counter or Timer operation (may use the peripheral clock or one of the capture inputs as the clock source).
- Seven match registers allow up to 6 single edge controlled or 3 double edge controlled PWM outputs, or a mix of both types. The match registers also allow:
 - Continuous operation with optional interrupt generation on match.
 - Stop timer on match with optional interrupt generation.
 - Reset timer on match with optional interrupt generation.
- Supports single edge controlled and/or double edge controlled PWM outputs. Single edge controlled PWM outputs all go high at the beginning of each cycle unless the output is a constant low. Double edge controlled PWM outputs can have either edge occur at any position within a cycle. This allows for both positive going and negative going pulses.

- Pulse period and width can be any number of timer counts. This allows complete flexibility in the trade-off between resolution and repetition rate. All PWM outputs will occur at the same repetition rate.
- Double edge controlled PWM outputs can be programmed to be either positive going or negative going pulses.
- Match register updates are synchronized with pulse outputs to prevent generation of erroneous pulses. Software must 'release' new match values before they can become effective.
- May be used as a standard timer if the PWM mode is not enabled.
- A 32-bit Timer/Counter with a programmable 32-bit Prescaler.

7.24 Watchdog timer

The purpose of the watchdog is to reset the microcontroller within a reasonable amount of time if it enters an erroneous state. When enabled, the watchdog will generate a system reset if the user program fails to 'feed' (or reload) the watchdog within a predetermined amount of time.

7.24.1 Features

- Internally resets chip if not periodically reloaded.
- Debug mode.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect/Incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 32-bit timer with internal prescaler.
- Selectable time period from $(T_{cy(WDCLK)} \times 256 \times 4)$ to $(T_{cy(WDCLK)} \times 2^{32} \times 4)$ in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) source can be selected from the RTC clock, the Internal RC oscillator (IRC), or the APB peripheral clock. This gives a wide range of potential timing choices of Watchdog operation under different power reduction conditions. It also provides the ability to run the WDT from an entirely internal source that is not dependent on an external crystal and its associated components and wiring, for increased reliability.

7.25 RTC and battery RAM

The RTC is a set of counters for measuring time when system power is on, and optionally when it is off. It uses little power in Power-down mode. On the LPC2478, the RTC can be clocked by a separate 32.768 kHz oscillator or by a programmable prescale divider based on the APB clock. Also, the RTC is powered by its own power supply pin, VBAT, which can be connected to a battery or to the same 3.3 V supply used by the rest of the device.

The VBAT pin supplies power only to the RTC and the Battery RAM. These two functions require a minimum of power to operate, which can be supplied by an external battery. When the CPU and the rest of chip functions are stopped and power removed, the RTC can supply an alarm output that can be used by external hardware to restore chip power and resume operation.

7.25.1 Features

- Measures the passage of time to maintain a calendar and clock.
- Ultra low power design to support battery powered systems.
- Provides Seconds, Minutes, Hours, Day of Month, Month, Year, Day of Week, and Day of Year.
- Dedicated 32 kHz oscillator or programmable prescaler from APB clock.
- Dedicated power supply pin can be connected to a battery or to the main 3.3 V.
- An alarm output pin is included to assist in waking up when the chip has had power removed to all functions except the RTC and Battery RAM.
- Periodic interrupts can be generated from increments of any field of the time registers, and selected fractional second values. This enhancement enables the RTC to be used as a System Timer.
- 2 kB data SRAM powered by VBAT.
- RTC and Battery RAM power supply is isolated from the rest of the chip.

7.26 Clocking and power control

7.26.1 Crystal oscillators

The LPC2478 includes three independent oscillators. These are the Main Oscillator, the Internal RC oscillator, and the RTC oscillator. Each oscillator can be used for more than one purpose as required in a particular application. Any of the three clock sources can be chosen by software to drive the PLL and ultimately the CPU.

Following reset, the LPC2478 will operate from the Internal RC oscillator until switched by software. This allows systems to operate without any external crystal and the bootloader code to operate at a known frequency.

7.26.1.1 Internal RC oscillator

The IRC may be used as the clock source for the WDT, and/or as the clock that drives the PLL and subsequently the CPU. The nominal IRC frequency is 4 MHz. The IRC is trimmed to 1 % accuracy.

Upon power-up or any chip reset, the LPC2478 uses the IRC as the clock source. Software may later switch to one of the other available clock sources.

7.26.1.2 Main oscillator

The main oscillator can be used as the clock source for the CPU, with or without using the PLL. The main oscillator operates at frequencies of 1 MHz to 24 MHz. This frequency can be boosted to a higher frequency, up to the maximum CPU operating frequency, by the PLL. The clock selected as the PLL input is PLLCLKIN. The ARM processor clock frequency is referred to as CCLK elsewhere in this document. The frequencies of PLLCLKIN and CCLK are the same value unless the PLL is active and connected. The clock frequency for each peripheral can be selected individually and is referred to as PCLK. Refer to <u>Section 7.26.2</u> for additional information.

7.26.1.3 RTC oscillator

The RTC oscillator can be used as the clock source for the RTC and/or the WDT. Also, the RTC oscillator can be used to drive the PLL and the CPU.

7.26.2 PLL

The PLL accepts an input clock frequency in the range of 32 kHz to 50 MHz. The input frequency is multiplied up to a high frequency, then divided down to provide the actual clock used by the CPU and the USB block.

The PLL input, in the range of 32 kHZ to 50 MHz, may initially be divided down by a value 'N', which may be in the range of 1 to 256. This input division provides a wide range of output frequencies from the same input frequency.

Following the PLL input divider is the PLL multiplier. This can multiply the input divider output through the use of a Current Controlled Oscillator (CCO) by a value 'M', in the range of 1 through 32768. The resulting frequency must be in the range of 275 MHz to 550 MHz. The multiplier works by dividing the CCO output by the value of M, then using a phase-frequency detector to compare the divided CCO output to the multiplier input. The error value is used to adjust the CCO frequency.

The PLL is turned off and bypassed following a chip Reset and by entering Power-down mode. PLL is enabled by software only. The program must configure and activate the PLL, wait for the PLL to lock, then connect to the PLL as a clock source.

7.26.3 Wake-up timer

The LPC2478 begins operation at power-up and when awakened from Power-down mode by using the 4 MHz IRC oscillator as the clock source. This allows chip operation to resume quickly. If the main oscillator or the PLL is needed by the application, software will need to enable these features and wait for them to stabilize before they are used as a clock source.

When the main oscillator is initially activated, the wake-up timer allows software to ensure that the main oscillator is fully functional before the processor uses it as a clock source and starts to execute instructions. This is important at power on, all types of Reset, and whenever any of the aforementioned functions are turned off for any reason. Since the oscillator and other functions are turned off during Power-down mode, any wake-up of the processor from Power-down mode makes use of the wake-up Timer.

The Wake-up Timer monitors the crystal oscillator to check whether it is safe to begin code execution. When power is applied to the chip, or when some event caused the chip to exit Power-down mode, some time is required for the oscillator to produce a signal of sufficient amplitude to drive the clock logic. The amount of time depends on many factors, including the rate of $V_{DD(3V3)}$ ramp (in the case of power on), the type of crystal and its electrical characteristics (if a quartz crystal is used), as well as any other external circuitry (e.g., capacitors), and the characteristics of the oscillator itself under the existing ambient conditions.

7.26.4 Power control

The LPC2478 supports a variety of power control features. There are four special modes of processor power reduction: Idle mode, Sleep mode, and Power-down mode. The CPU clock rate may also be controlled as needed by changing clock sources, reconfiguring

PLL values, and/or altering the CPU clock divider value. This allows a trade-off of power versus processing speed based on application requirements. In addition, Peripheral power control allows shutting down the clocks to individual on-chip peripherals, allowing fine tuning of power consumption by eliminating all dynamic power use in any peripherals that are not required for the application. Each of the peripherals has its own clock divider which provides even better power control.

The LPC2478 also implements a separate power domain in order to allow turning off power to the bulk of the device while maintaining operation of the RTC and a small SRAM, referred to as the Battery RAM.

7.26.4.1 Idle mode

In Idle mode, execution of instructions is suspended until either a Reset or interrupt occurs. Peripheral functions continue operation during Idle mode and may generate interrupts to cause the processor to resume execution. Idle mode eliminates dynamic power used by the processor itself, memory systems and related controllers, and internal buses.

7.26.4.2 Sleep mode

In Sleep mode, the oscillator is shut down and the chip receives no internal clocks. The processor state and registers, peripheral registers, and internal SRAM values are preserved throughout Sleep mode and the logic levels of chip pins remain static. The output of the IRC is disabled but the IRC is not powered down for a fast wake-up later. The 32 kHz RTC oscillator is not stopped because the RTC interrupts may be used as the wake-up source. The PLL is automatically turned off and disconnected. The CCLK and USB clock dividers automatically get reset to zero.

The Sleep mode can be terminated and normal operation resumed by either a Reset or certain specific interrupts that are able to function without clocks. Since all dynamic operation of the chip is suspended, Sleep mode reduces chip power consumption to a very low value. The flash memory is left on in Sleep mode, allowing a very quick wake-up.

On the wake-up of Sleep mode, if the IRC was used before entering Sleep mode, the code execution and peripherals activities will resume after 4 cycles expire. If the main external oscillator was used, the code execution will resume when 4096 cycles expire.

The customers need to reconfigure the PLL and clock dividers accordingly.

7.26.4.3 Power-down mode

Power-down mode does everything that Sleep mode does, but also turns off the IRC oscillator and the flash memory. This saves more power, but requires waiting for resumption of flash operation before execution of code or data access in the flash memory can be accomplished.

On the wake-up of Power-down mode, if the IRC was used before entering Power-down mode, it will take IRC 60 μ s to start-up. After this 4 IRC cycles will expire before the code execution can then be resumed if the code was running from SRAM. In the meantime, the flash wake-up timer then counts 4 MHz IRC clock cycles to make the 100 μ s flash start-up time. When it times out, access to the flash will be allowed. The customers need to reconfigure the PLL and clock dividers accordingly.

7.26.4.4 Power domains

The LPC2478 provides two independent power domains that allow the bulk of the device to have power removed while maintaining operation of the RTC and the Battery RAM.

On the LPC2478, I/O pads are powered by the 3.3 V ($V_{DD(3V3)}$) pins, while the $V_{DD(DCDC)(3V3)}$ pins power the on-chip DC-to-DC converter which in turn provides power to the CPU and most of the peripherals.

Although both the I/O pad ring and the core require a 3.3 V supply, different powering schemes can be used depending on the actual application requirements.

The first option assumes that power consumption is not a concern and the design ties the $V_{DD(3V3)}$ and $V_{DD(DCDC)(3V3)}$ pins together. This approach requires only one 3.3 V power supply for both pads, the CPU, and peripherals. While this solution is simple, it does not support powering down the I/O pad ring "on the fly" while keeping the CPU and peripherals alive.

The second option uses two power supplies; a 3.3 V supply for the I/O pads ($V_{DD(3V3)}$) and a dedicated 3.3 V supply for the CPU ($V_{DD(DCDC)(3V3)}$). Having the on-chip DC-DC converter powered independently from the I/O pad ring enables shutting down of the I/O pad power supply "on the fly", while the CPU and peripherals stay active.

The VBAT pin supplies power only to the RTC and the Battery RAM. These two functions require a minimum of power to operate, which can be supplied by an external battery. When the CPU and the rest of chip functions are stopped and power removed, the RTC can supply an alarm output that may be used by external hardware to restore chip power and resume operation.

7.27 System control

7.27.1 Reset

Reset has four sources on the LPC2478: the RESET pin, the Watchdog reset, power-on reset, and the BrownOut Detection (BOD) circuit. The RESET pin is a Schmitt trigger input pin. Assertion of chip Reset by any source, once the operating voltage attains a usable level, starts the wake-up timer (see description in <u>Section 7.26.3 "Wake-up timer</u>"), causing reset to remain asserted until the external Reset is de-asserted, the oscillator is running, a fixed number of clocks have passed, and the flash controller has completed its initialization.

When the internal Reset is removed, the processor begins executing at address 0, which is initially the Reset vector mapped from the Boot Block. At that point, all of the processor and peripheral registers have been initialized to predetermined values.

7.27.2 Brownout detection

The LPC2478 includes 2-stage monitoring of the voltage on the $V_{DD(3V3)}$ pins. If this voltage falls below 2.95 V, the BOD asserts an interrupt signal to the Vectored Interrupt Controller. This signal can be enabled for interrupt in the Interrupt Enable Register in the VIC in order to cause a CPU interrupt; if not, software can monitor the signal by reading a dedicated status register.

The second stage of low-voltage detection asserts Reset to inactivate the LPC2478 when the voltage on the $V_{DD(3V3)}$ pins falls below 2.65 V. This Reset prevents alteration of the flash as operation of the various elements of the chip would otherwise become unreliable due to low voltage. The BOD circuit maintains this reset down below 1 V, at which point the power-on reset circuitry maintains the overall Reset.

Both the 2.95 V and 2.65 V thresholds include some hysteresis. In normal operation, this hysteresis allows the 2.95 V detection to reliably interrupt, or a regularly-executed event loop to sense the condition.

7.27.3 Code security (Code Read Protection - CRP)

This feature of the LPC2478 allows user to enable different levels of security in the system so that access to the on-chip flash and use of the JTAG and ISP can be restricted. When needed, CRP is invoked by programming a specific pattern into a dedicated flash location. IAP commands are not affected by the CRP.

There are three levels of the Code Read Protection.

CRP1 disables access to chip via the JTAG and allows partial flash update (excluding flash sector 0) using a limited set of the ISP commands. This mode is useful when CRP is required and flash field updates are needed but all sectors can not be erased.

CRP2 disables access to chip via the JTAG and only allows full flash erase and update using a reduced set of the ISP commands.

Running an application with level CRP3 selected fully disables any access to chip via the JTAG pins and the ISP. This mode effectively disables ISP override using P2[10] pin, too. It is up to the user's application to provide (if needed) flash update mechanism using IAP calls or a call to reinvoke the ISP command to enable flash update via UART0.

CAUTION



If level three Code Read Protection (CRP3) is selected, no future factory testing can be performed on the device.

7.27.4 AHB bus

The LPC2478 implements two AHB buses in order to allow the Ethernet block to operate without interference caused by other system activity. The primary AHB, referred to as AHB1, includes the Vectored Interrupt Controller, GPDMA controller, USB interface, and 16 kB SRAM.

The second AHB, referred to as AHB2, includes only the Ethernet block and an associated 16 kB SRAM. In addition, a bus bridge is provided that allows the secondary AHB to be a bus master on AHB1, allowing expansion of Ethernet buffer space into off-chip memory or unused space in memory residing on AHB1.

In summary, bus masters with access to AHB1 are the ARM7 itself, the USB block, the GPDMA function, and the Ethernet block (via the bus bridge from AHB2). Bus masters with access to AHB2 are the ARM7 and the Ethernet block.

7.27.5 External interrupt inputs

The LPC2478 includes up to 68 edge sensitive interrupt inputs combined with up to four level sensitive external interrupt inputs as selectable pin functions. The external interrupt inputs can optionally be used to wake up the processor from Power-down mode.

7.27.6 Memory mapping control

The memory mapping control alters the mapping of the interrupt vectors that appear at the beginning at address 0x0000 0000. Vectors may be mapped to the bottom of the Boot ROM, the SRAM, or external memory. This allows code running in different memory spaces to have control of the interrupts.

7.28 Emulation and debugging

The LPC2478 support emulation and debugging via a JTAG serial port. A trace port allows tracing program execution. Debugging and trace functions are multiplexed only with GPIOs on P2[0] to P2[9]. This means that all communication, timer, and interface peripherals residing on other pins are available during the development and debugging phase as they are when the application is run in the embedded system itself.

7.28.1 EmbeddedICE

The EmbeddedICE logic provides on-chip debug support. The debugging of the target system requires a host computer running the debugger software and an EmbeddedICE protocol convertor. The EmbeddedICE protocol convertor converts the Remote Debug Protocol commands to the JTAG data needed to access the ARM7TDMI-S core present on the target system.

The ARM core has a Debug Communication Channel (DCC) function built-in. The DCC allows a program running on the target to communicate with the host debugger or another separate host without stopping the program flow or even entering the debug state. The DCC is accessed as a coprocessor 14 by the program running on the ARM7TDMI-S core. The DCC allows the JTAG port to be used for sending and receiving data without affecting the normal program flow. The DCC data and control registers are mapped in to addresses in the EmbeddedICE logic.

7.28.2 Embedded trace

Since the LPC2478 have significant amounts of on-chip memories, it is not possible to determine how the processor core is operating simply by observing the external pins. The ETM provides real-time trace capability for deeply embedded processor cores. It outputs information about processor execution to a trace port. A software debugger allows configuration of the ETM using a JTAG interface and displays the trace information that has been captured.

The ETM is connected directly to the ARM core and not to the main AMBA system bus. It compresses the trace information and exports it through a narrow trace port. An external Trace Port Analyzer captures the trace information under software debugger control. The trace port can broadcast the Instruction trace information. Instruction trace (or PC trace) shows the flow of execution of the processor and provides a list of all the instructions that were executed. Instruction trace is significantly compressed by only broadcasting branch addresses as well as a set of status signals that indicate the pipeline status on a cycle by cycle basis. Trace information generation can be controlled by selecting the trigger resource. Trigger resources include address comparators, counters and sequencers.

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Since trace information is compressed the software debugger requires a static image of the code being executed. Self-modifying code can not be traced because of this restriction.

7.28.3 RealMonitor

RealMonitor is a configurable software module, developed by ARM Inc., which enables real-time debug. It is a lightweight debug monitor that runs in the background while users debug their foreground application. It communicates with the host using the DCC, which is present in the EmbeddedICE logic. The LPC2478 contain a specific configuration of RealMonitor software programmed into the on-chip ROM memory.

8. Limiting values

Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

Parameter	Conditions	Min	Max	Unit
supply voltage (3.3 V)	core and external rail	3.0	3.6	V
DC-to-DC converter supply voltage (3.3 V)		3.0	3.6	V
analog 3.3 V pad supply voltage		-0.5	+4.6	V
input voltage on pin VBAT	for the RTC	-0.5	+4.6	V
input voltage on pin VREF		-0.5	+4.6	V
analog input voltage	on ADC related pins	-0.5	+5.1	V
input voltage	5 V tolerant I/O pins; only valid when the V _{DD(3V3)} supply voltage is present	2 –0.5	+6.0	V
	other I/O pins	<u>[2][3]</u> –0.5	V _{DD(3V3)} + 0.5	V
supply current	per supply pin	<u>[4]</u> _	100	mA
ground current	per ground pin	[4] _	100	mA
storage temperature		<u>[5]</u> –65	+150	°C
total power dissipation (per package)	based on package heat transfer, not device power consumption	-	1.5	W
electrostatic discharge voltage	human body model; all pins	<u>[6]</u> –2000	+2000	V
	supply voltage (3.3 V) DC-to-DC converter supply voltage (3.3 V) analog 3.3 V pad supply voltage input voltage on pin VBAT input voltage on pin VREF analog input voltage input voltage supply current ground current storage temperature total power dissipation (per package)	supply voltage (3.3 V)core and external railDC-to-DC converter supply voltage (3.3 V)	supply voltage (3.3 V)core and external rail3.0DC-to-DC converter supply voltage (3.3 V)3.03.0analog 3.3 V pad supply voltage-0.5input voltage on pin VBATfor the RTC-0.5input voltage on pin VREF-0.5analog input voltageon ADC related pins-0.5input voltage5 V tolerant I/O pins; only valid when the V_DD(3V3) supply voltage is present[2] -0.5supply currentper supply pin[4] -ground currentper ground pin[4] -total power dissipation (per package) heat transfer, not device power consumption5 -2000	supply voltage (3.3 V)core and external rail3.03.6DC-to-DC converter supply voltage (3.3 V)3.03.6analog 3.3 V pad supply voltage-0.5+4.6input voltage on pin VBATfor the RTC-0.5+4.6input voltage on pin VREF-0.5+4.6analog input voltageon ADC related pins-0.5+5.1input voltage 5 V tolerant I/O pins; only valid when the VDD(3V3) supply voltage is present[2] -0.5+6.0supply currentper supply pin[4] -100ground currentper ground pin[4] -100storage temperature[5] -65+150total power dissipation (per package) heat transfer, not device power consumption2000+2000

[1] The following applies to the Limiting values:

 a) This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.

b) Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

[2] Including voltage on outputs in 3-state mode.

[3] Not to exceed 4.6 V.

[4] The peak current is limited to 25 times the corresponding maximum current.

[5] Dependent on package type.

[6] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.

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Static characteristics 9.

Table 7. Static characteristics

 $T_{amb} = -40 \,^{\circ}$ C to +85 $^{\circ}$ C for commercial applications, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
V _{DD(3V3)}	supply voltage (3.3 V)	core and external rail		3.0	3.3	3.6	V
V _{DD(DCDC)(3V3)}	DC-to-DC converter supply voltage (3.3 V)			3.0	3.3	3.6	V
V _{DDA}	analog 3.3 V pad supply voltage			3.0	3.3	3.6	V
V _{i(VBAT)}	input voltage on pin VBAT		[2]	2.0	3.3	3.6	V
V _{i(VREF)}	input voltage on pin VREF			2.5	3.3	V _{DDA}	V
Standard port	pins, RESET, RTCK						
IL	LOW-level input current	$V_I = 0 V$; no pull-up		-	-	3	μA
lн	HIGH-level input current	$V_I = V_{DD(3V3)}$; no pull-down		-	-	3	μA
l _{oz}	OFF-state output current	$V_O = 0 V; V_O = V_{DD(3V3)};$ no pull-up/down		-	-	3	μA
llatch	I/O latch-up current	–(0.5V _{DD(3V3)}) < V _I < (1.5V _{DD(3V3}); T _j < 125 °C		-	-	100	mA
VI	input voltage	pin configured to provide a digital function	[3][4][5]	0	-	5.5	V
Vo	output voltage	output active		0	-	V _{DD(3V3)}	V
V _{IH}	HIGH-level input voltage			2.0	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.8	V
V _{hys}	hysteresis voltage			-	0.4	-	V
V _{OH}	HIGH-level output voltage	$I_{OH} = -4 \text{ mA}$	<u>[6]</u>	V _{DD(3V3)} - 0.4	-	-	V
V _{OL}	LOW-level output voltage	$I_{OL} = -4 \text{ mA}$	<u>[6]</u>	-	-	0.4	V
loн	HIGH-level output current	$V_{OH} = V_{DD(3V3)} - 0.4 V$	[6]	-4	-	-	mA
lol	LOW-level output current	$V_{OL} = 0.4 V$	<u>[6]</u>	4	-	-	mA
I _{OHS}	HIGH-level short-circuit output current	V _{OH} = 0 V	<u>[7]</u>	-	-	-45	mA
l _{ols}	LOW-level short-circuit output current	$V_{OL} = V_{DDA}$	[7]	-	-	50	mA
I _{pd}	pull-down current	V _I = 5 V	[8]	10	50	150	μA
I _{pu}	pull-up current	$V_{I} = 0 V$		-15	-50	-85	μA
		$V_{DD(3V3)} < V_{I} < 5 V$	<u>[8]</u>	0	0	0	μA
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Table 7. Static characteristics ...continued

 $T_{amb} = -40 \ \text{C}$ to +85 $\ \text{C}$ for commercial applications, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
DD(DCDC)act(3V3)	active mode DC-to-DC converter supply	$V_{DD(DCDC)(3V3)} = 3.3 V;$ $T_{amb} = 25 °C; code$					
	current (3.3 V)	while(1){}					
		executed from flash; no peripherals enabled; PCLK = CCLK					
		CCLK = 10 MHz		-	15	-	mΑ
		CCLK = 72 MHz		-	63	-	mΑ
		all peripherals enabled; PCLK = CCLK / 8					
		CCLK = 10 MHz		-	21	-	mΑ
		CCLK = 72 MHz		-	92	-	mΑ
		all peripherals enabled; PCLK = CCLK					
		CCLK = 10 MHz		-	27	-	mΑ
		CCLK = 72 MHz		-	125	-	mA
DD(DCDC)pd(3V3)	power-down mode DC-to-DC converter	V _{DD(DCDC)(3V3)} = 3.3 V; T _{amb} = 25 °C					
••	supply current (3.3 V)		[0]	-	150	-	μA
BATact	active mode battery supply current	DC-to-DC converter on	[<u>9]</u>		20	-	μA
		DC-to-DC converter off	<u>[9]</u>	-	28	-	μA
	0[27] and P0[28])						
V _{IH}	HIGH-level input voltage			0.7V _{DD(3V3)}	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.3V _{DD(3V3)}	V
V _{hys}	hysteresis voltage			-	0.5V _{DD(3V3)}	-	V
V _{OL}	LOW-level output voltage	I _{OLS} = 3 mA	<u>[6]</u>	-	-	0.4	V
LI	input leakage current	$V_{I} = V_{DD(3V3)}$	[10]	-	2	4	μΑ
		V ₁ = 5 V		-	10	22	μΑ
Oscillator pins							
V _{i(XTAL1)}	input voltage on pin XTAL1			0	-	1.8	V
V _{o(XTAL2)}	output voltage on pin XTAL2			0	-	1.8	V
V _{i(RTCX1)}	input voltage on pin RTCX1			0	-	1.8	V
V _{o(RTCX2)}	output voltage on pin RTCX2			0	-	1.8	V

Table 7. Static characteristics ... continued

 $T_{amb} = -40 \,^{\circ}$ C to +85 $^{\circ}$ C for commercial applications, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
USB pins						
I _{OZ}	OFF-state output current	0 V < V _I < 3.3 V	-	-	±10	μA
V _{BUS}	bus supply voltage		-	-	5.25	V
V _{DI}	differential input sensitivity voltage	(D+) – (D–)	0.2	-	-	V
V _{CM}	differential common mode voltage range	includes V _{DI} range	0.8	-	2.5	V
V _{th(rs)se}	single-ended receiver switching threshold voltage		0.8	-	2.0	V
V _{OL}	LOW-level output voltage for low-/full-speed	R_L of 1.5 k Ω to 3.6 V	-	-	0.18	V
V _{OH}	HIGH-level output voltage (driven) for low-/full-speed	R_L of 15 $k\Omega$ to GND	2.8	-	3.5	V
C _{trans}	transceiver capacitance	pin to GND	-	-	20	pF
Z _{DRV}	driver output impedance for driver which is not high-speed capable	with 33 Ω series resistor; steady state drive	[11] 36	-	44.1	Ω
R _{pu}	pull-up resistance	SoftConnect = ON	1.1	-	1.9	kΩ

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages

[2] The RTC typically fails when $V_{i(VBAT)}$ drops below 1.6 V.

[3] Including voltage on outputs in 3-state mode.

[4] V_{DD(3V3)} supply voltages must be present.

- [5] 3-state outputs go into 3-state mode when $V_{DD(3V3)}$ is grounded.
- [6] Accounts for 100 mV voltage drop in all supply lines.
- [7] Only allowed for a short time period.
- [8] Minimum condition for $V_I = 4.5$ V, maximum condition for $V_I = 5.5$ V.
- [9] On pin VBAT.
- [10] To $V_{\text{SS}}.$
- [11] Includes external resistors of 18 $\Omega\pm$ 1 % on D+ and D–.

Table 8. ADC static characteristics

 V_{DDA} = 2.5 V to 3.6 V; T_{amb} = -40 °C to +85 °C unless otherwise specified; ADC frequency 4.5 MHz.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
VIA	analog input voltage		0	-	V_{DDA}	V
C _{ia}	analog input capacitance		-	-	1	pF
ED	differential linearity error	[1][:	2][3]	-	±1	LSB
E _{L(adj)}	integral non-linearity	1	1][4] _	-	±2	LSB
Eo	offset error	1	1][5]	-	±3	LSB

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Table 8. ADC static characteristics ... continued

V_{DDA} = 2.5 V to 3.6 V; T_{amb} = -40 °C to +85 °C unless otherwise specified; ADC frequency 4.5 MHz.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
E _G	gain error		<u>[1][6]</u> _	-	±0.5	%
E _T	absolute error		<u>[1][7]</u> _	-	±4	LSB
R _{vsi}	voltage source interface resistance		<u>[8]</u> _	-	40	kΩ

[1] Conditions: $V_{SSA} = 0 V$, $V_{DDA} = 3.3 V$.

[2] The ADC is monotonic, there are no missing codes.

[3] The differential linearity error (E_D) is the difference between the actual step width and the ideal step width. See Figure 5.

[4] The integral non-linearity (E_{L(adj)}) is the peak difference between the center of the steps of the actual and the ideal transfer curve after appropriate adjustment of gain and offset errors. See Figure 5.

[5] The offset error (E_0) is the absolute difference between the straight line which fits the actual curve and the straight line which fits the ideal curve. See Figure 5.

[6] The gain error (E_G) is the relative difference in percent between the straight line fitting the actual transfer curve after removing offset error, and the straight line which fits the ideal transfer curve. See Figure 5.

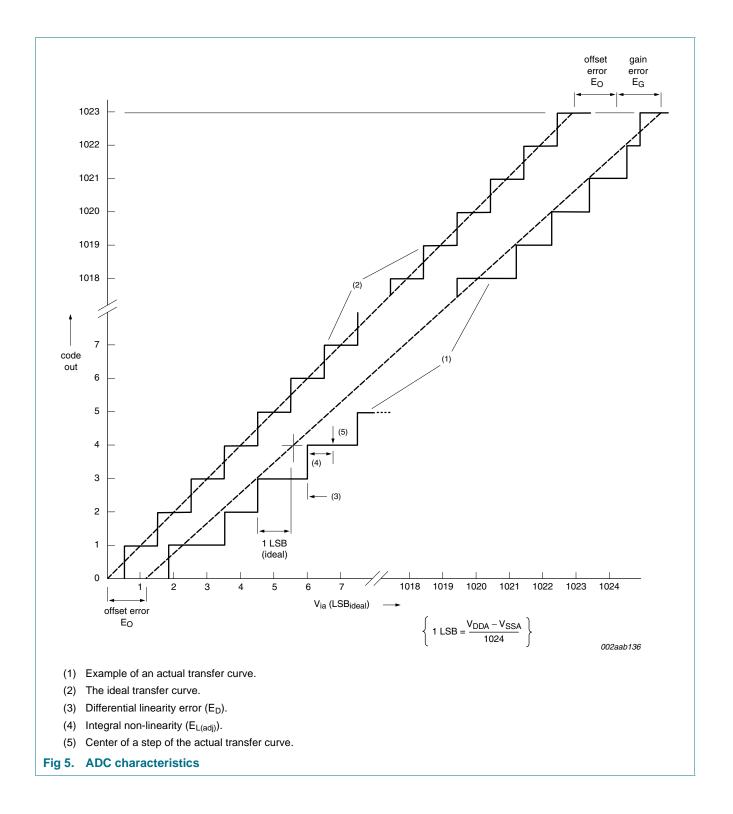
[7] The absolute error (E_T) is the maximum difference between the center of the steps of the actual transfer curve of the non-calibrated ADC and the ideal transfer curve. See Figure 5.

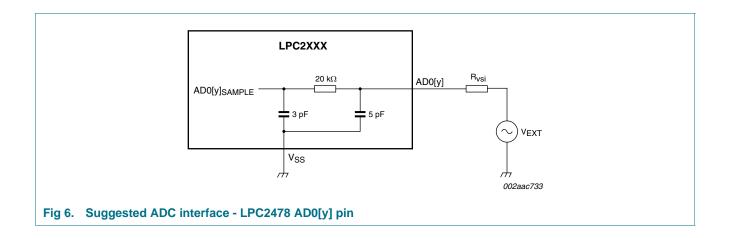
[8] See Figure 6.

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10. Dynamic characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _r	rise time	10 % to 90 %	8.5	-	13.8	ns
t _f	fall time	10 % to 90 %	7.7	-	13.7	ns
t _{FRFM}	differential rise and fall time matching	t _r / t _f	-	-	109	%
V _{CRS}	output signal crossover voltage		1.3	-	2.0	V
t _{FEOPT}	source SE0 interval of EOP	see Figure 10	160	-	175	ns
t _{FDEOP}	source jitter for differential transition to SE0 transition	see Figure 10	-2	-	+5	ns
t _{JR1}	receiver jitter to next transition		-18.5	-	+18.5	ns
t _{JR2}	receiver jitter for paired transitions	10 % to 90 %	-9	-	+9	ns
t _{eopr1}	EOP width at receiver	must reject as EOP; see Figure 10	[1] 40	-	-	ns
t _{EOPR2}	EOP width at receiver	must accept as EOP; see <u>Figure 10</u>	<u>[1]</u> 82	-	-	ns

Dynamic characteristics of USB pins (full-speed) Table 9.

[1] Characterized but not implemented as production test. Guaranteed by design.

Table 10. Dynamic characteristics

 $T_{amb} = -40 \text{ °C to } +85 \text{ °C for commercial applications; } V_{DD(3V3)}$ over specified ranges.[1]

Symbol	Parameter	Conditions	Min	Typ <mark>[2]</mark>	Max	Unit
External clo	ck					
f _{osc}	oscillator frequency		1	-	24	MHz
T _{cy(clk)}	clock cycle time		40	-	100	ns
t _{CHCX}	clock HIGH time		$T_{\text{cy(clk)}} \times 0.4$	-	-	ns
t _{CLCX}	clock LOW time		$T_{\text{cy(clk)}} \times 0.4$	-	-	ns
t _{CLCH}	clock rise time		-	-	5	ns
t _{CHCL}	clock fall time		-	-	5	ns
I ² C-bus pins	6 (P0[27] and P0[28])					
t _{f(0)}	output fall time	V_{IH} to V_{IL}	$20 + 0.1 \times C_{b}$	-	-	ns

[1] Parameters are valid over operating temperature range unless otherwise specified.

[2] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[3] Bus capacitance C_b in pF, from 10 pF to 400 pF.

Table 11. External memory interface dynamic characteristics

 $C_L = 25 \ pF$, $T_{amb} = 40 \ ^{\circ}C$.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Common	to read and write cycles					
t _{CHAV}	XCLK HIGH to address valid time		-	-	10	ns
t _{CHCSL}	XCLK HIGH to CS LOW time		-	-	10	ns
t _{CHCSH}	XCLK HIGH to CS HIGH time		-	-	10	ns
t _{CHANV}	XCLK HIGH to address invalid time		-	-	10	ns
Read cyc	le parameters					
t _{CSLAV}	CS LOW to address valid time	[1]	-5	-	+10	ns
t _{OELAV}	OE LOW to address valid time	[1]	-5	-	+10	ns
t _{CSLOEL}	CS LOW to OE LOW time		-5	-	+5	ns
t _{am}	memory access time	<u>[2][3]</u>	(T _{cy(CCLK)} × (2 + WST1)) + (–20)	-	-	ns
t _{am(ibr)}	memory access time (initial burst-ROM)	[2][3]	(T _{cy(CCLK)} × (2 + WST1)) + (–20)	-	-	ns
t _{am(sbr)}	memory access time (subsequent burst-ROM)	[2][4]	T _{cy(CCLK)} + (–20)	-	-	ns
t _{h(D)}	data hold time	[5]	0	-	-	ns
t _{CSHOEH}	CS HIGH to OE HIGH time		-5	-	+5	ns
t _{OEHANV}	OE HIGH to address invalid time		-5	-	+5	ns
t _{CHOEL}	XCLK HIGH to OE LOW time		-5	-	+5	ns
t _{СНОЕН}	XCLK HIGH to OE HIGH time		-5	-	+5	ns
Write cyc	le parameters					
t _{AVCSL}	address valid to CS LOW time	[1]	$T_{cy(CCLK)} - 10$	-	-	ns
t _{CSLDV}	CS LOW to data valid time		-5	-	+5	ns
t _{CSLWEL}	CS LOW to WE LOW time		-5	-	+5	ns
t _{CSLBLSL}	CS LOW to BLS LOW time		-5	-	+5	ns
t _{WELDV}	WE LOW to data valid time		-5	-	+5	ns
t _{CSLDV}	CS LOW to data valid time		-5	-	+5	ns
t _{WELWEH}	WE LOW to WE HIGH time	[2]	$T_{cy(CCLK)} \times (1 + WST2) - 5$	-	$T_{cy(CCLK)} \times (1 + WST2) + 5$	ns
t _{BLSLBLSH}	BLS LOW to BLS HIGH time	[2]	$T_{cy(CCLK)} \times (1 + WST2) - 5$	-	$T_{cy(CCLK)} \times$ (1 + WST2) + 5	ns
t _{WEHANV}	WE HIGH to address invalid time	[2]	$T_{cy(CCLK)} - 5$	-	$T_{cy(CCLK)}$ + 5	ns
t _{WEHDNV}	WE HIGH to data invalid time	[2]	$(2 \times T_{cy(CCLK)}) - 5$	-	$(2 \times T_{cy(CCLK)}) + 5$	ns
t _{BLSHANV}	BLS HIGH to address invalid time	[2]	$T_{cy(CCLK)} - 5$	-	$T_{cy(CCLK)} + 5$	ns

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Symbol	Parameter	Conditions	Mi	in	Tvp	Max	Unit
t _{BLSHDNV}	BLS HIGH to data invalid time			$X \times T_{cy(CCLK)}) - 5$	-	$(2 \times T_{cy(CCLK)}) + 5$	
t _{CHDV}	XCLK HIGH to data valid time		-		-	10	ns
t _{CHWEL}	XCLK HIGH to WE LOW time		-		-	10	ns
t _{CHBLSL}	XCLK HIGH to BLS LOW time		-		-	10	ns
t _{CHWEH}	XCLK HIGH to WE HIGH time		-		-	10	ns
t _{CHBLSH}	XCLK HIGH to BLS HIGH time		-		-	10	ns
t _{CHDNV}	XCLK HIGH to data invalid time		-		-	10	ns

Table 11. External memory interface dynamic characteristics ... continued $C_l = 25 \text{ pF}$, $T_{amb} = 40 \text{ °C}$.

[1] Except on initial access, in which case the address is set up $T_{cy(CCLK)}$ earlier.

[2] $T_{cy(CCLK)} = \frac{1}{CCLK}$.

[3] Latest of address valid, CS LOW, OE LOW to data valid.

[4] Address valid to data valid.

[5] Earliest of CS HIGH, OE HIGH, address change to data invalid.

Table 12. Standard read access specifications

Access cycle	Max frequency	WST setting WST ≥ 0; round up to	Memory access time requirement
		integer	
standard read	$f_{MAX} \le \frac{2 + WST1}{t_{RAM} + 20 \ ns}$	$WST1 \ge \frac{t_{RAM} + 20 \ ns}{t_{cy(CCLK)}} - 2$	$t_{RAM} \le t_{cy(CCLK)} \times (2 + WST1) - 20 \ ns$
standard write	$f_{MAX} \le \frac{1 + WST2}{t_{WRITE} + 5 \ ns}$	$WST2 \ge \frac{t_{WRITE} - t_{CYC} + 5}{t_{cy(CCLK)}}$	$t_{WRITE} \le t_{cy(CCLK)} \times (1 + WST2) - 5 \ ns$
burst read - initial	$f_{MAX} \le \frac{2 + WST1}{t_{INIT} + 20 \ ns}$	$WSTI \ge \frac{t_{INIT} + 20 \ ns}{t_{cy(CCLK)}} - 2$	$t_{INIT} \le t_{cy(CCLK)} \times (2 + WST1) - 20 \ ns$
burst read - subsequent 3 \times	$f_{MAX} \le \frac{1}{t_{ROM} + 20 \ ns}$	N/A	$t_{ROM} \le t_{cy(CCLK)} - 20 \ ns$



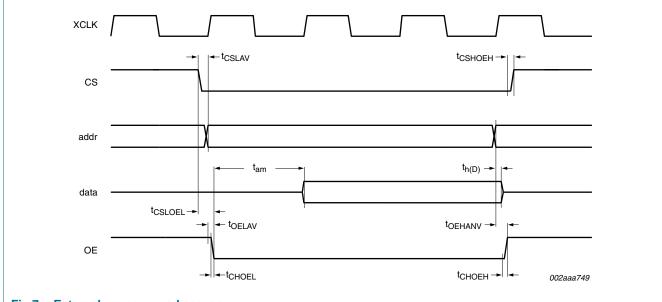
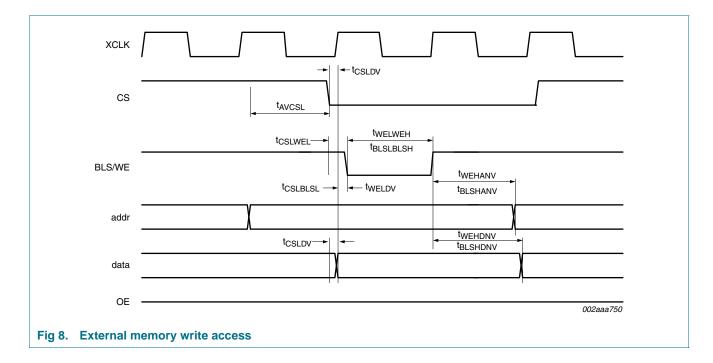
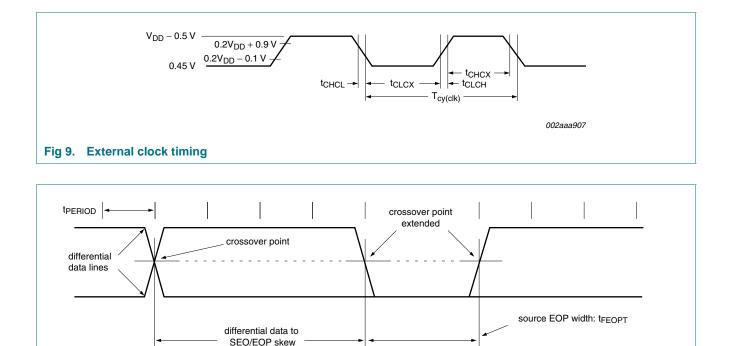


Fig 7. External memory read access



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 $n \times t_{PERIOD} + t_{FDEOP}$

Fig 10. Differential data-to-EOP transition skew and EOP width

002aab561

receiver EOP width: tEOPR1, tEOPR2

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11. Application information

11.1 LCD panel signal usage

Table 13.	LCD panel	connections	for STN	single panel mode
-----------	-----------	-------------	---------	-------------------

External pin	4-bit mono STN single panel		8-bit mono STN single panel		Color STN single panel	
	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function
LCDVD[23]	-	-	-	-	-	-
LCDVD[22]	-	-	-	-	-	-
LCDVD[21]	-	-	-	-	-	-
LCDVD[20]	-	-	-	-	-	-
LCDVD[19]	-	-	-	-	-	-
LCDVD[18]	-	-	-	-	-	-
LCDVD[17]	-	-	-	-	-	-
LCDVD[16]	-	-	-	-	-	-
LCDVD[15]	-	-	-	-	-	-
LCDVD[14]	-	-	-	-	-	-
LCDVD[13]	-	-	-	-	-	-
LCDVD[12]	-	-	-	-	-	-
LCDVD[11]	-	-	-	-	-	-
LCDVD[10]	-	-	-	-	-	-
LCDVD[9]	-	-	-	-	-	-
LCDVD[8]	-	-	-	-	-	-
LCDVD[7]	-	-	P4[29][<u>3]</u>	UD[7]	P4[29] <mark>[3]</mark>	UD[7]
LCDVD[6]	-	-	P4[28] ^[3]	UD[6]	P4[28] ^[3]	UD[6]
LCDVD[5]	-	-	P2[13] ^[2]	UD[5]	P2[13] ^[2]	UD[5]
LCDVD[4]	-	-	P2[12] ^[2]	UD[4]	P2[12] ^[2]	UD[4]
LCDVD[3]	P2[9] <mark>[1]</mark>	UD[3]	P2[9] ^[1]	UD[3]	P2[9][1]	UD[3]
LCDVD[2]	P2[8] <mark>[1]</mark>	UD[2]	P2[8][1]	UD[2]	P2[8][1]	UD[2]
LCDVD[1]	P2[7] <mark>[1]</mark>	UD[1]	P2[7] ^[1]	UD[1]	P2[7][1]	UD[1]
LCDVD[0]	P2[6] <mark>[1]</mark>	UD[0]	P2[6] ^[1]	UD[0]	P2[6][1]	UD[0]
LCDLP	P2[5] <mark>[1]</mark>	LCDLP	P2[5] ^[1]	LCDLP	P2[5][1]	LCDLP
LCDENAB/ LCDM	P2[4] <mark>[1]</mark>	LCDENAB/ LCDM	P2[4][1]	LCDENAB/ LCDM	P2[4] ^[1]	LCDENAB/ LCDM
LCDFP	P2[3][1]	LCDFP	P2[3][1]	LCDFP	P2[3][1]	LCDFP
LCDDCLK	P2[2][1]	LCDDCLK	P2[2][1]	LCDDCLK	P2[2][1]	LCDDCLK
LCDLE	P2[1][1]	LCDLE	P2[1][1]	LCDLE	P2[1] ^[1]	LCDLE
LCDPWR	P2[0][1]	CDPWR	P2[0][1]	LCDPWR	P2[0][1]	LCDPWR
LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[0] ^[2]	LCDPWR

[1] ETM replaced with LCD pins.

[2] External interrupt pins EINT1, EINT2, EINT3 replaced with LCD pins.

[3] Timer pins MAT2[0] and MAT2[1] replaced with LCD pins.

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External pin	4-bit mono ST	N dual panel	8-bit mono STN dual panel		Color STN dual panel		
	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function	
LCDVD[23]	-	-	-	-	-	-	
LCDVD[22]	-	-	-	-	-	-	
LCDVD[21]	-	-	-	-	-	-	
LCDVD[20]	-	-	-	-	-	-	
LCDVD[19]	-	-	-	-	-	-	
LCDVD[18]	-	-	-	-	-	-	
LCDVD[17]	-	-	-	-	-	-	
LCDVD[16]	-	-	-	-	-	-	
LCDVD[15]	-	-	P1[29] ^[4]	LD[7]	P1[29] <mark>4]</mark>	LD[7]	
LCDVD[14]	-	-	P1[28] ^[4]	LD[6]	P1[28] <mark>4]</mark>	LD[6]	
LCDVD[13]	-	-	P1[27] ^[4]	LD[5]	P1[27] <mark>4]</mark>	LD[5]	
LCDVD[12]		-	P1[26] ^[4]	LD[4]	P1[26][4]	LD[4]	
LCDVD[11]	P4[29] <mark>3]</mark>	LD[3]	P1[25] ^[4]	LD[3]	P1[25] ^[4]	LD[3]	
LCDVD[10]	P4[28] <mark>3]</mark>	LD[2]	P1[24] ^[4]	LD[2]	P1[24] ^[4]	LD[2]	
LCDVD[9]	P2[13] ^[2]	LD[1]	P1[23] ^[4]	LD[1]	P1[23] ^[4]	LD[1]	
LCDVD[8]	P2[12] ^[2]	LD[0]	P1[22] ^[4]	LD[0]	P1[22] ^[4]	LD[0]	
LCDVD[7]	-	-	P1[21] ^[4]	UD[7]	P1[21] ^[4]	UD[7]	
LCDVD[6]	-	-	P1[20] ^[4]	UD[6]	P1[20] ^[4]	UD[6]	
LCDVD[5]	-	-	P2[13] ^[2]	UD[5]	P2[13] ^[2]	UD[5]	
LCDVD[4]	-	-	P2[12] ^[2]	UD[4]	P2[12] ^[2]	UD[4]	
LCDVD[3]	P2[9] <mark>[1]</mark>	UD[3]	P2[9] ^[1]	UD[3]	P2[9][1]	UD[3]	
LCDVD[2]	P2[8] <mark>[1]</mark>	UD[2]	P2[8] ^[1]	UD[2]	P2[8][1]	UD[2]	
LCDVD[1]	P2[7] <mark>[1]</mark>	UD[1]	P2[7] ^[1]	UD[1]	P2[7][1]	UD[1]	
LCDVD[0]	P2[6] <mark>[1]</mark>	UD[0]	P2[6] ^[1]	UD[0]	P2[6][1]	UD[0]	
LCDLP	P2[5] <mark>[1]</mark>	LCDLP	P2[5][1]	LCDLP	P2[5] ^[1]	LCDLP	
LCDENAB/ LCDM	P2[4] <mark>[1]</mark>	LCDENAB/ LCDM	P2[4] ^[1]	LCDENAB/ LCDM	P2[4] ^[1]	LCDENAB/ LCDM	
LCDFP	P2[3][1]	LCDFP	P2[3][1]	LCDFP	P2[3] ^[1]	LCDFP	
LCDDCLK	P2[2][1]	LCDDCLK	P2[2] ^[1]	LCDDCLK	P2[2] ^[1]	LCDDCLK	
LCDLE	P2[1][1]	LCDLE	P2[1] ^[1]	LCDLE	P2[1] ^[1]	LCDLE	
LCDPWR	P2[0][1]	LCDPWR	P2[0] ^[1]	LCDPWR	P2[0] ^[1]	LCDPWR	
LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[11] ^[2]	LCDCLKIN	

Table 14. LCD panel connections for STN dual panel mode

[1] ETM replaced with LCD pins.

[2] External interrupt pins EINT1, EINT2, EINT3 replaced with LCD pins.

[3] Timer pins MAT2[0] and MAT2[1] replaced with LCD pins.

[4] USB OTG pins replaced by LCD pins.

External pin	TFT 12 bit (4:4:4 mode)		TFT 16 bit (5:6:5 mode)		TFT 16 bit (1:5:5:5 mode)		TFT 24 bit	
	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function	LPC2478 pin used	LCD function
LCDVD[23]	P1[29] <mark>4]</mark>	BLUE3	P1[29] <mark>4</mark>	BLUE4	P1[29] <mark>4]</mark>	BLUE4	P1[29] <mark>4]</mark>	BLUE7
LCDVD[22]	P1[28] <mark>4]</mark>	BLUE2	P1[28] <mark>4</mark>	BLUE3	P1[28][4]	BLUE3	P1[28][4]	BLUE6
LCDVD[21]	P1[27] <mark>4</mark>	BLUE1	P1[27] <mark>4</mark>	BLUE2	P1[27][4]	BLUE2	P1[27][4]	BLUE5
LCDVD[20]	P1[26][4]	BLUE0	P1[26] <mark>4</mark>	BLUE1	P1[26][4]	BLUE1	P1[26][4]	BLUE4
LCDVD[19]	-	-	P2[13] ^[2]	BLUE0	P2[13] ^[2]	BLUE0	P2[13] ^[2]	BLUE3
LCDVD[18]	-	-	-	-	P2[12] ^[2]	intensity	P2[12] ^[2]	BLUE2
LCDVD[17]	-	-	-	-	-	-	P0[9] <mark>5</mark>	BLUE1
LCDVD[16]	-	-	-	-	-	-	P0[8] <mark>5</mark>	BLUE0
LCDVD[15]	P1[25] <mark>4]</mark>	GREEN3	P1[25] ^[4]	GREEN5	P1[25] ^[4]	GREEN4	P1[25] ^[4]	GREEN7
LCDVD[14]	P1[24] ^[4]	GREEN2	P1[24] ^[4]	GREEN4	P1[24] ^[4]	GREEN3	P1[24][4]	GREEN6
LCDVD[13]	P1[23] <mark>4</mark>	GREEN1	P1[23] <mark>4</mark>	GREEN3	P1[23][4]	GREEN2	P1[23][4]	GREEN5
LCDVD[12]	P1[22][4]	GREEN0	P1[22] <mark>4</mark>	GREEN2	P1[22][4]	GREEN1	P1[22] <mark>4]</mark>	GREEN4
LCDVD[11]	-	-	P1[21] <mark>4</mark>	GREEN1	P1[21][4]	GREEN0	P1[21] <mark>4</mark>	GREEN3
LCDVD[10]	-	-	P1[20][4]	GREEN0	P1[20][4]	intensity	P1[20] ^[4]	GREEN2
LCDVD[9]	-	-	-	-	-	-	P0[7] <mark>5</mark>	GREEN1
LCDVD[8]	-	-	-	-	-	-	P0[6] <mark>5</mark>	GREEN0
LCDVD[7]	P2[9] <mark>1]</mark>	RED3	P2[9] <mark>[1]</mark>	RED4	P2[9][1]	RED4	P2[9] <mark>[1]</mark>	RED7
LCDVD[6]	P2[8] <mark>1]</mark>	RED2	P2[8] <mark>[1]</mark>	RED3	P2[8][1]	RED3	P2[8] <mark>[1]</mark>	RED6
LCDVD[5]	P2[7] <mark>1]</mark>	RED1	P2[7] <mark>[1]</mark>	RED2	P2[7][1]	RED2	P2[7] <mark>[1]</mark>	RED5
LCDVD[4]	P2[6] <mark>1]</mark>	RED0	P2[6] <mark>[1]</mark>	RED1	P2[6][1]	RED1	P2[6] <mark>[1]</mark>	RED4
LCDVD[3]	-	-	P2[12] ^[2]	RED0	P4[29][3]	RED0	P4[29][3]	RED3
LCDVD[2]	-	-	-	-	P4[28][3]	intensity	P4[28][3]	RED2
LCDVD[1]	-	-	-	-	-	-	P0[5] <mark>5</mark>	RED1
LCDVD[0]	-	-	-	-	-	-	P0[4] <mark>5</mark>	RED0
LCDLP	P2[5][1]	LCDLP	P2[5] <mark>[1]</mark>	LCDLP	P2[5][1]	LCDLP	P2[5] <mark>[1]</mark>	LCDLP
LCDENAB/ LCDM	P2[4] <mark>[1]</mark>	LCDENAB/ LCDM	P2[4] <mark>[1]</mark>	LCDENAB/ LCDM	P2[4] <mark>[1]</mark>	LCDENAB/ LCDM	P2[4] <mark>[1]</mark>	LCDENAB/L CDM
LCDFP	P2[3][1]	LCDFP	P2[3][1]	LCDFP	P2[3][1]	LCDFP	P2[3] <mark>[1]</mark>	LCDFP
LCDDCLK	P2[2][1]	LCDDCLK	P2[2][1]	LCDDCLK	P2[2][1]	LCDDCLK	P2[2][1]	LCDDCLK
LCDLE	P2[1][1]	LCDLE	P2[1][1]	LCDLE	P2[1][1]	LCDLE	P2[1] ^[1]	LCDLE
LCDPWR	P2[0][1]	LCDPWR	P2[0][1]	LCDPWR	P2[0][1]	LCDPWR	P2[0][1]	LCDPWR
LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[11] ^[2]	LCDCLKIN	P2[11] ^[2]	LCDCLKIN

Table 15. LCD panel connections for TFT panels

[1] ETM replaced with LCD pins.

[2] External interrupt pins EINT1, EINT2, EINT3 replaced with LCD pins.

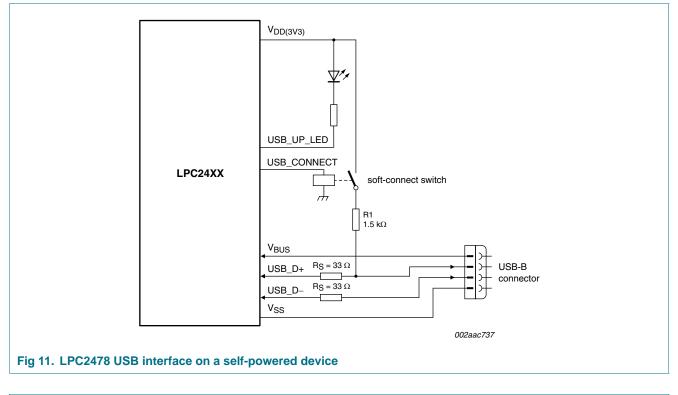
[3] Timer pins MAT2[0] and MAT2[1] replaced with LCD pins.

[4] USB OTG pins replaced with LCD pins.

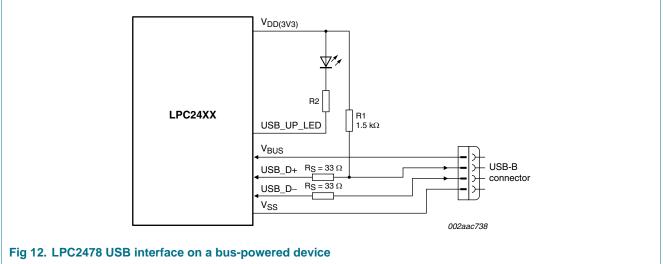
[5] I²S pins replaced with LCD pins.

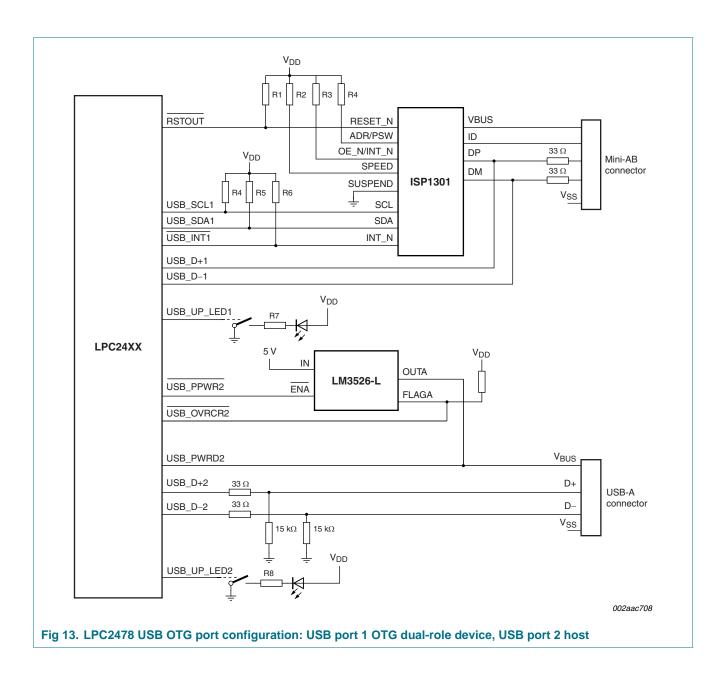
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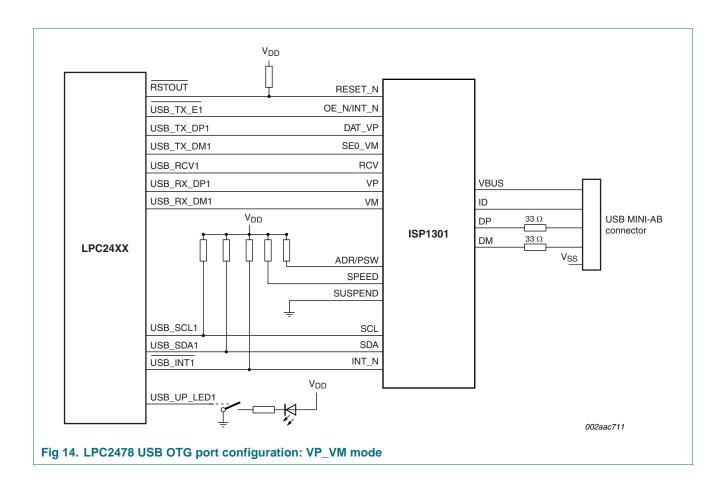
LPC2478 Fast communication chip





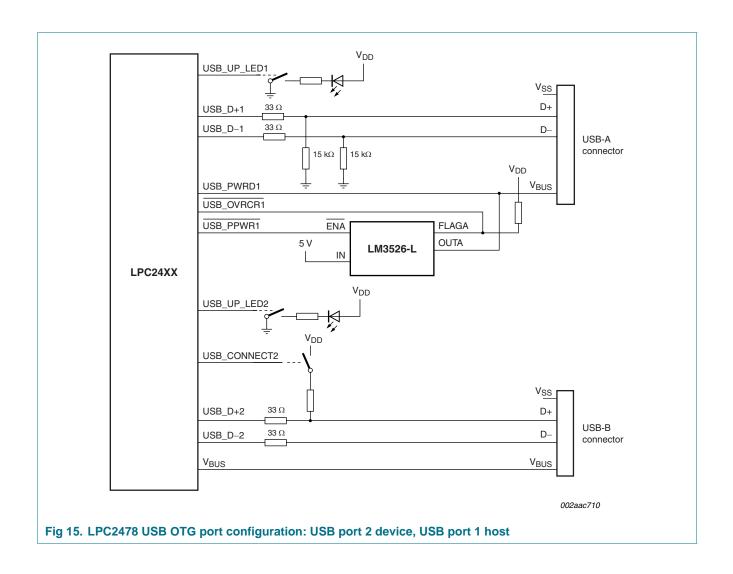




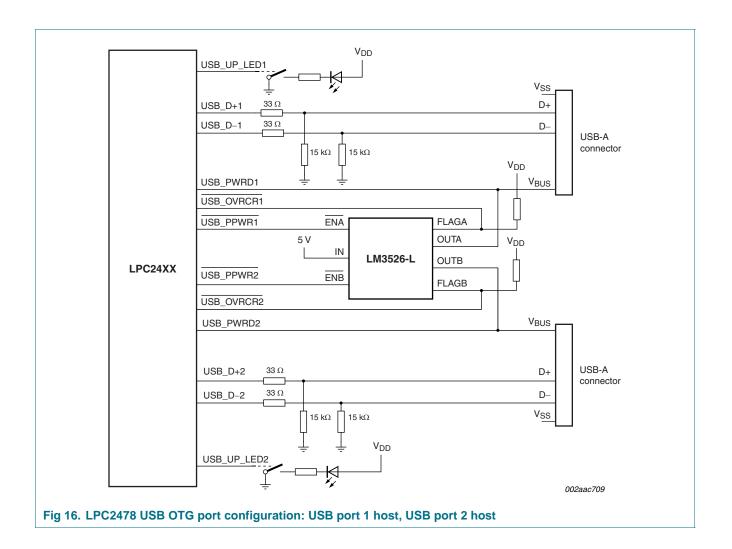


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12. Package outline

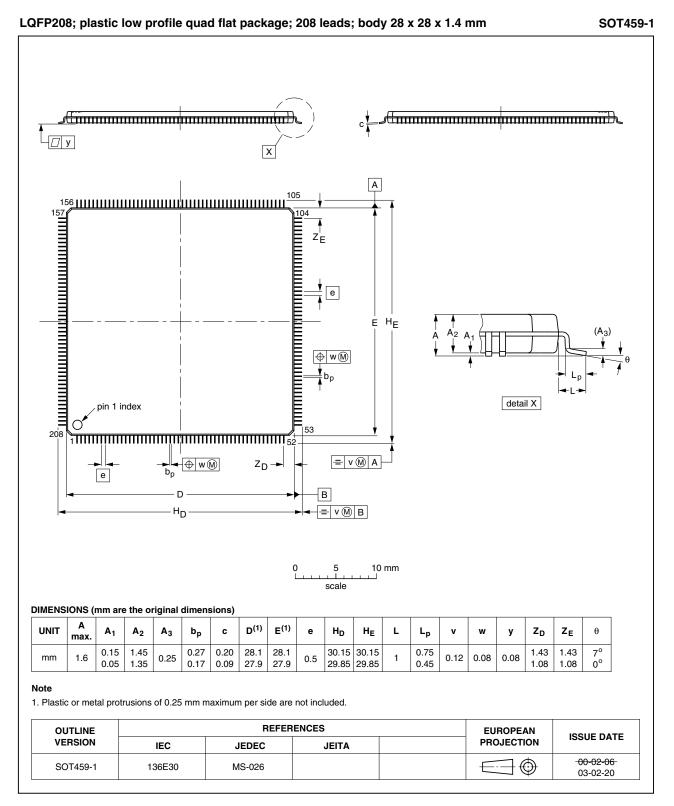
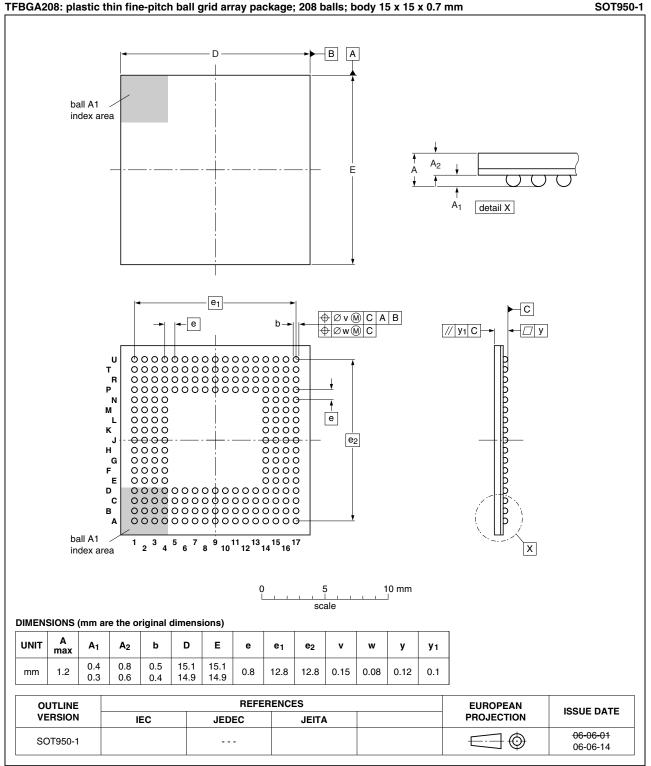


Fig 17. Package outline SOT459-1 (LQFP208)

LPC2478_1



TFBGA208: plastic thin fine-pitch ball grid array package; 208 balls; body 15 x 15 x 0.7 mm

Fig 18. Package outline SOT950-1 (TFBGA208)

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13. Abbreviations

Table 16.	Acronym list
Acronym	Description
ADC	Analog-to-Digital Converter
AHB	Advanced High-performance Bus
AMBA	Advanced Microcontroller Bus Architecture
APB	Advanced Peripheral Bus
ATX	Analog transceiver
BLS	Byte Lane Select
BOD	BrownOut Detection
CAN	Controller Area Network
DAC	Digital-to-Analog Converter
DCC	Debug Communication Channel
DMA	Direct Memory Access
DSP	Digital Signal Processing
EOP	End Of Packet
ETM	Embedded Trace Macrocell
GPIO	General Purpose Input/Output
JTAG	Joint Test Action Group
LCD	Liquid Crystal Display
MII	Media Independent Interface
OHC	Open Host Controller
OTG	On-The-Go
PHY	Physical Layer
PLL	Phase-Locked Loop
PWM	Pulse Width Modulator
RMII	Reduced Media Independent Interface
SE0	Single Ended Zero
SPI	Serial Peripheral Interface
SSI	Synchronous Serial Interface
SSP	Synchronous Serial Port
TTL	Transistor-Transistor Logic
UART	Universal Asynchronous Receiver/Transmitter
USB	Universal Serial Bus

14. Revision history

Table 17. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
LPC2478_1	20070209	Preliminary data sheet	-	-		

15. Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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